

QingDao_ULCPC

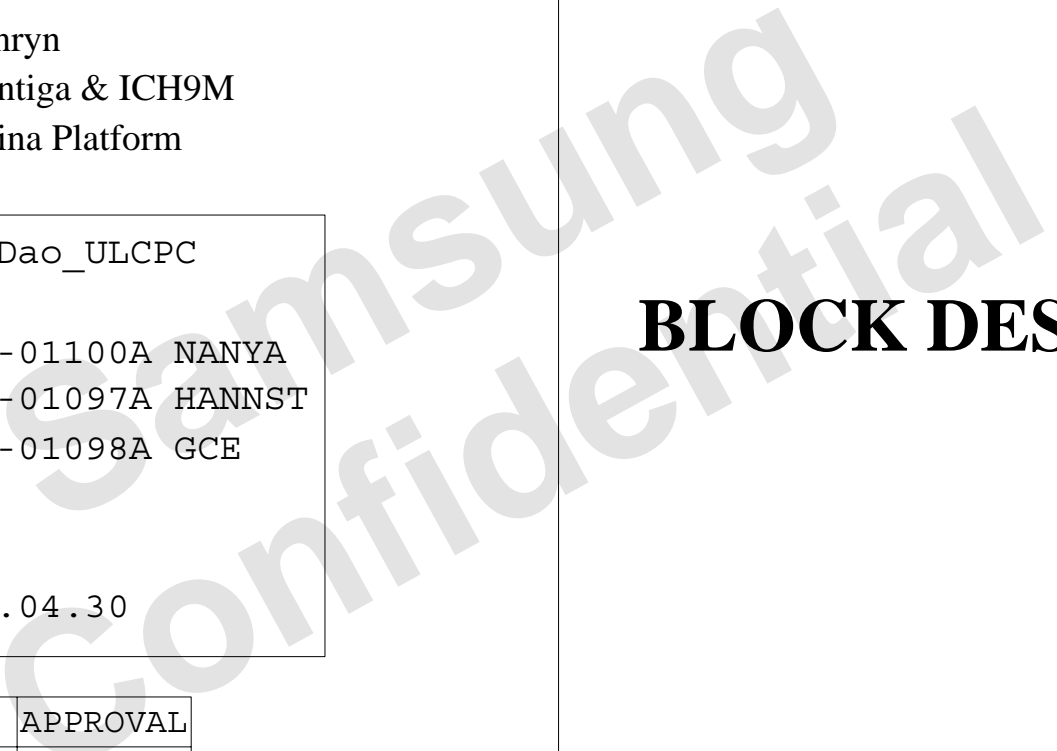
CPU : Intel Penryn
 Chip Set : Intel Cantiga & ICH9M
 Remarks : Montevina Platform

Model Name : QingDao_ULCPC
 PBA Name : MAIN
 PCB Code : BA41-01100A NANYA
 BA41-01097A HANNST
 BA41-01098A GCE
 Dev. Step : PV
 Revision : 1.0
 T.R. Date : 2009.04.30

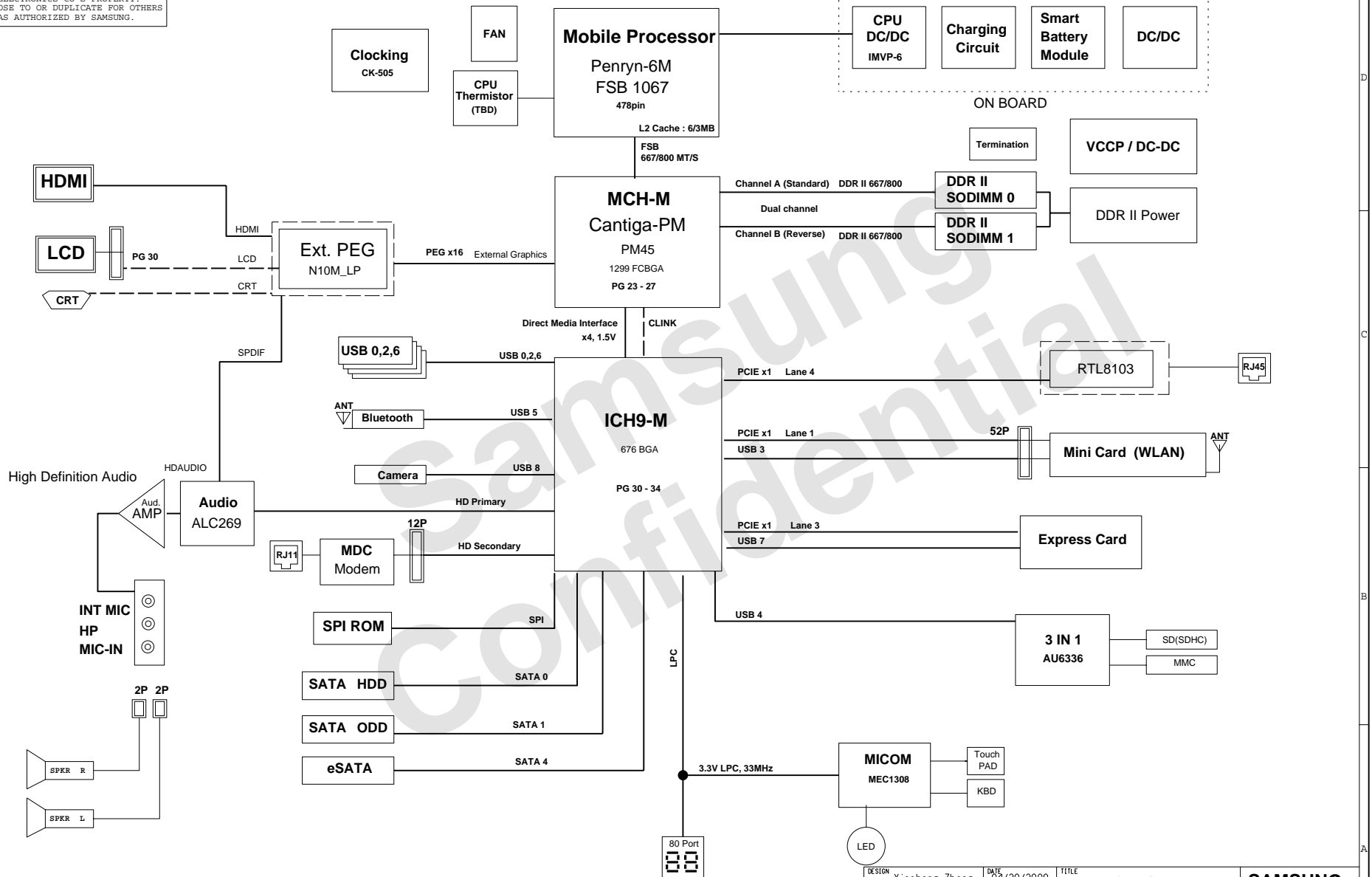
Design	CHECK	APPROVAL
XIAOHONG ZHANG	RUJIN ZHENG	BC LEE

■ Owner : SESC Mobile R & D Signature : X

BLOCK DESIGN



SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



DESIGN	Xiaohong Zhang	DATE	09/30/2009	TITLE	QingDao.L MAIN	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	BLOCK DIAGRAM		
APPROVAL	BC LEE	REV	1.0	PART NO. BA41-01097/8/(1100)A		PAGE 2 OF 15
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM			

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

BOARD INFORMATION

SCHEMATIC ANNOTATIONS AND BOARD INFORMATION

Voltage Rails	
VDC	Primary DC system power supply (7 to 21V)
CPU_CORE	Core Voltage for CPU
EGFX_CORE	Core Voltage for GPU
P1.05V	VTT for CPU, Cantiga & ICH9-M
P1.1	VTT for N10M_GE1
P3.3V_MICOM	3.3V always power rail (for Micom)
P1.5V	1.5V switched power rail (off in S3-S5)
P1.8V	1.8V switched power rail (off in S3-S5)
P1.8V_AUX	1.8V power rail for DDR (off in S4-S5)
P0.9V	0.9V power rail for DDR (off in S3-S5)
P3.3V	3.3V switched power rail (off in S3-S5)
P3.3V_AUX	3.3V switched on power rail (off in S4-S5)
P5.0V	5.0V switched power rail (off in S3-S5)
P5.0V_AUX	5.0V switched on power rail (off in S4-S5)
P5.0V_ALW	5.0V always power rail
P12.0V_ALW	12.0V always power rail

Crystal / Oscillator			
TYPE	FREQUENCY	DEVICE	USAGE
Crystal	32.768KHz	ICH9-M	Real Time Clock
Crystal	10MHz	MICOM	HD64F2169/2160
Crystal	14.318MHz	CLOCK-Generator	CK-505
Crystal	25MHz	LAN	Intel LAN

I ² C / SMB Address			
Devices	Address	Hex	Bus
ICH9-M	Master	-	SMBUS Master
CPU Thermal Sensor	0111 101x	7Ah	Thermal Sensor
SODIMM0	1010 000x	A0h	-
SODIMM1	1010 010x	A4h	-
Thermal Sensor on SODIMM0	0011 000x	30h	-
Thermal Sensor on SODIMM1	0011 010x	34h	-
CK-505M (Clock Generator)	1101 0010	D2h	Clock, Unused Clock Output Disable

USB PORT Assign		PCI Express Assign	
PORT #	ASSIGNED TO	PORT #	ASSIGNED TO
0	SYSTEM PORT 0		
1	Mini PCI Express		
2	SYSTEM PORT 1	1	Mini Card 1 (WLAN)
3	NC	2	NC
4	3 IN 1	3	EXPRESS CARD
5	Bluetooth	4	LOM
6	SYSTEM PORT 2	5	NC
7	EXPRESS CARD	6	NC
8	Camera		
9	NC		
10	NC		

LCD Panel Detect (TBD)		
Devices	Resolution	PANNEL_DETECT_0(strap0)

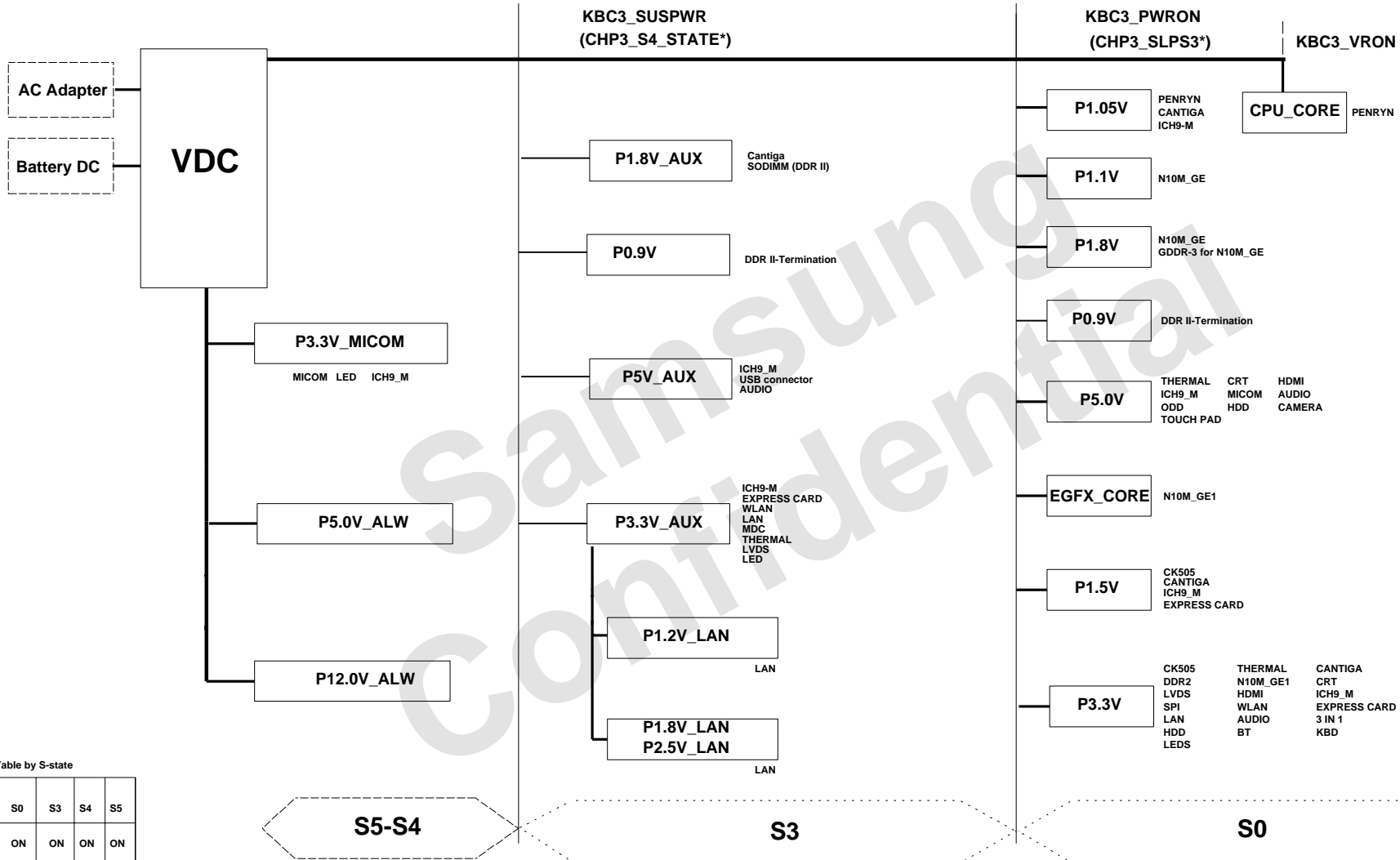
REVISION HISTORY

See rev notes for more information.

DESIGN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L MAIN	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	BOARD INFO	BA41-01097/8/(1100)A	
APPROVAL	BC LEE	REV	1.0			PART NO.
MODULE CODE		LAST EDIT		April 29, 2009 21:47:17 PM	PAGE	3 OF 15

POWER DIAGRAM

Rev 0.1



Power On/Off Table by S-state

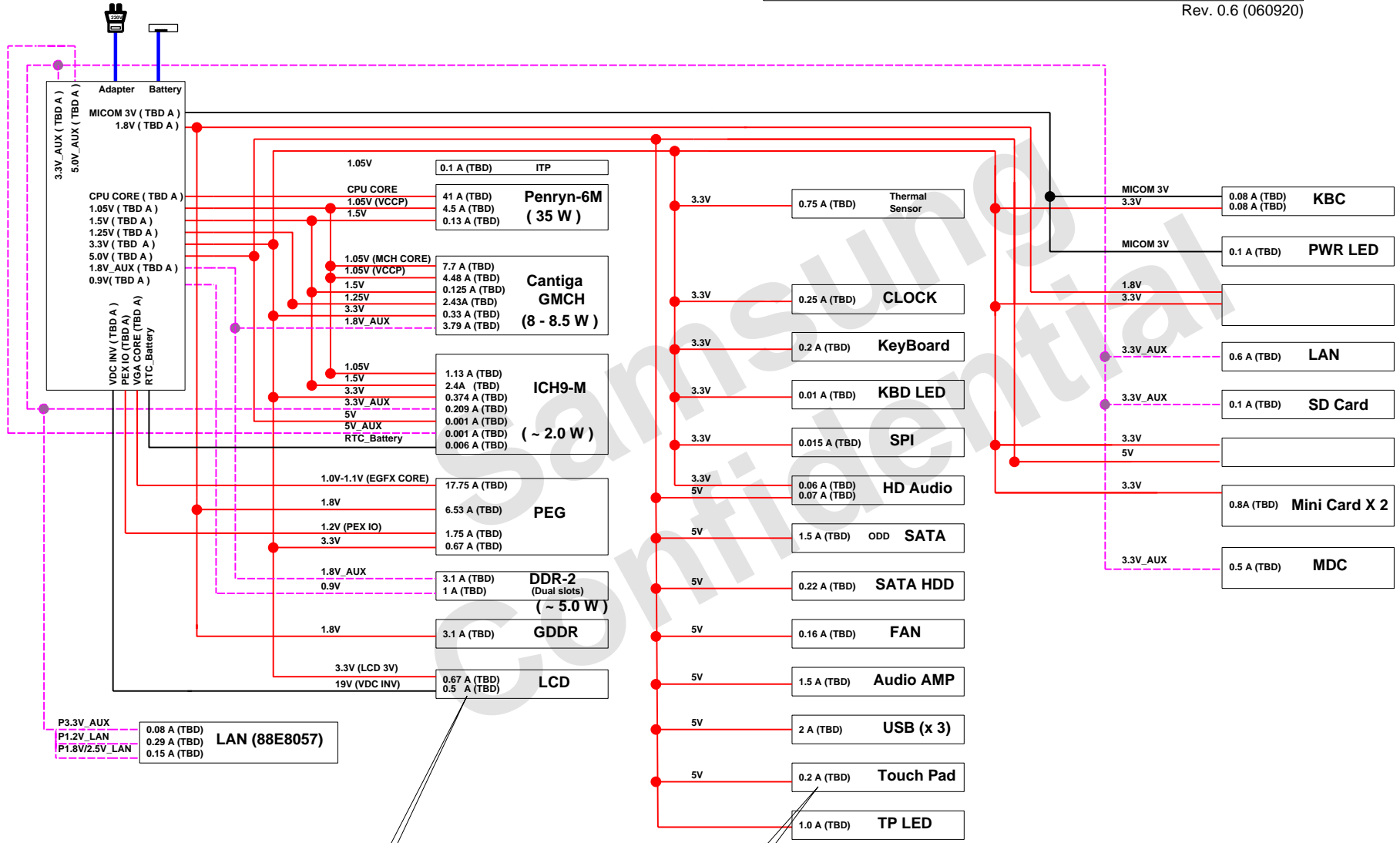
Rail \ State	S0	S3	S4	S5
+V*(LWS) +V*LAN	ON	ON	ON	ON
+1.8V_AUX +0.9V	ON	ON	---	---
+V*AUX	ON	ON	---	---
+V	ON	---	---	---
+V* (CORE)	ON	---	---	---

DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L MAIN POWER DIAGRAM	SAMSUNG ELECTRONICS PART NO. 01097/8/(1100)A
CHECK	Rujin Zheng	DEV. STEP	PV	APPROVAL	BC LEE	
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	4	OF 15

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

POWER RAILS ANALYSIS

Rev. 0.6 (060920)



P3.3V_AUX 0.08 A (TBD)
 P1.2V_LAN 0.29 A (TBD)
 P1.8V/2.5V_LAN 0.15 A (TBD)
LAN (88E8057)

Value by Datasheet/Application notes (Value by measurement)

DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L MAIN POWER RAILS	SAMSUNG ELECTRONICS PART NO.: BA41-01097/8/(1100)A
CHECK	Rujin Zheng	REV. STEP	PV			
APPROVAL	BC LEE	REV	1.0			
MODULE CODE		LAST EDIT				
				April 29, 2009 21:47:17 PM	PAGE 5 OF 15	

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

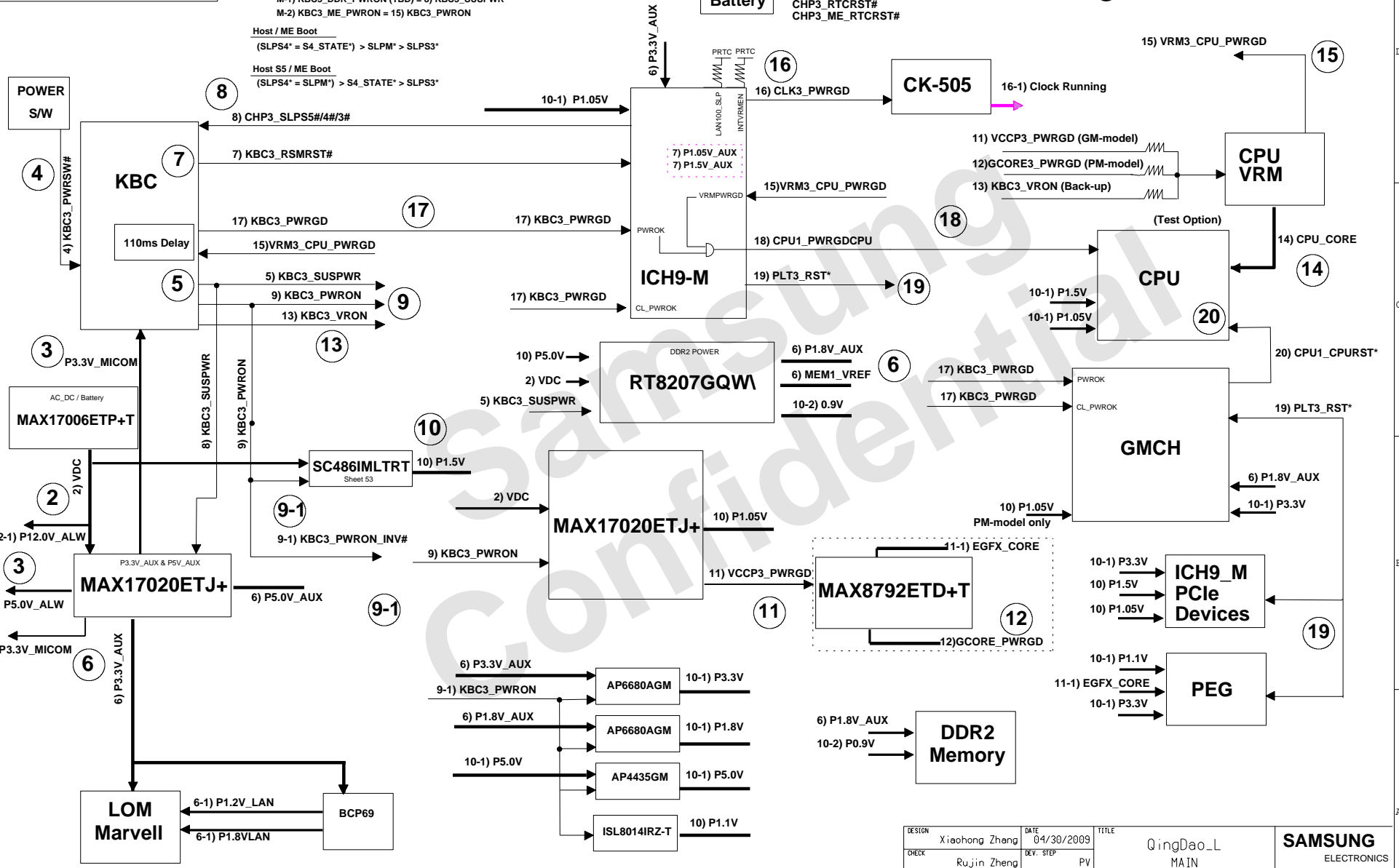
POWER SEQUENCE

Rev. 0.7

Host Boot / ME Off
 (SLPS4* = S4_STATE*) > (SLPM* = SLPS3*)
 M-1) KBC3_DDR_PWRON (TBD) = 8) KBC3_SUSPWR
 M-2) KBC3_ME_PWRON = 15) KBC3_PWRON

Host / ME Boot
 (SLPS4* = S4_STATE*) > SLPM* > SLPS3*

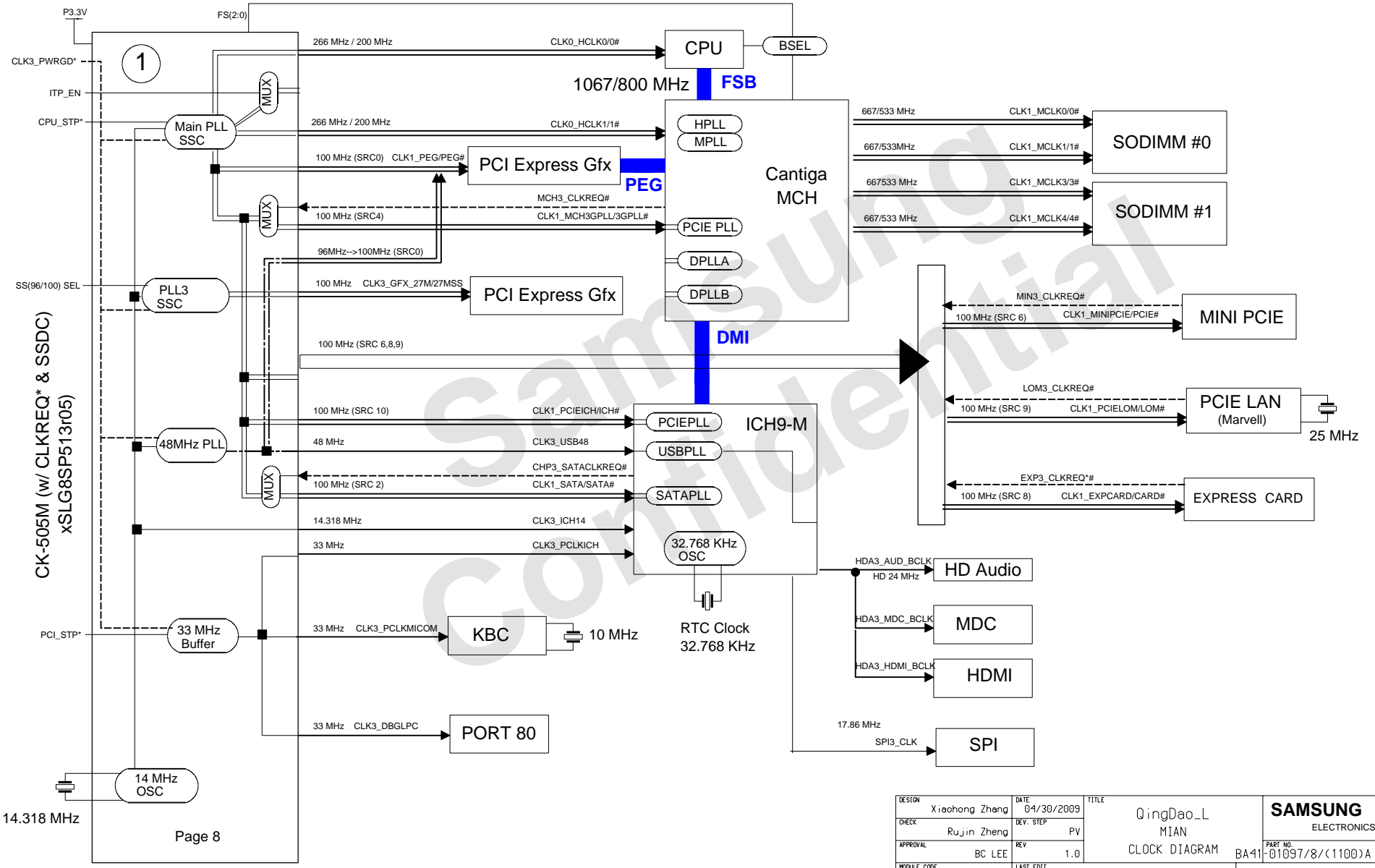
Host S5 / ME Boot
 (SLPS4* = SLPM*) > S4_STATE* > SLPS3*



DESIGN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L MAIN POWER SEQUENCE	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	APPROVAL	BC LEE	
MODULE CODE		LAST EDIT		REVISION	1.0	PART NO BA41-01097/8/((1100)A
				DATE	April 29, 2009 21:47:17 PM	PAGE 6 OF 15

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

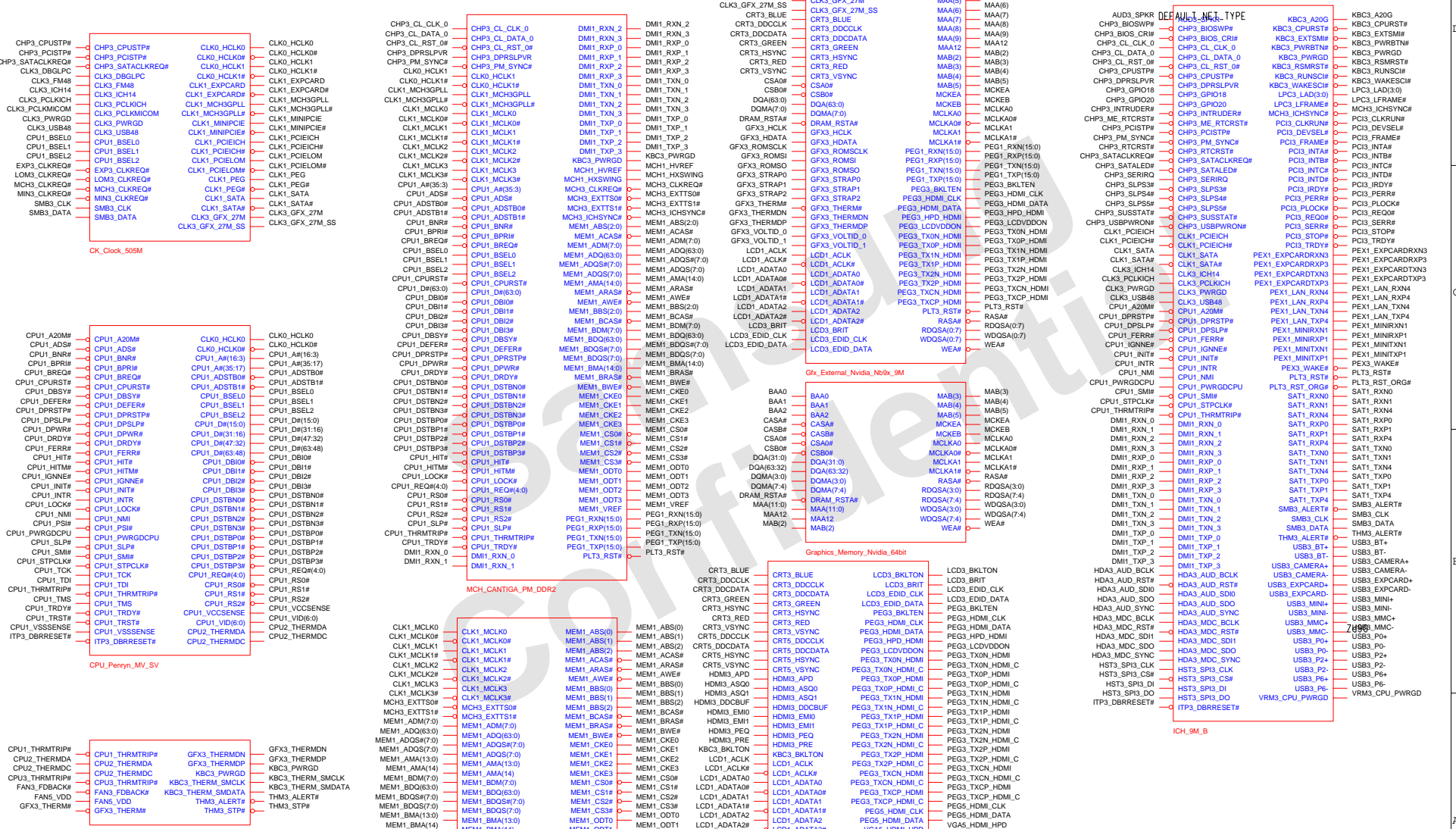
CLOCK DISTRIBUTION Rev. 0.1



CK-505M (w/CLKREQ* & SSDC)
xSLG8SP513T05

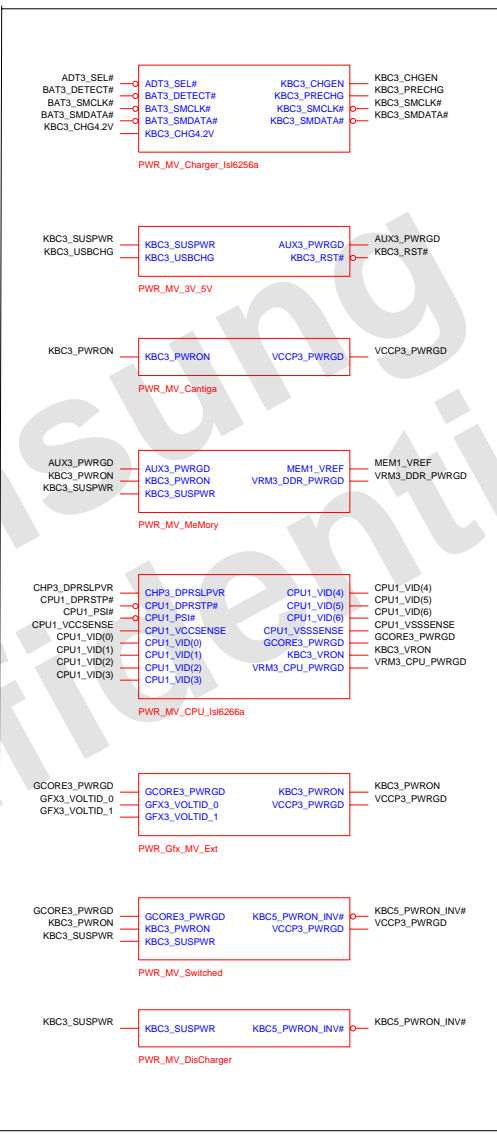
DESIGN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L MIAN CLOCK DIAGRAM	SAMSUNG ELECTRONICS PART NO. BA41-01097/8/(1100)A
CHECK	Rujin Zheng	REV. STEP	PV			
APPROVAL	BC LEE	REV	1.0			
MODULE CODE		LAST EDIT				
				Apr 29, 2009 21:47:17 PM	PAGE 7 OF 15	

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG
CHECK	Rujin Zheng	DEV. STEP	PV	MAIN BLOCK	BA41	ELECTRONICS
APPROVAL	BC LEE	REV	1.0			PART NO. 01097/8/11000A
MODULE CODE		LAST EDIT		Apr 12, 2009 21:47:17 PM	PAGE	8 OF 15

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

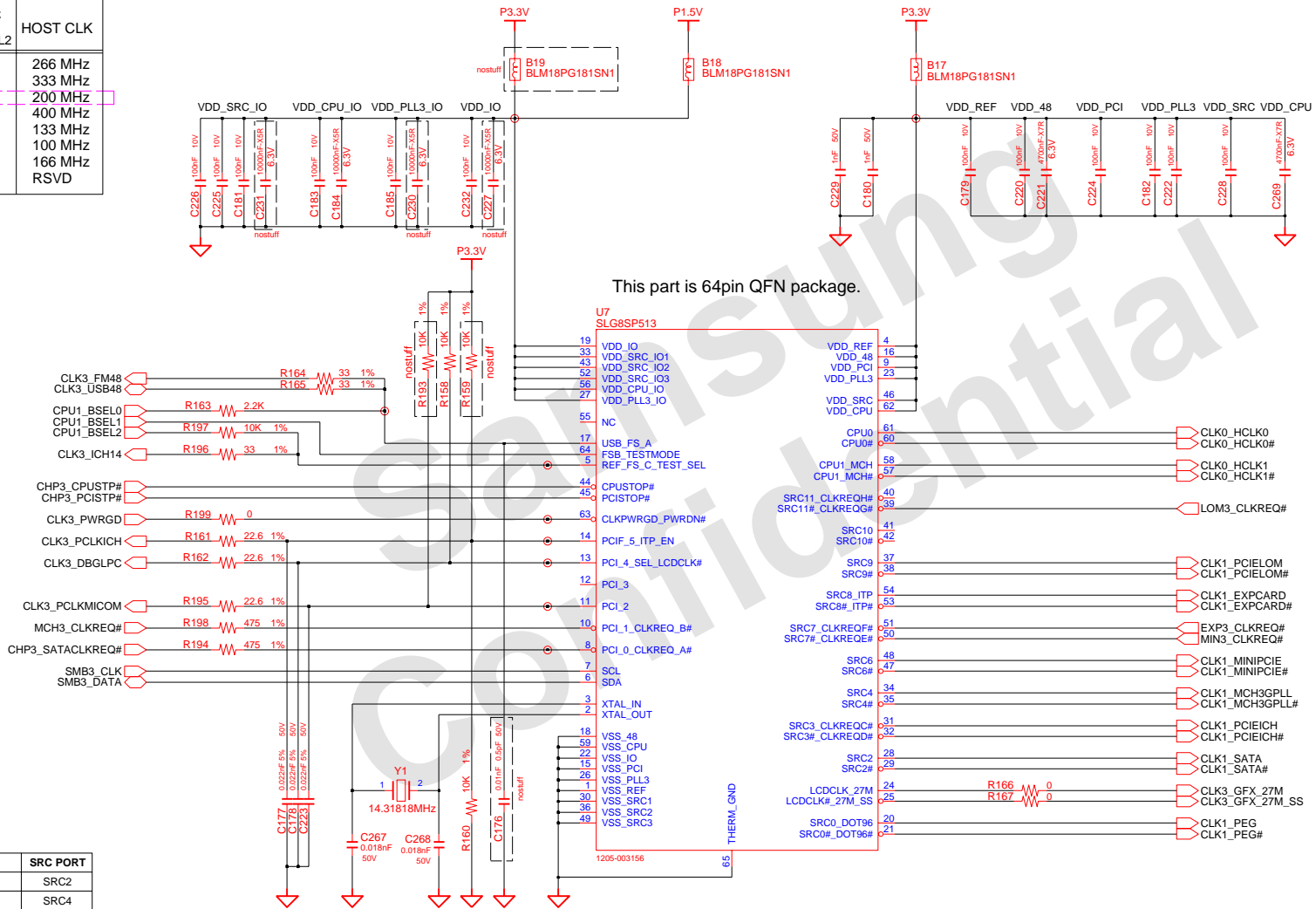


DESIGN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV		MAIN	
APPROVAL	BC LEE	REV	1.0		BLOCK	PART NO.
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM		BA41-01097/8/(1100)A	
					PAGE	9 OF 15

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

CK505M

FSA	FSB	FSC	HOST CLK
BSEL0	BSEL1	BSEL2	
0	0	0	266 MHz
0	0	1	333 MHz
0	1	0	200 MHz
0	1	1	400 MHz
1	0	0	133 MHz
1	0	1	100 MHz
1	1	0	166 MHz
1	1	1	RSVD



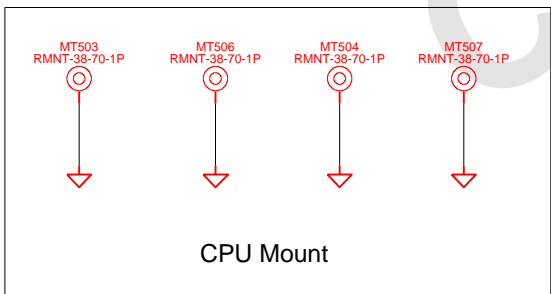
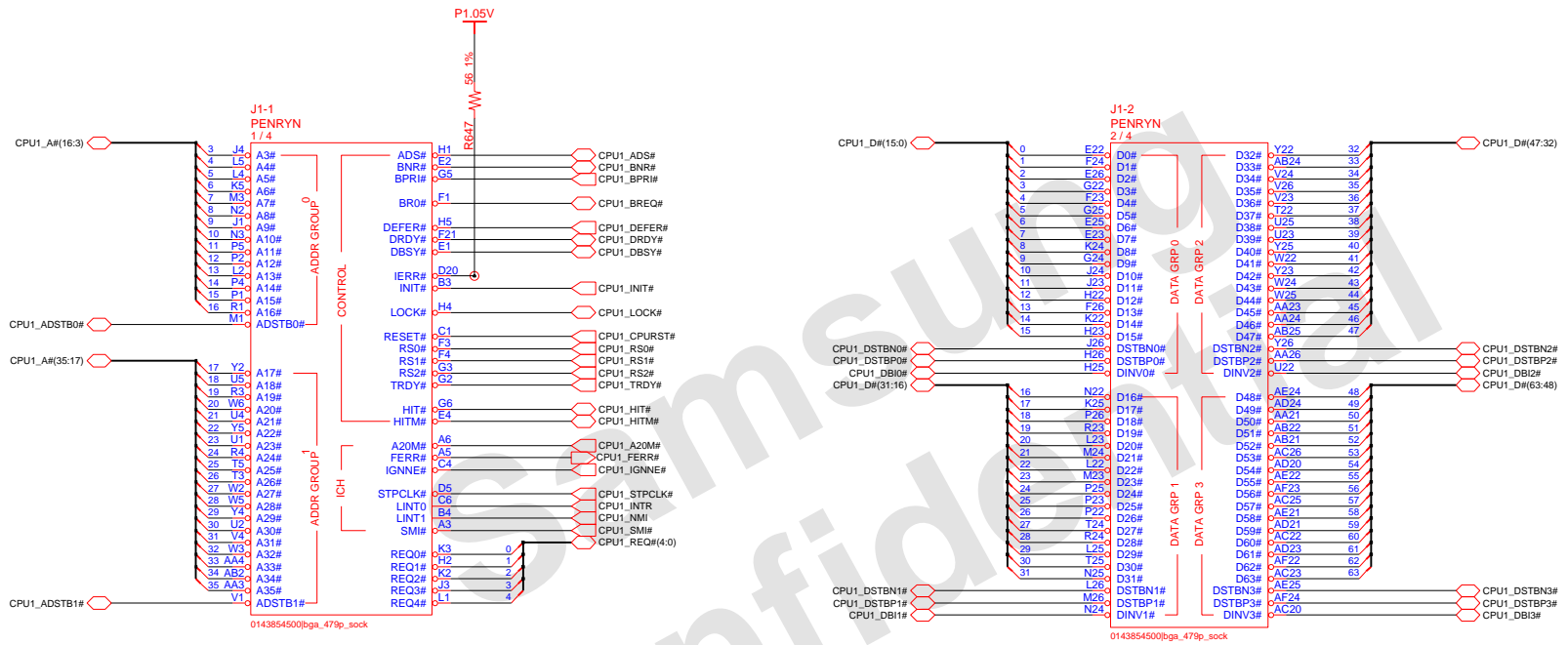
Place 14.318MHz within 500mils of CK-505

CLK REQ	DEVICE	SRC PORT
CLK REQ A	SATA	SRC2
CLK REQ B	GMCH	SRC4
CLK REQ E	MINI CARD	SRC6
CLK REQ F	EXP3_CLKREQ#	SRC8

SEL_LDCCLK*	Pin 20/21	Pin 24/25
LOW	DOT_96/DOT_96#	PEG_CLK/PEG_CLK#
HIGH	SRC_0/SRC_0#	27M & 27M_SS

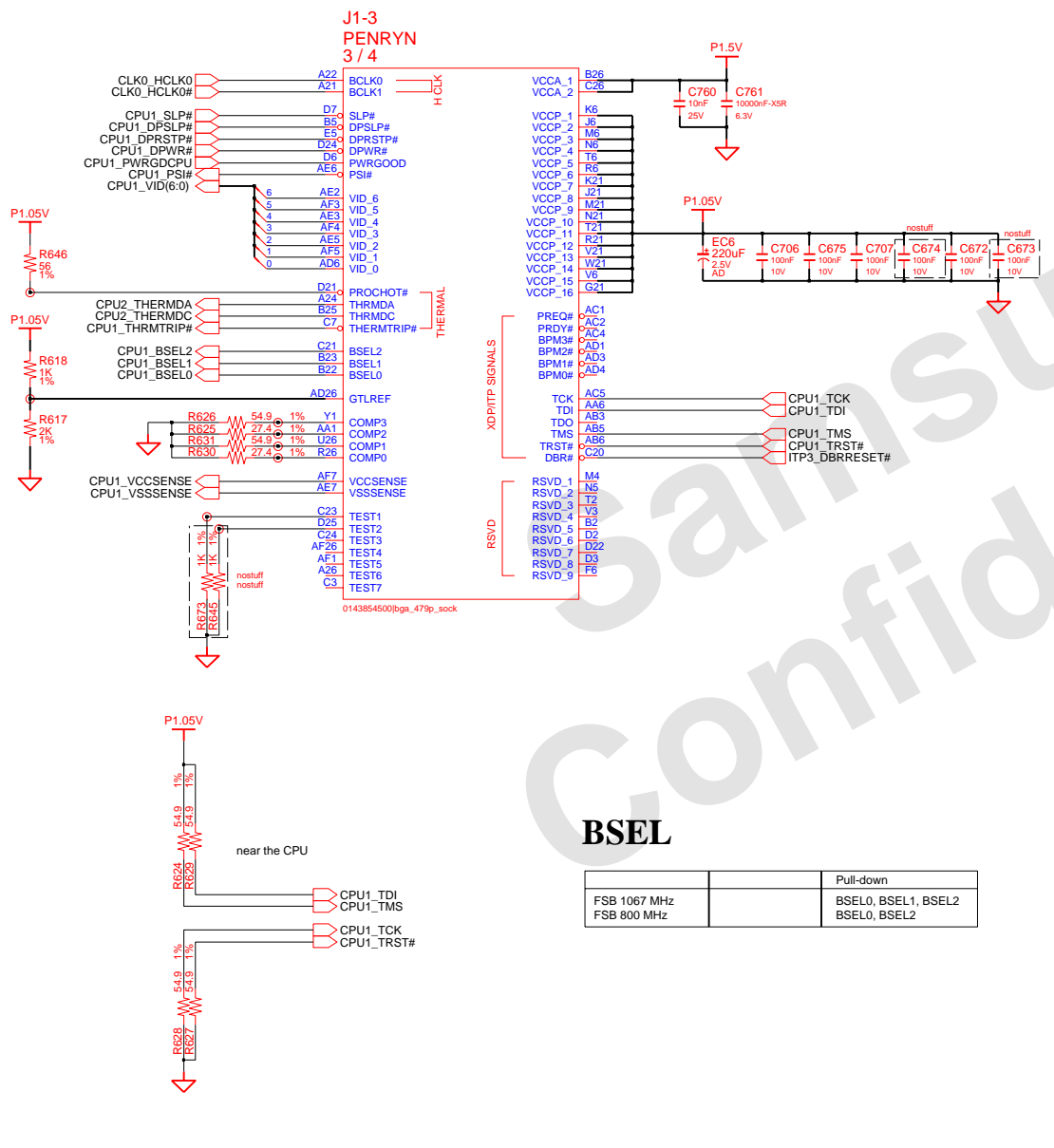
DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	Main_Clock_Circuit		
APPROVAL	BC LEE	REV	1.0	CK_Clock_505M		PART NO.
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1	OF

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



DRAW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L CPU	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	REV. STEP	PV	PENRYN (1/3)	BA11-01097/8/(1100)A	
APPROVAL	BC LEE	REV	1.0	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE 1 OF 3
MODULE CODE	undefined					

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



CPU Core Voltage Table IMVP-6

Active Mode		Active/Deeper Sleep Dual Mode Region		Deeper Sleep/Extended Deeper Sleep Dual Mode Region	
VID(6:0)	Voltage	VID(6:0)	Voltage	VID(6:0)	Voltage
0 0 0 0 0 0 0	1.5000 V	0 1 0 1 0 0 0	1.0000 V	1 0 1 0 0 0 1	0.4875 V
0 0 0 0 0 0 1	1.4875 V	0 1 0 1 0 0 1	0.9875 V	1 0 1 0 0 1 0	0.4750 V
0 0 0 0 0 1 0	1.4750 V	0 1 0 1 0 1 0	0.9750 V	1 0 1 0 1 0 1	0.4625 V
0 0 0 0 0 1 1	1.4625 V	0 1 0 1 1 0 1	0.9625 V	1 0 1 1 0 1 0	0.4500 V
0 0 0 0 1 0 0	1.4500 V	0 1 0 1 1 1 0	0.9500 V	1 0 1 1 1 0 1	0.4375 V
0 0 0 0 1 0 1	1.4375 V	0 1 0 1 1 1 1	0.9375 V	1 0 1 1 1 1 0	0.4250 V
0 0 0 0 1 1 0	1.4250 V	0 1 1 0 0 0 0	0.9250 V	1 0 1 1 0 0 1	0.4125 V
0 0 0 0 1 1 1	1.4125 V	0 1 1 0 0 0 1	0.9125 V	1 0 1 1 0 1 0	0.4000 V
0 0 0 1 0 0 0	1.4000 V	0 1 1 0 0 1 0	0.9000 V	1 0 1 1 1 0 1	0.3875 V
0 0 0 1 0 0 1	1.3875 V	0 1 1 0 0 1 1	0.8875 V	1 0 1 1 1 1 0	0.3750 V
0 0 0 1 0 1 0	1.3750 V	0 1 1 0 1 0 0	0.8750 V	1 0 1 1 1 0 1	0.3625 V
0 0 0 1 0 1 1	1.3625 V	0 1 1 0 1 0 1	0.8625 V	1 0 1 1 1 1 0	0.3500 V
0 0 0 1 1 0 0	1.3500 V	0 1 1 0 1 1 0	0.8500 V	1 0 1 1 1 1 1	0.3375 V
0 0 0 1 1 0 1	1.3375 V	0 1 1 1 0 0 0	0.8375 V	1 0 1 1 1 1 0	0.3250 V
0 0 0 1 1 1 0	1.3250 V	0 1 1 1 0 0 1	0.8250 V	1 0 1 1 1 1 1	0.3125 V
0 0 0 1 1 1 1	1.3125 V	0 1 1 1 0 1 0	0.8125 V	1 1 0 0 0 0 0	0.3000 V
0 0 1 0 0 0 0	1.3000 V	0 1 1 1 0 1 1	0.8000 V	1 1 0 0 0 0 1	0.2875 V
0 0 1 0 0 0 1	1.2875 V	0 1 1 1 1 0 0	0.7875 V	1 1 0 0 0 1 0	0.2750 V
0 0 1 0 0 1 0	1.2750 V	0 1 1 1 1 0 1	0.7750 V	1 1 0 0 0 1 1	0.2625 V
0 0 1 0 0 1 1	1.2625 V	0 1 1 1 1 1 0	0.7625 V	1 1 0 0 1 0 0	0.2500 V
0 0 1 0 1 0 0	1.2500 V	0 1 1 1 1 1 1	0.7500 V	1 1 0 0 1 0 1	0.2375 V
0 0 1 0 1 0 1	1.2375 V	0 1 1 1 1 1 0	0.7375 V	1 1 0 0 1 1 0	0.2250 V
0 0 1 0 1 1 0	1.2250 V	0 1 1 1 1 1 1	0.7250 V	1 1 0 0 1 1 1	0.2125 V
0 0 1 0 1 1 1	1.2125 V	0 1 1 1 1 1 1	0.7125 V	1 1 0 1 0 0 0	0.2000 V
0 0 1 1 0 0 0	1.2000 V	1 0 0 0 0 0 0	0.7000 V	1 1 0 1 0 0 1	0.1875 V
0 0 1 1 0 0 1	1.1875 V	1 0 0 0 0 0 1	0.6875 V	1 1 0 1 0 1 0	0.1750 V
0 0 1 1 0 1 0	1.1750 V	1 0 0 0 0 1 0	0.6750 V	1 1 0 1 0 1 1	0.1625 V
0 0 1 1 0 1 1	1.1625 V	1 0 0 0 1 0 0	0.6625 V	1 1 0 1 1 0 0	0.1500 V
0 0 1 1 1 0 0	1.1500 V	1 0 0 0 1 0 1	0.6500 V	1 1 0 1 1 0 1	0.1375 V
0 0 1 1 1 0 1	1.1375 V	1 0 0 0 1 1 0	0.6375 V	1 1 0 1 1 1 0	0.1250 V
0 0 1 1 1 1 0	1.1250 V	1 0 0 0 1 1 1	0.6250 V	1 1 0 1 1 1 1	0.1125 V
0 0 1 1 1 1 1	1.1125 V	1 0 0 1 0 0 0	0.6125 V	1 1 1 0 0 0 0	0.1000 V
0 1 0 0 0 0 0	1.1000 V	1 0 0 1 0 0 1	0.6000 V	1 1 1 0 0 0 1	0.0875 V
0 1 0 0 0 0 1	1.0875 V	1 0 0 1 0 1 0	0.5875 V	1 1 1 0 0 1 0	0.0750 V
0 1 0 0 0 1 0	1.0750 V	1 0 0 1 0 1 1	0.5750 V	1 1 1 0 1 0 0	0.0625 V
0 1 0 0 0 1 1	1.0625 V	1 0 0 1 1 0 0	0.5625 V	1 1 1 0 1 0 1	0.0500 V
0 1 0 0 1 0 0	1.0500 V	1 0 0 1 1 0 1	0.5500 V	1 1 1 0 1 1 0	0.0375 V
0 1 0 0 1 0 1	1.0375 V	1 0 0 1 1 1 0	0.5375 V	1 1 1 0 1 1 1	0.0250 V
0 1 0 0 1 1 0	1.0250 V	1 0 0 1 1 1 1	0.5250 V	1 1 1 1 0 0 0	0.0125 V
0 1 0 0 1 1 1	1.0125 V	1 0 0 1 1 1 1	0.5125 V	1 1 1 1 0 0 1	0.0000 V
0 1 0 1 0 0 0	1.0000 V	1 0 0 1 1 1 1	0.5000 V	1 1 1 1 0 1 0	0.0000 V
0 1 0 1 0 0 1	0.9875 V	1 0 0 1 1 1 1	0.4875 V	1 1 1 1 0 1 1	0.0000 V
0 1 0 1 0 1 0	0.9750 V	1 0 0 1 1 1 1	0.4750 V	1 1 1 1 1 0 0	0.0000 V
0 1 0 1 0 1 1	0.9625 V	1 0 0 1 1 1 1	0.4625 V	1 1 1 1 1 0 1	0.0000 V
0 1 0 1 1 0 0	0.9500 V	1 0 0 1 1 1 1	0.4500 V	1 1 1 1 1 1 0	0.0000 V
0 1 0 1 1 0 1	0.9375 V	1 0 0 1 1 1 1	0.4375 V	1 1 1 1 1 1 1	0.0000 V
0 1 0 1 1 1 0	0.9250 V	1 0 0 1 1 1 1	0.4250 V	1 1 1 1 1 1 1	0.0000 V
0 1 0 1 1 1 1	0.9125 V	1 0 0 1 1 1 1	0.4125 V	1 1 1 1 1 1 1	0.0000 V

Active: DPRSLPVR 0, DPRSTP* 1, PSI2* 0 or 1
 Deeper Slp: DPRSLPVR 1, DPRSTP* 0, PSI2* 0 or 1

***11111111** : 0V power good asserted.

*Yonah Processor (2.33 GHz / 800 MHz : TBD)

GTLREF : Keep the Voltage divider within 0.5° of the first GTLREF pin with Zo=55ohm trace. Minimize coupling of any switching signals to this net.

COMP0,2(COMP1,3) should be connected with Zo=27.4ohm(55ohm) trace shorter than 1/2" to their respective Banias socket pins.

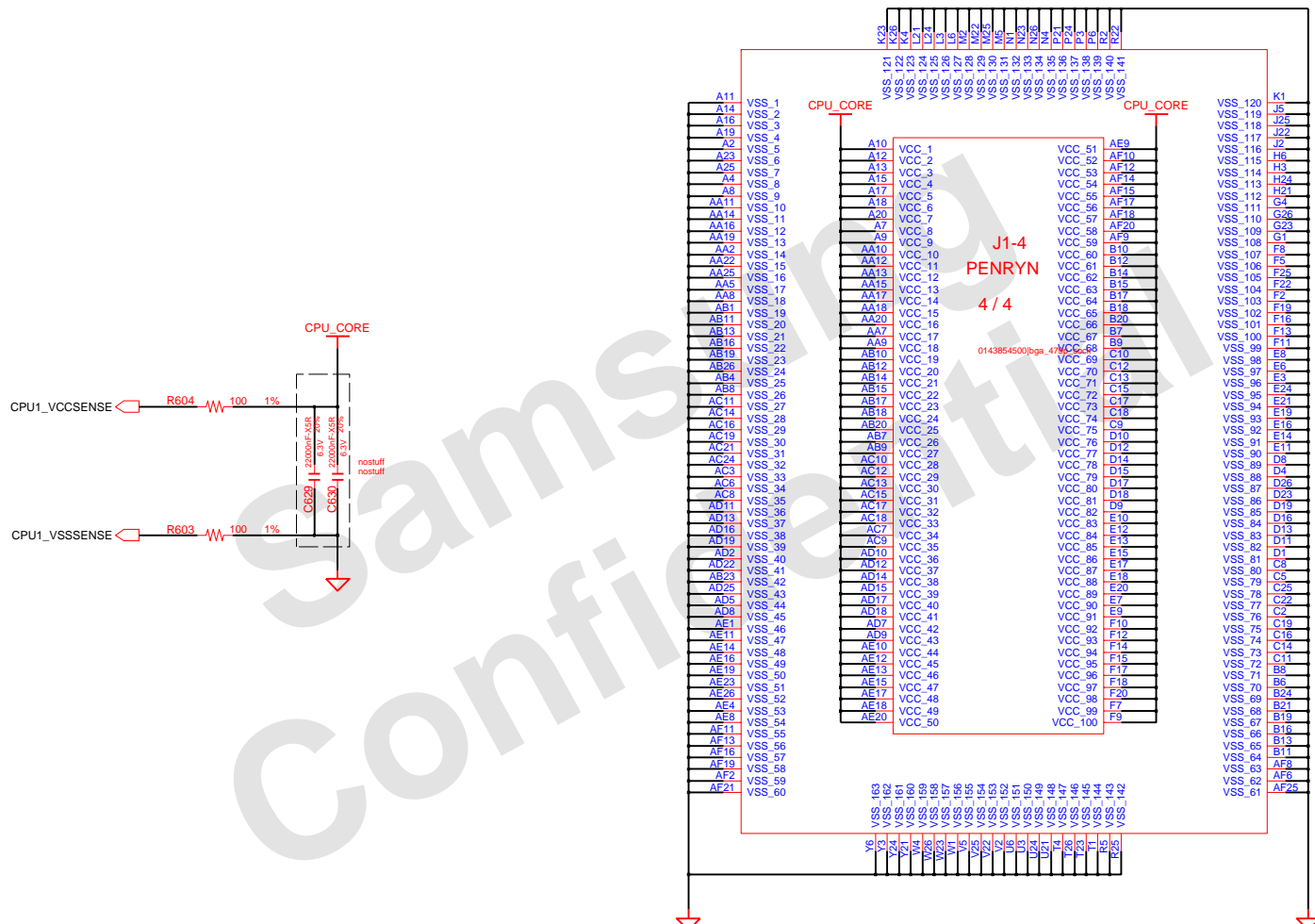
GND test points within 100mil of the VCC/VSSsense at the end of the line. Route the VCC/VSSsense as a Zo=55ohm traces with equal length. Observe 3:1 spacing b/w VCC/VSSsense lines and 25mil away (preferred 50mil) from any other signal. And GND via 100mil away from each of the VCC/VSS test point vias.

BSEL

FSB 1067 MHz		Pull-down
FSB 800 MHz		BSELO, BSEL1, BSEL2 BSELO, BSEL2

DRW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L CPU	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV			
APPROVAL	BC LEE	REV	1.0		PENRYN (2/3)	PART NO. BA41-01097/8/(1100)A
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	2 OF 3	

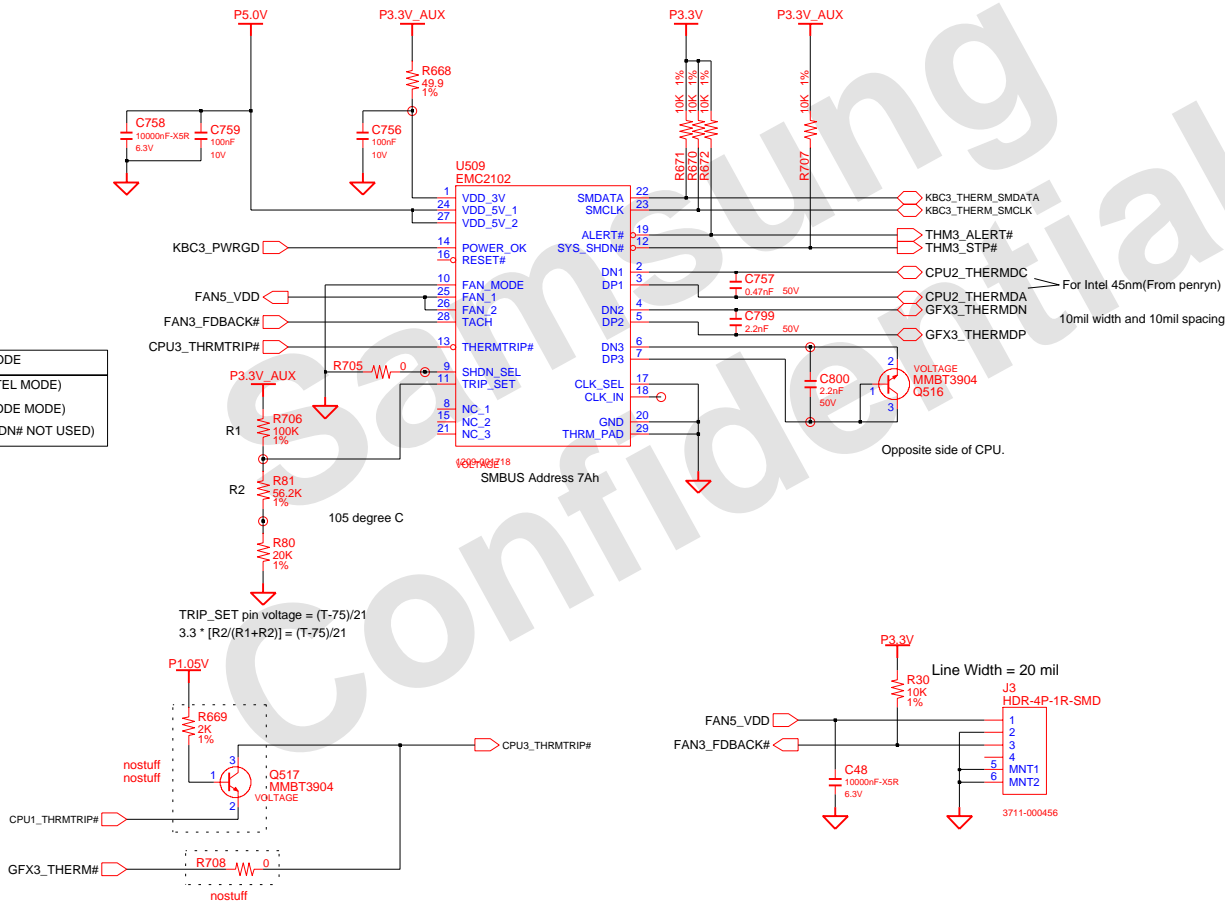
SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



DRAW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS	
CHECK	Rujin Zheng	REV. STEP	PV		CPU		
APPROVAL	BC LEE	REV	1.0		PENRYN (3/3)	PART NO.	
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM		BA41-01097/8/(1100)A		
						PAGE	3 OF 3

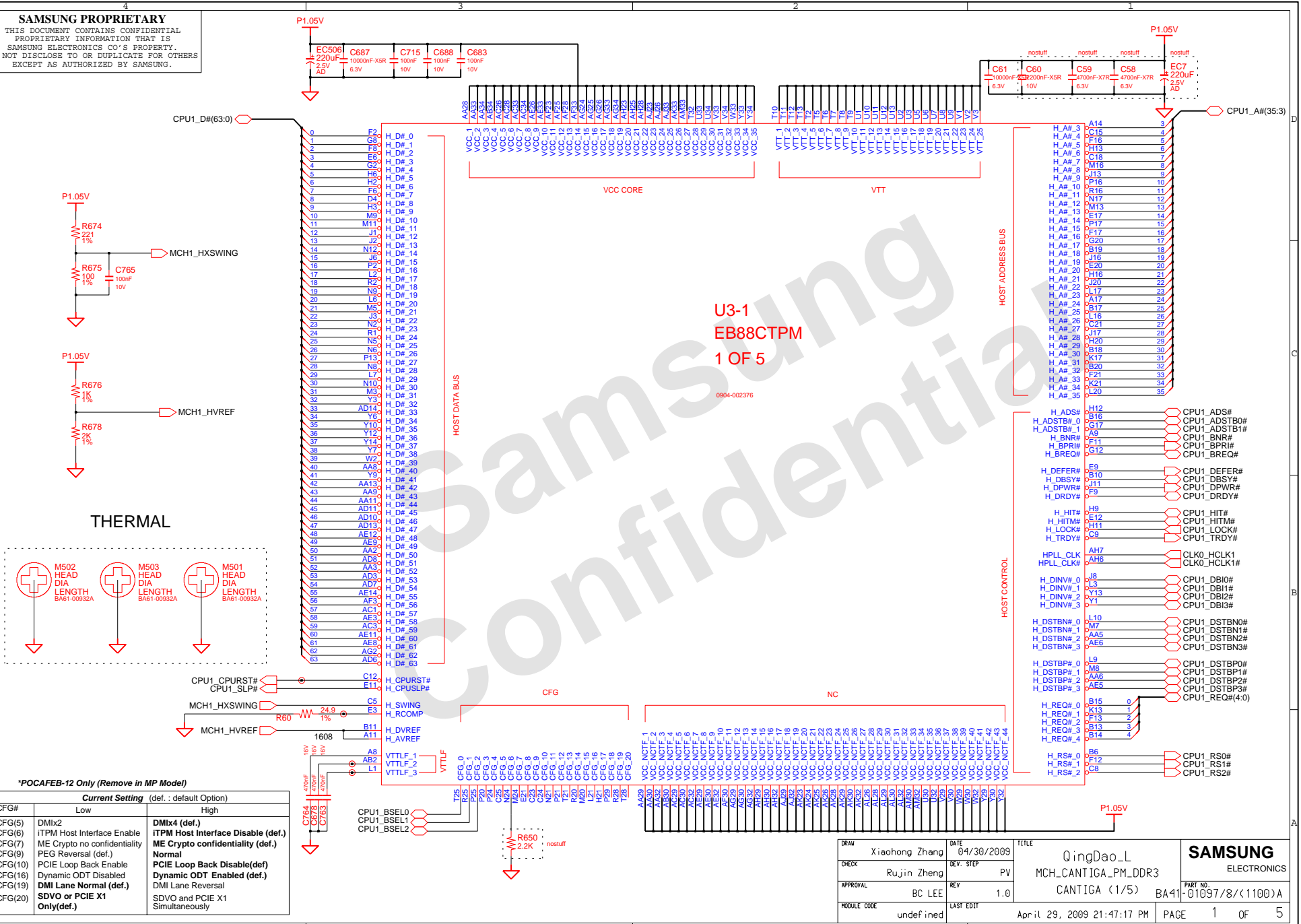
THERMAL SENSOR & FAN CONTROL

SHDN_SEL MODE	
0	CH1(INTEL MODE)
HIGH Z	CH3(DIODE MODE)
1	N/A (SHDN# NOT USED)



DESIGN	XIAOHONG, ZHANG	DATE	12/3/2008	TITLE	QingDao_Ext	SAMSUNG ELECTRONICS
CHECK	RUJIN, ZHENG	DEV. STEP	ADV1	THERMAL SENSOR EMC2102	PART NO.	
APPROVAL	BC, LEE	REV	1.0		BA41-xxxxxA	
MODULE CODE		LAST EDIT	December, 3, 2008 12:55:11 PM	PAGE	1	OF 1

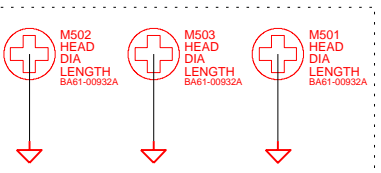
SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



U3-1
 EB88CTPM
 1 OF 5

0904-002376

THERMAL

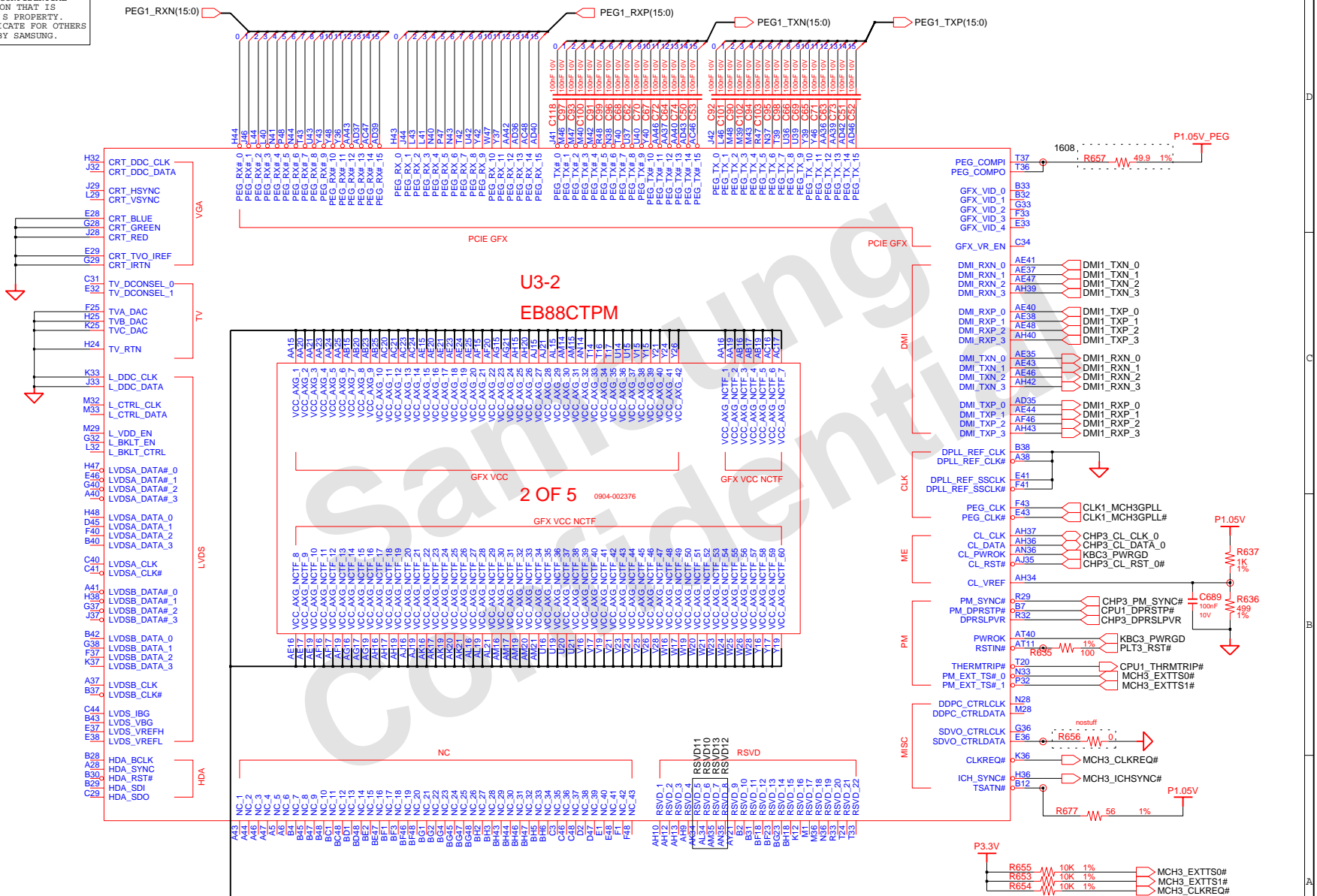


***POCAFEB-12 Only (Remove in MP Model)**

CFG#	Current Setting (def.: default Option)	Low	High
CFG(5)	DMIX2	DMIX4 (def.)	
CFG(6)	ITPM Host Interface Enable	ITPM Host Interface Disable (def.)	
CFG(7)	ME Crypto no confidentiality	ME Crypto confidentiality (def.)	
CFG(9)	PEG Reversal (def.)	Normal	
CFG(10)	PCIe Loop Back Enable	PCIe Loop Back Disable(def)	
CFG(16)	Dynamic ODT Disabled	Dynamic ODT Enabled (def.)	
CFG(19)	DMI Lane Normal (def.)	DMI Lane Reversal	
CFG(20)	SDVO or PCIe X1 Only(def.)	SDVO and PCIe X1 Simultaneously	

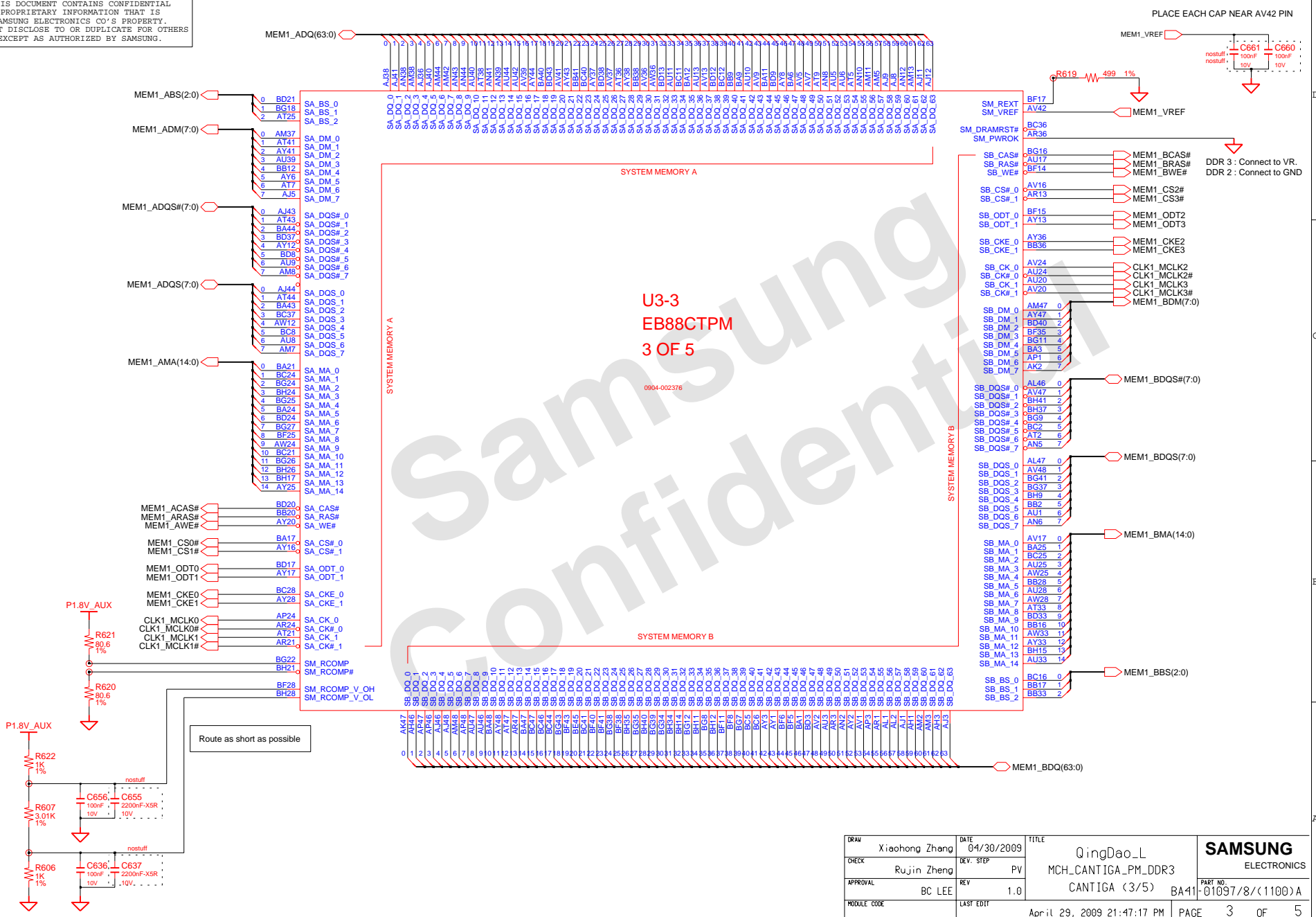
DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	MCH_CANTIGA_PM_DDR3		
APPROVAL	BC LEE	REV	1.0	CANTIGA (1/5)	BA41	PART NO. 01097/8/(1100)A
MODULE CODE	undefined	LAST EDIT	Apr 12, 2009 21:47:17 PM	PAGE	1	OF 5

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



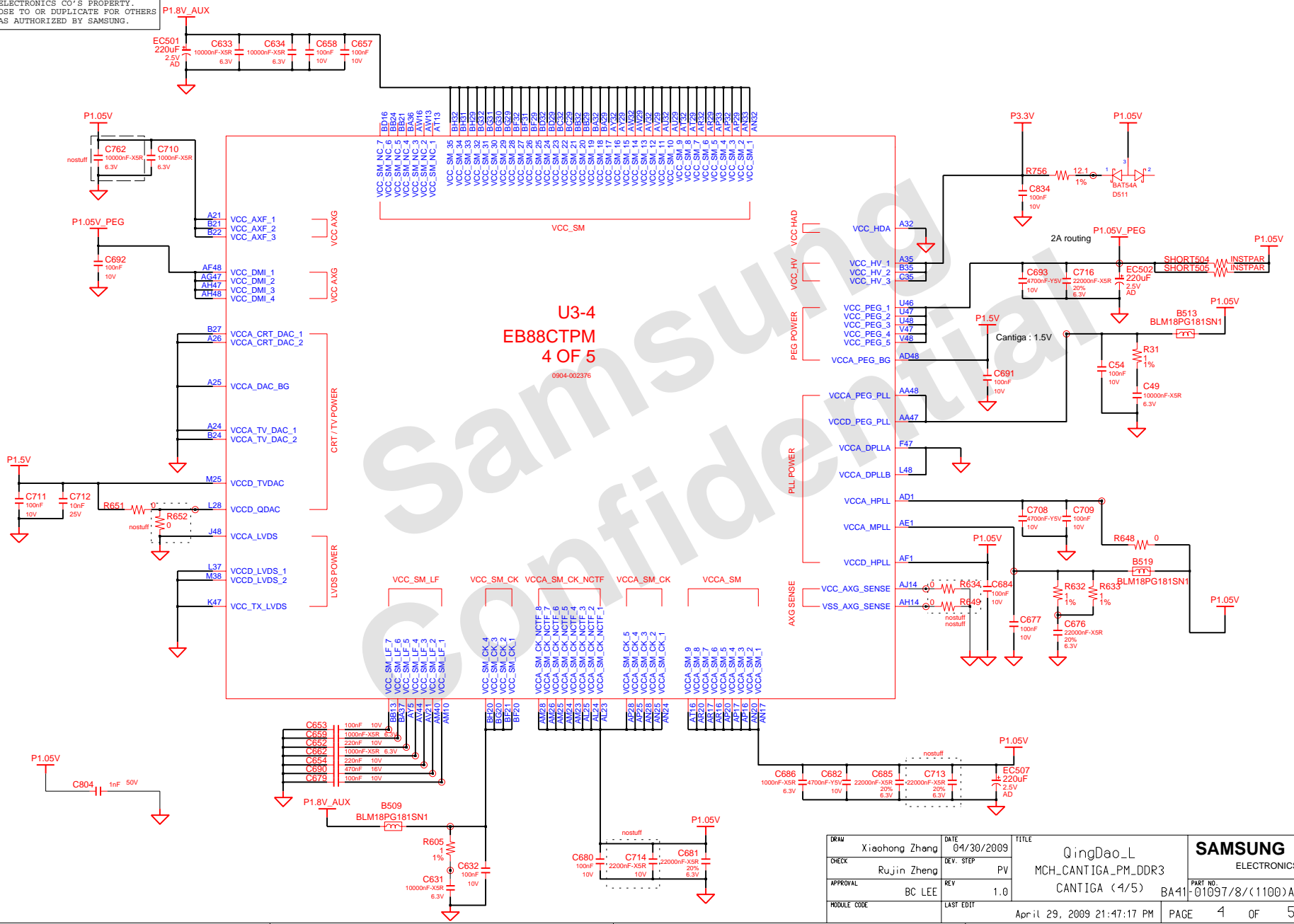
DRW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS	
CHECK	Rujin Zheng	DEV. STEP	PV	MCH_CANTIGA_PM_DDR3			
APPROVAL	BC LEE	REV	1.0	CANTIGA (2/5)	BA41-01097/8/(1100)A	PART NO.	
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	2	OF	5

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



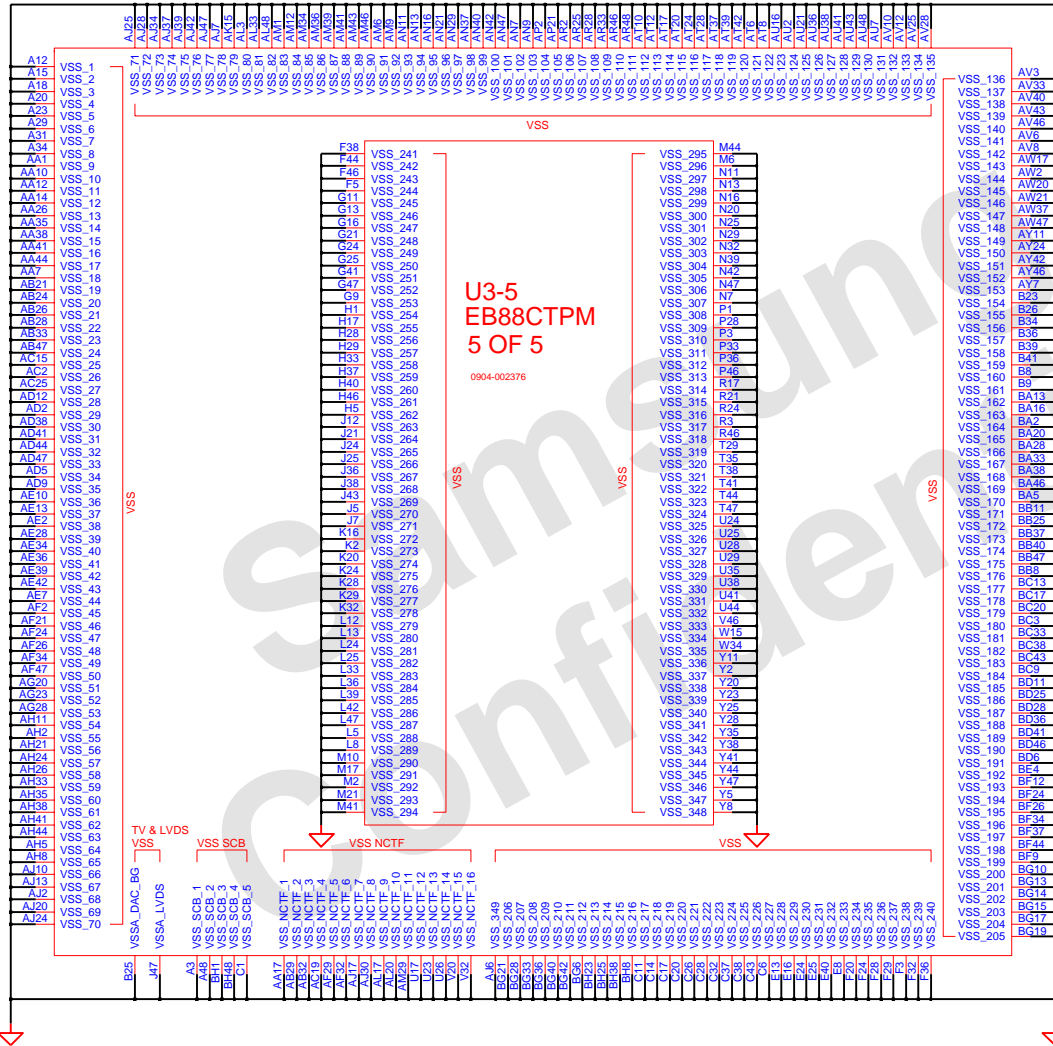
DRW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS PART NO. 01097/8/(1100)A
CHECK	Rujin Zheng	DEV. STEP	PV	MCH_CANTIGA_PM_DDR3		
APPROVAL	BC LEE	REV	1.0	CANTIGA (3/5)		
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	BA41		
			PAGE 3 OF 5			

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



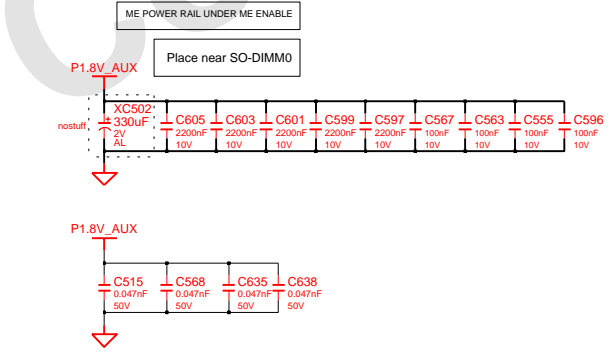
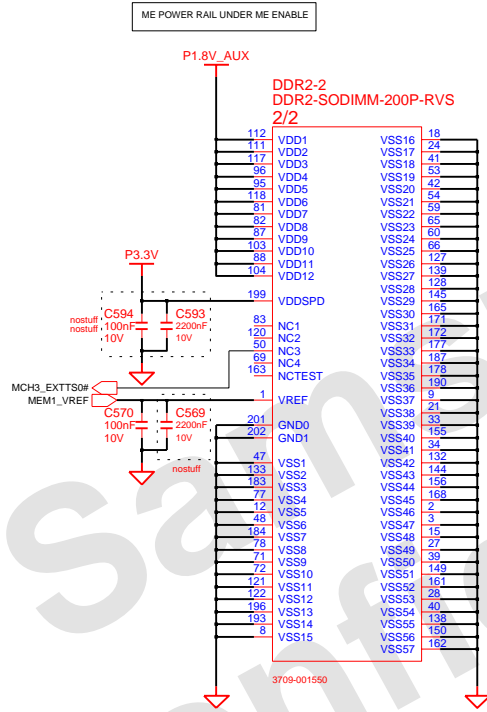
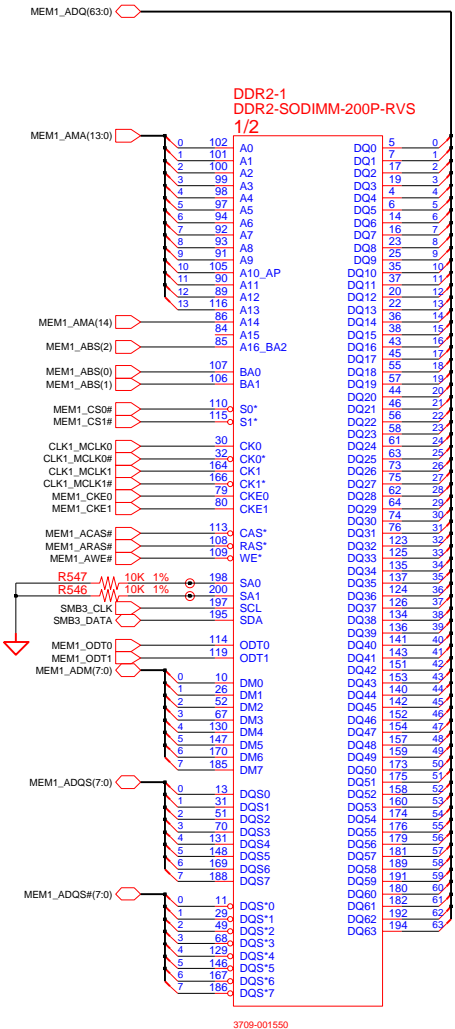
DRW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS PART NO. 01097/8/(1100)A
CHECK	Rujin Zheng	DEV. STEP	PV	MCH_CANTIGA_PM_DDR3		
APPROVAL	BC LEE	REV	1.0	CANTIGA (4/5)		
MODULE CODE		LAST EDIT		April 29, 2009 21:47:17 PM	PAGE 4 OF 5	

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

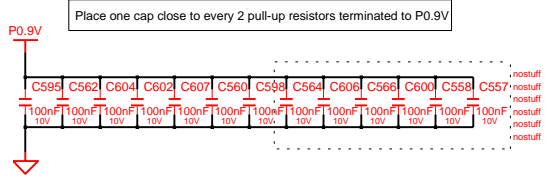
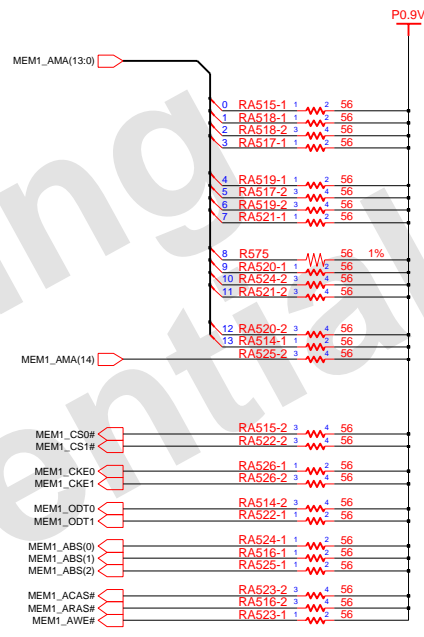


DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	MCH_CANTIGA_PM_DDR3		
APPROVAL	BC LEE	REV	1.0	CANTIGA (5/5)	BA41	PART NO.
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM			01097/8/(1100)A
				PAGE	5	OF
						5

DDR SO-DIMM #0



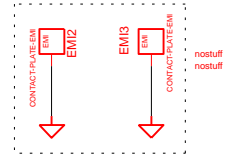
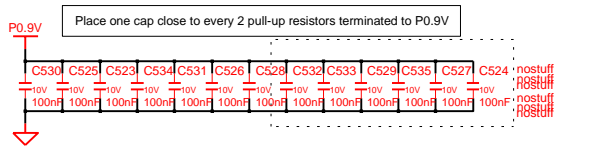
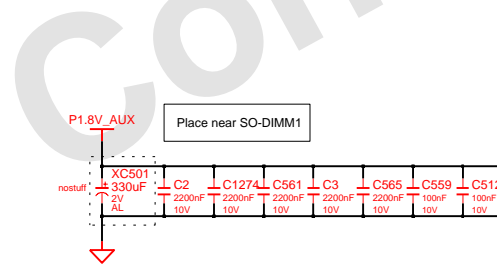
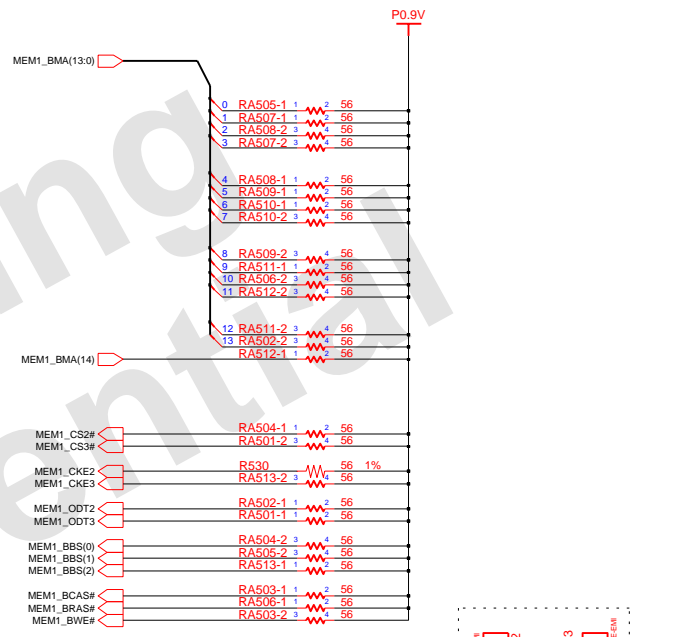
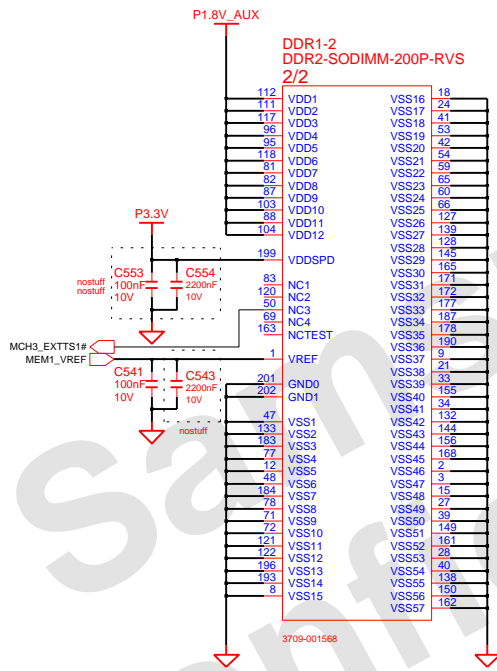
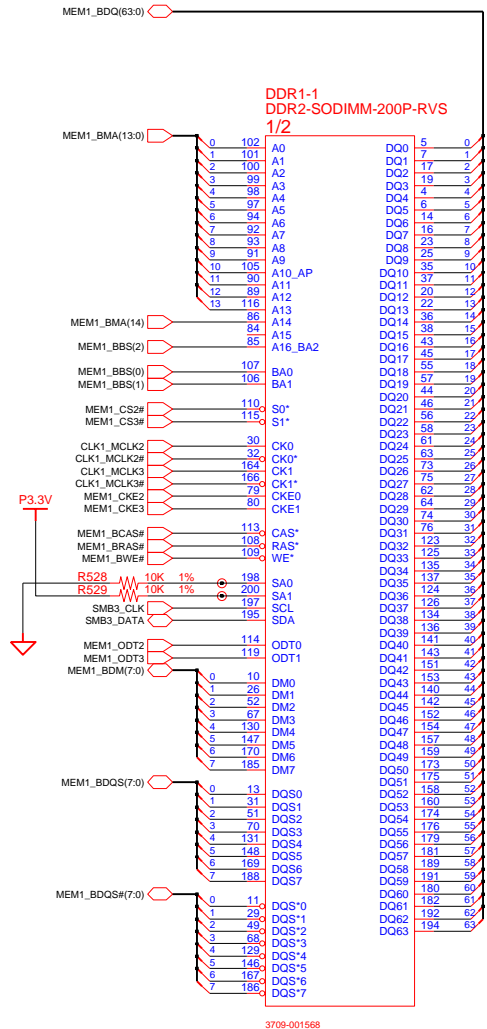
Array resistors & Single resistors used to improve layout & routing.



DRAW	XiaoHong Zheng	DATE	12/03/2008	TITLE	QingDao_Ext	SAMSUNG ELECTRONICS
CHECK	RuJin Zheng	DEV. STEP	ADV1	SODIMM_DDR2	PART NO.	
APPROVAL	BC LEE	REV	1.0	SODIMM_DDR2 #1	BA41-xxxxxA	
MODULE CODE		LAST EDIT	December 03, 2008 20:55:25 PM	PAGE	1 OF 2	

DDR SO-DIMM #1

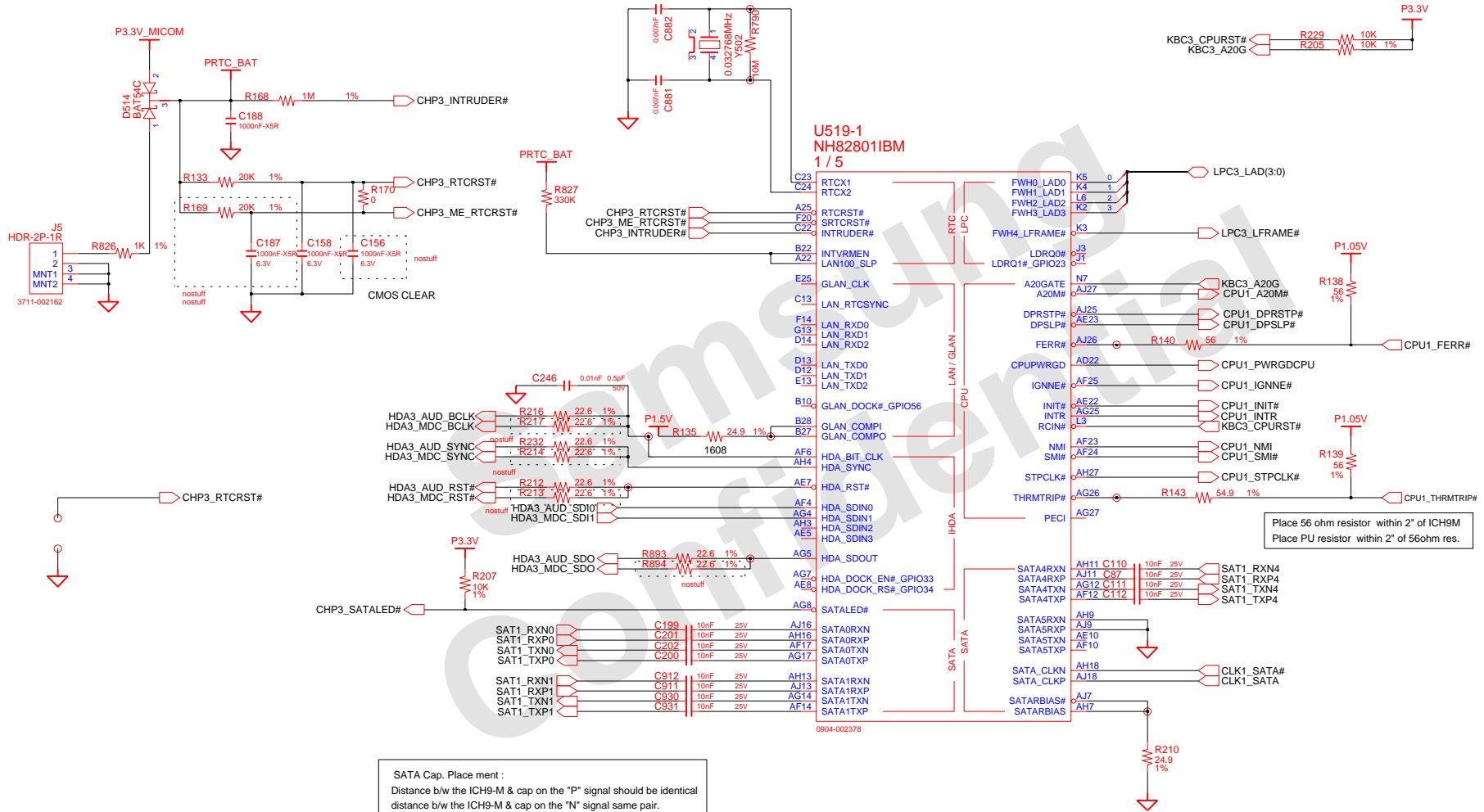
Array resistors & Single resistors used to improve layout & routing.



3709-001568

DRAW	XiaoHong Zheng	DATE	12/03/2008	TITLE	QingDao_Ext	SAMSUNG ELECTRONICS
CHECK	RuJin Zheng	DEV. STEP	ADV1	SODIMM_DDR2		
APPROVAL	BC LEE	REV	1.0	SODIMM_DDR2 #2		PART NO. BA41-xxxxxA
MODULE CODE		LAST EDIT	December 03, 2008 20:55:25 PM	PAGE	2 OF 2	

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

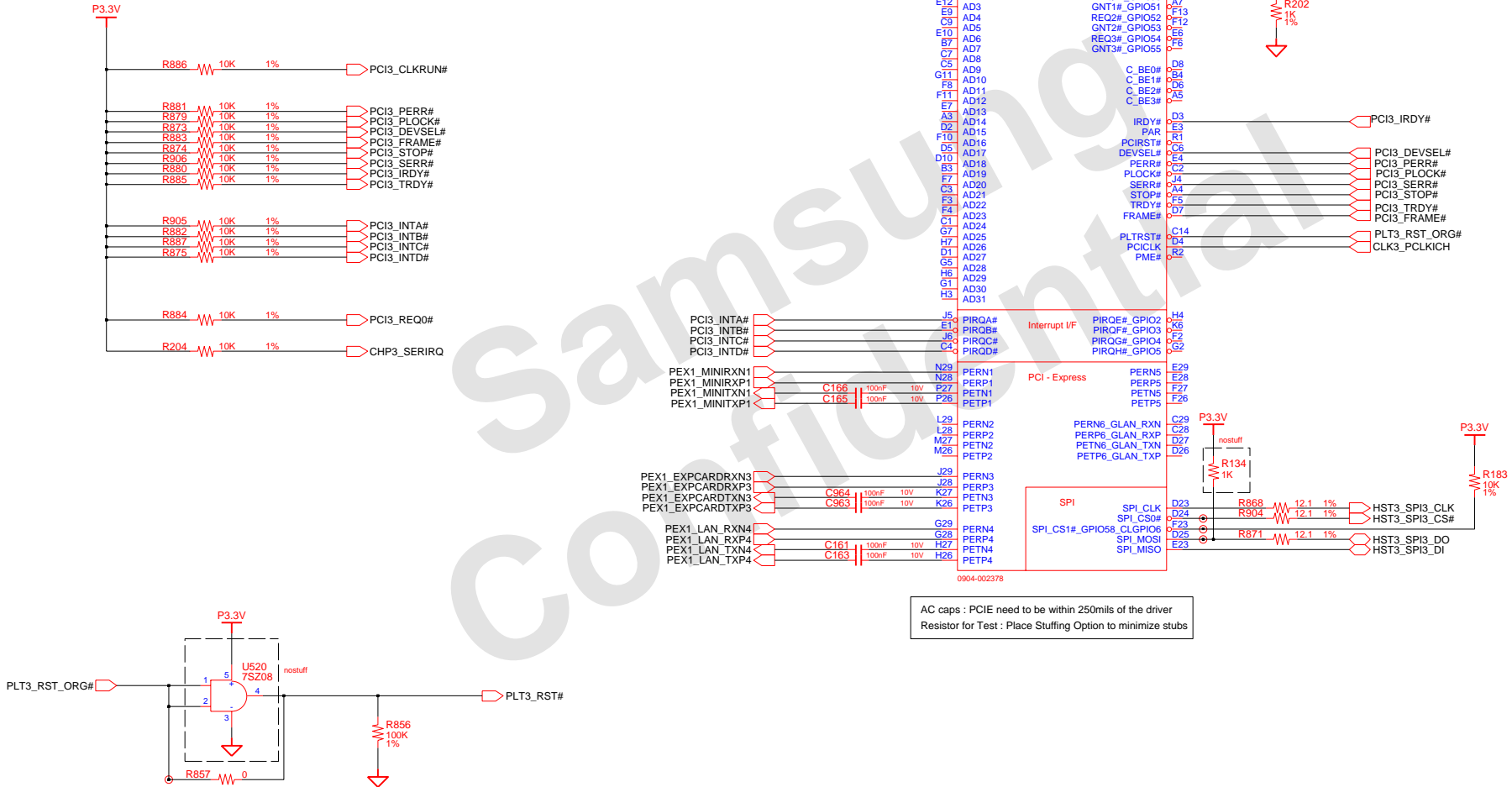


SATA Cap. Placement :
 Distance b/w the ICH9-M & cap on the "P" signal should be identical
 distance b/w the ICH9-M & cap on the "N" signal same pair.

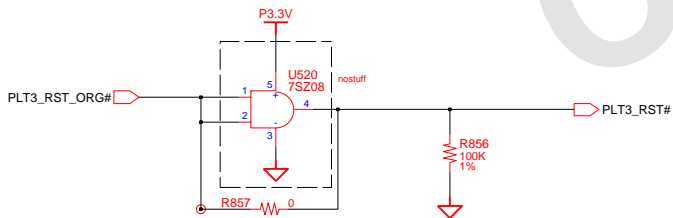
DRAW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS PART NO. BA41-01097/8/(1100)A
CHECK	Rujin Zheng	DEV. STEP	PV		ICH9_M_B	
APPROVAL	BC LEE	REV	1.0		ICH9-M (1/5)	
MODULE CODE		LAST EDIT		April 29, 2009 21:47:17 PM	PAGE 1 OF 5	

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

U519-2
NH82801IBM
2/5

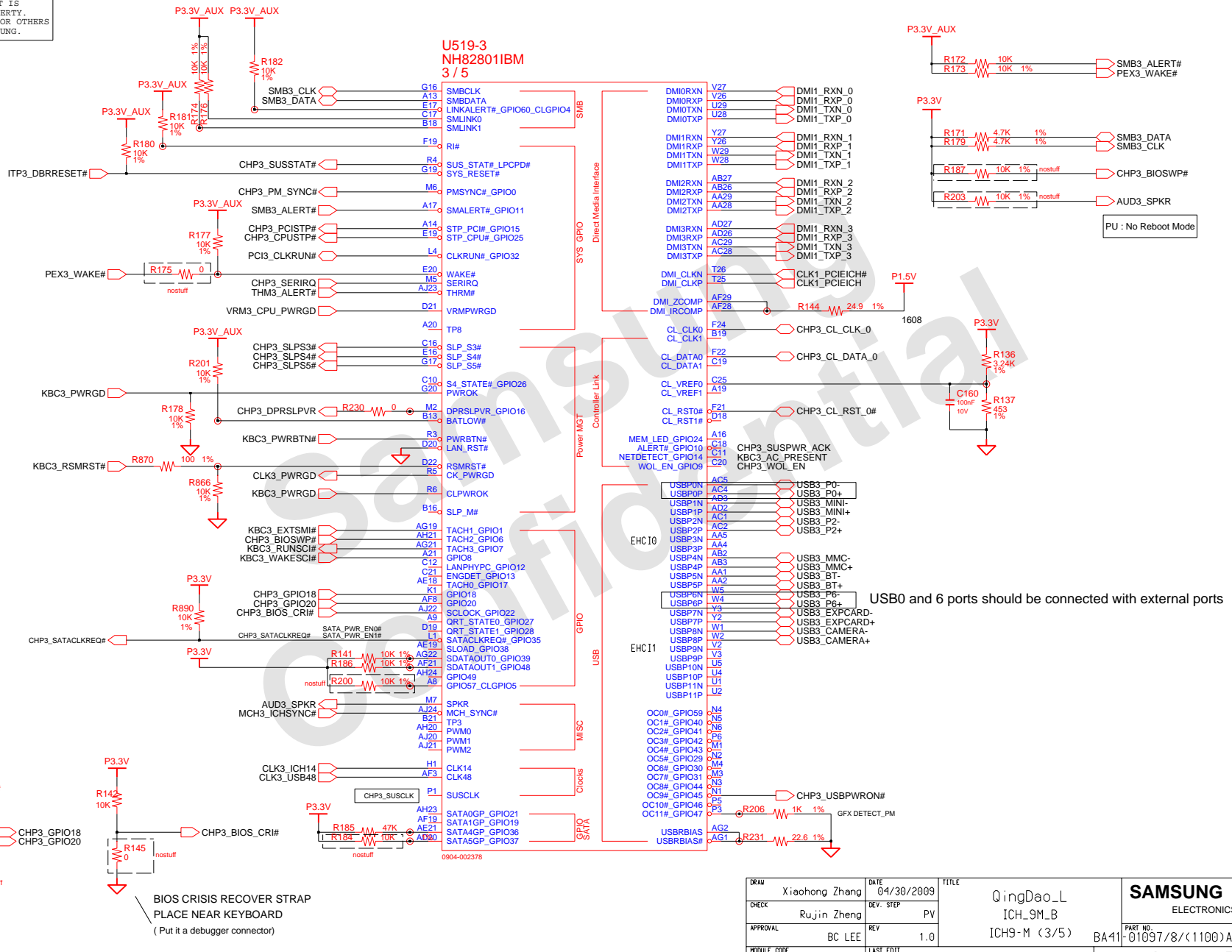


AC caps : PCIE need to be within 250mils of the driver
 Resistor for Test : Place Stuffed Option to minimize stubs



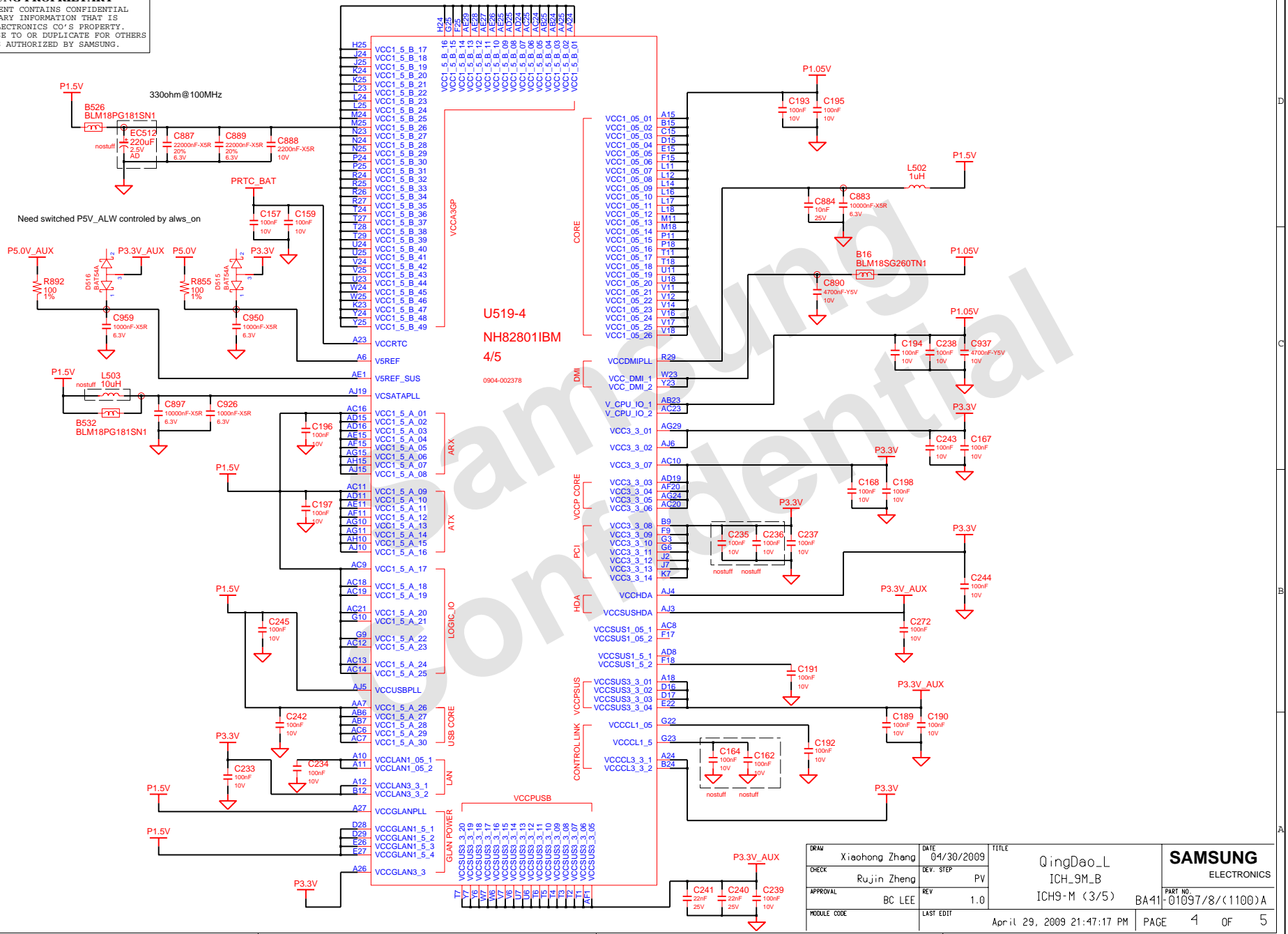
DRW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L ICH_9M_B	SAMSUNG ELECTRONICS	
CHECK	Rujin Zheng	DEV. STEP	PV				
APPROVAL	BC LEE	REV	1.0		ICH9-M (2/5)	PART NO.	
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	2	OF	5

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



DRN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS PART NO. 01097/8/(1100)A
CHECK	Rujin Zheng	DEV. STEP	PV	ICH_9M_LB		
APPROVAL	BC LEE	REV	1.0	ICH9-M (3/5)		
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM			
				PAGE	3 OF 5	

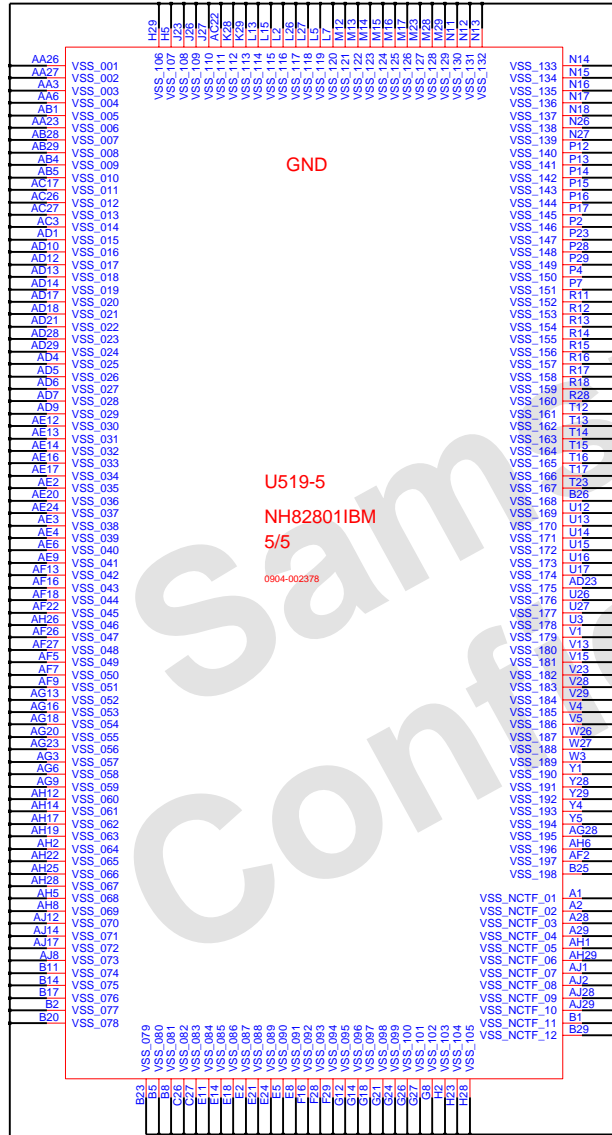
SAMSUNG PROPRIETARY
THIS DOCUMENT CONTAINS CONFIDENTIAL
PROPRIETARY INFORMATION THAT IS
SAMSUNG ELECTRONICS CO.'S PROPERTY.
NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
EXCEPT AS AUTHORIZED BY SAMSUNG.



NO.	NAME	VALUE
77	VCCUS3_3_20	100nF
78	VCCUS3_3_19	100nF
79	VCCUS3_3_18	100nF
80	VCCUS3_3_17	100nF
81	VCCUS3_3_16	100nF
82	VCCUS3_3_15	100nF
83	VCCUS3_3_14	100nF
84	VCCUS3_3_13	100nF
85	VCCUS3_3_12	100nF
86	VCCUS3_3_11	100nF
87	VCCUS3_3_10	100nF
88	VCCUS3_3_09	100nF
89	VCCUS3_3_08	100nF
90	VCCUS3_3_07	100nF
91	VCCUS3_3_06	100nF
92	VCCUS3_3_05	100nF
93	VCCUS3_3_04	100nF
94	VCCUS3_3_03	100nF
95	VCCUS3_3_02	100nF
96	VCCUS3_3_01	100nF
97	VCCUS3_3_00	100nF
98	VCCUS3_3_01	100nF
99	VCCUS3_3_02	100nF
100	VCCUS3_3_03	100nF
101	VCCUS3_3_04	100nF
102	VCCUS3_3_05	100nF
103	VCCUS3_3_06	100nF
104	VCCUS3_3_07	100nF
105	VCCUS3_3_08	100nF
106	VCCUS3_3_09	100nF
107	VCCUS3_3_10	100nF
108	VCCUS3_3_11	100nF
109	VCCUS3_3_12	100nF
110	VCCUS3_3_13	100nF
111	VCCUS3_3_14	100nF
112	VCCUS3_3_15	100nF
113	VCCUS3_3_16	100nF
114	VCCUS3_3_17	100nF
115	VCCUS3_3_18	100nF
116	VCCUS3_3_19	100nF
117	VCCUS3_3_20	100nF
118	VCCUS3_3_21	100nF
119	VCCUS3_3_22	100nF
120	VCCUS3_3_23	100nF
121	VCCUS3_3_24	100nF
122	VCCUS3_3_25	100nF
123	VCCUS3_3_26	100nF
124	VCCUS3_3_27	100nF
125	VCCUS3_3_28	100nF
126	VCCUS3_3_29	100nF
127	VCCUS3_3_30	100nF
128	VCCUS3_3_31	100nF
129	VCCUS3_3_32	100nF
130	VCCUS3_3_33	100nF
131	VCCUS3_3_34	100nF
132	VCCUS3_3_35	100nF
133	VCCUS3_3_36	100nF
134	VCCUS3_3_37	100nF
135	VCCUS3_3_38	100nF
136	VCCUS3_3_39	100nF
137	VCCUS3_3_40	100nF
138	VCCUS3_3_41	100nF
139	VCCUS3_3_42	100nF
140	VCCUS3_3_43	100nF
141	VCCUS3_3_44	100nF
142	VCCUS3_3_45	100nF
143	VCCUS3_3_46	100nF
144	VCCUS3_3_47	100nF
145	VCCUS3_3_48	100nF
146	VCCUS3_3_49	100nF
147	VCCUS3_3_50	100nF
148	VCCUS3_3_51	100nF
149	VCCUS3_3_52	100nF
150	VCCUS3_3_53	100nF
151	VCCUS3_3_54	100nF
152	VCCUS3_3_55	100nF
153	VCCUS3_3_56	100nF
154	VCCUS3_3_57	100nF
155	VCCUS3_3_58	100nF
156	VCCUS3_3_59	100nF
157	VCCUS3_3_60	100nF
158	VCCUS3_3_61	100nF
159	VCCUS3_3_62	100nF
160	VCCUS3_3_63	100nF
161	VCCUS3_3_64	100nF
162	VCCUS3_3_65	100nF
163	VCCUS3_3_66	100nF
164	VCCUS3_3_67	100nF
165	VCCUS3_3_68	100nF
166	VCCUS3_3_69	100nF
167	VCCUS3_3_70	100nF
168	VCCUS3_3_71	100nF
169	VCCUS3_3_72	100nF
170	VCCUS3_3_73	100nF
171	VCCUS3_3_74	100nF
172	VCCUS3_3_75	100nF
173	VCCUS3_3_76	100nF
174	VCCUS3_3_77	100nF
175	VCCUS3_3_78	100nF
176	VCCUS3_3_79	100nF
177	VCCUS3_3_80	100nF
178	VCCUS3_3_81	100nF
179	VCCUS3_3_82	100nF
180	VCCUS3_3_83	100nF
181	VCCUS3_3_84	100nF
182	VCCUS3_3_85	100nF
183	VCCUS3_3_86	100nF
184	VCCUS3_3_87	100nF
185	VCCUS3_3_88	100nF
186	VCCUS3_3_89	100nF
187	VCCUS3_3_90	100nF
188	VCCUS3_3_91	100nF
189	VCCUS3_3_92	100nF
190	VCCUS3_3_93	100nF
191	VCCUS3_3_94	100nF
192	VCCUS3_3_95	100nF
193	VCCUS3_3_96	100nF
194	VCCUS3_3_97	100nF
195	VCCUS3_3_98	100nF
196	VCCUS3_3_99	100nF
197	VCCUS3_3_100	100nF

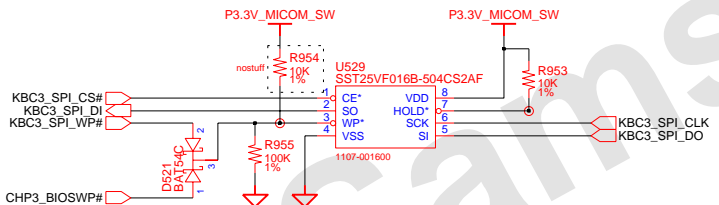
NO.	NAME	VALUE
241	VCC241	22nF
240	VCC240	22nF
239	VCC239	100nF

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

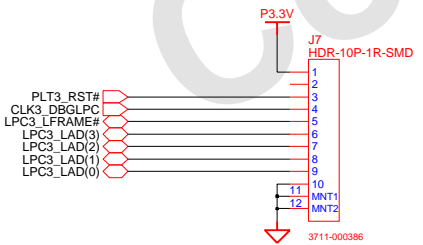


DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	ICH_9M_B		
APPROVAL	BC LEE	REV	1.0	ICH9-M (3/5)	BA41	PART NO. 01097/8/(1100)A
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	4	OF 5

SPI_BIOS_ROM



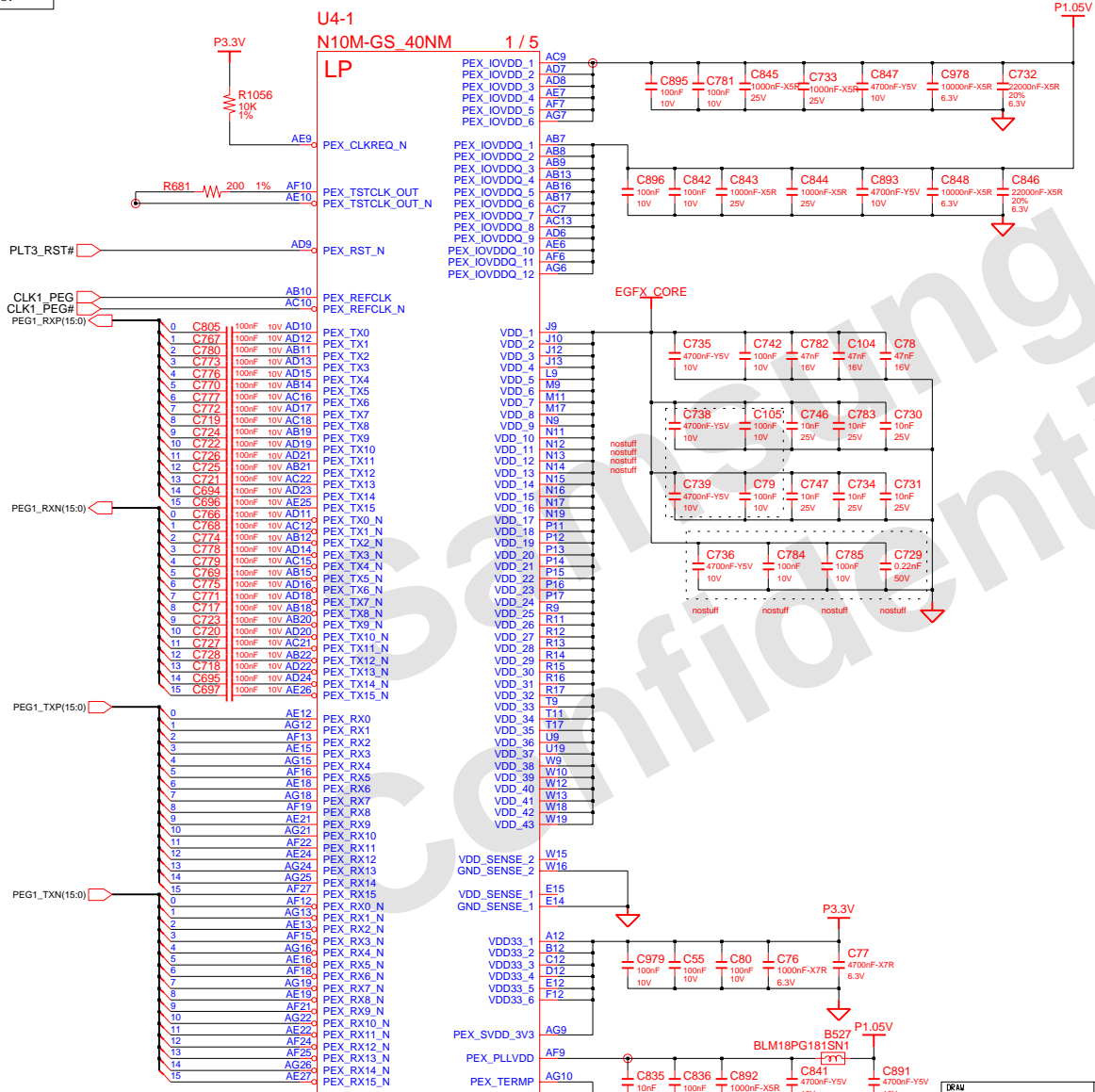
80H DECODER CONNECTOR



02	VERIFY REAL MODE	66	CONFIGURE ADVANCE CACHE REG.
03	DISABLE NMI	6A	DISPLAY EXTERNAL CACHE SIZE
04	GET CPU TYPE	6C	DISPLAY SHADOW MESSAGE
06	INIT. SYSTEM H/W	6E	DISPLAY NON-DISPOSABLE SEGMENT
08	INIT. CHIPSET REG.	70	DISPLAY ERROR MESSAGE
09	SET IN POST FLAG	72	CHECK FOR CONFIGURATION ERROR
0A	INIT CPU REG	74	TEST REAL-TIME CLOCK
0B	CPU CACHE ON	76	CHECK FOR KEYBOARD ERROR
0C	INIT CACHE TO POST	7C	SETUP HARDWARE INTERRUPT VECTOR
0E	INIT. I/O VALUE	7E	TEST COPROCESSER IF PRESENT
0F	ENABLE THE L-BUS IDE	80	DISABLE ON-BOARD I/O PORT
10	INIT. POWER MANAGER	82	DETECT AND INSTALL EXT RS232C
11	LOAD ALTERNATE REG.	84	DETECT AND INSTALL EXT PARALLEL
13	PCI BUS MASTER RESET	86	RE-INIT. ON-BOARD I/O PORT
		88	INIT. BIOS DATA ROM
14	INIT. KEYBOARD CONTROLLER	8A	INIT. EXTENDED BIOS DATA AREA
16	CHECK CHECKSUM	8C	INIT. FDD CONTROLLER
18	8254 TIMER INIT.	9A	SHADOW OPTION ROMS
1A	8237 DMA CONTROLLER INIT.	9C	SETUP POWER MANAGEMENT
1C	RESET INTERRUPT CONTROLLER	9E	ENABLE HW INTERRUPT
20	TEST DRAM REFRESH	A0	SET TIME OF DAY
22	TEST 8742 KEYBOARD CONTROLLER	A4	INIT. TYPEMATIC RATE
24	SET ES SEGMENT REG. TO 4GB	A8	ERASE F2 PROMPT
26	ENABLE A20	AA	SCAN FOR F2 KEY STROKE
28	AUTO SIZING DRAM	AC	ENTER SETUP
32	COMPUTE THE CPU SPEED	AE	CLEAR IN POST FLAG
34	TEST CMOS RAM	B0	CHECK FOR ERRORS
38	SHADOW SYSTEM BIOS ROM	B2	POST DONE-PREPARE TO BOOT O/S
3A	AUTO SIZING CACHE	B4	ONE BEEP
3C	CONFIGURE ADVANCED CHIPSET REG.	B6	CHECK PASSWORD (OPTION)
3D	LOAD ALTER REG. WITH CMOS VALUE	B7	ACPI INIT
42	INIT. INTERRUPT VECTOR	BA	DMI INIT
44	INIT. BIOS INTERRUPT	BE	CLEAR SCREEN
46	CHECK ROM COPYRIGHT NOTICE	C0	TRY BOOT WITH INT19
47	INIT. I20 SUPPORT IF INSTALLED	D0	INTERRUPT HANDLER ERROR
48	CHECK VIDEO CONFIGURE AGAINST CMOS	D2	UNKNOWN INTERRUPT ERROR
49	INIT. PCI BUS AND DEVICE	D4	PENDING INTERRUPT ERROR
4A	INIT. ALL VIDEO BIOS ROM	D6	SHUTDOWN 5
4C	SHADOW VIDEO BIOS ROM	D8	SHUTDOWN ERROR
50	DISPLAY CPU TYPE AND SPEED	DA	EXTENDED BLOCK MOVE
52	TEST KEYBOARD	DC	SHUTDOWN 10
54	SET KEYLOCK IF ENABLED	89	ENABLE NMI
56	ENABLE KEYBOARD	90	INIT. HDD CONTROLLER
58	TEST FOR UNEXPECTED INTERRUPTS	91	INIT. LOCAL BUS HDD CONTROLLER
5A	DISPLAY "PRESS SETUP"	92	JUMP TO USER PATCH 2
5C	TEST RAM BETWEEN 512K AND 640K	94	DISABLE A20 ADDRESS LINE
60	TEST EXTENDED MEMORY	96	CLEAR HUGE ES SEGMENT REG.
62	TEST EXTENDED MEMORY ADDRESS LINE	98	SEARCH FOR OPTION ROMS
64	JUMP TO USER PATCH 1		

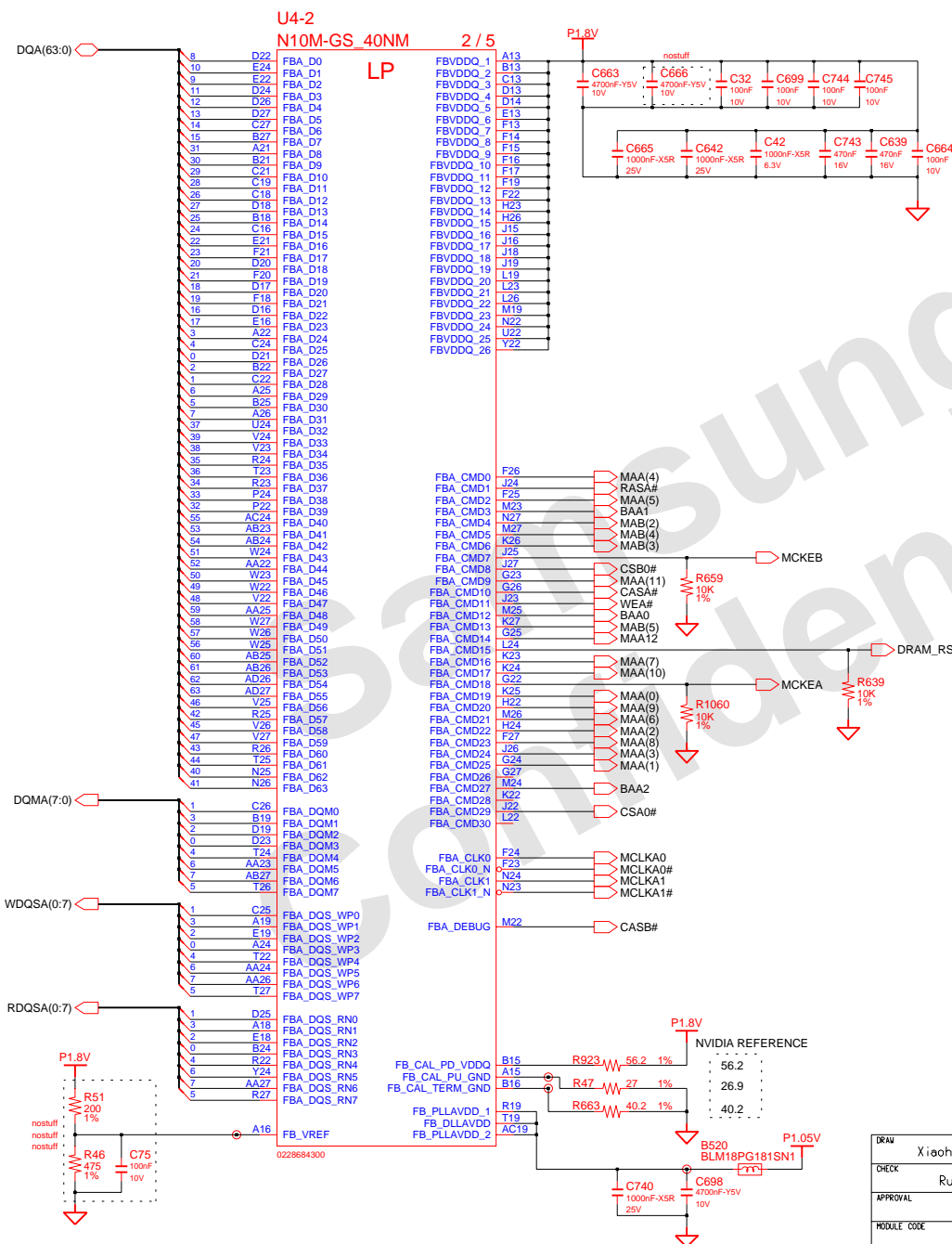
DRW	XiaoHong Zhang	DATE	12/03/2008	TITLE	QingDao_Ext	SAMSUNG ELECTRONICS PART NO. BA41-xxxxxA
CHECK	RuJin Zheng	DEV. STEP	ADV1		SPI_BIOS_ROM	
APPROVAL	BC LEE	REV	1.0		SPI_BIOS_ROM	
MODULE CODE		LAST EDIT	December 03, 2008 20:56:20 PM	PAGE	1 OF 1	

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



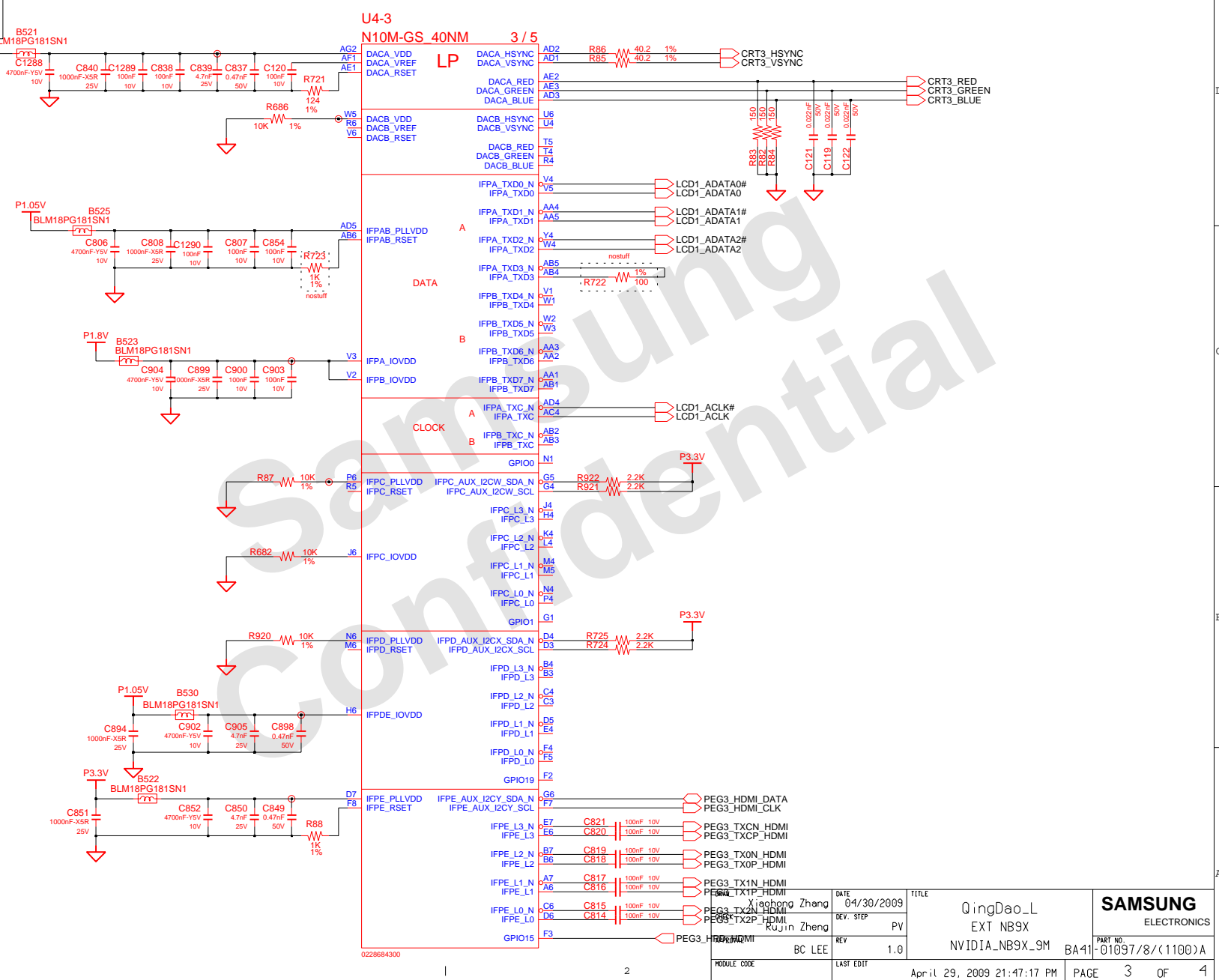
DRN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L EXT_NB9X	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	NVIDIA_NB9X_9M BA41-01097/8/(1100)A		
APPROVAL	BC LEE	REV	1.0	PART NO.		PAGE 1 OF 4
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE		

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L EXT NB9X	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	NVIDIA_NB9X_9M		
APPROVAL	BC LEE	REV	1.0	PART NO. BA41-01097/8/(1100)A		PAGE 2 OF 4
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM			

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



DATE	04/30/2009	TITLE	QingDao_L EXT_NB9X	SAMSUNG ELECTRONICS PART NO. BA41-01097/8/(1100)A
DEV. STEP	PV	REV	NVIDIA_NB9X_9M	
MODULE CODE	LAST EDIT	DATE	Apr 19, 2009 21:47:17 PM	PAGE 3 OF 4

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

Pin	Description	Activate
GPIO(0)	General Purpose	NC
GPIO(1)	HPD-C	NC
GPIO(2)	LCDD_BL_PWM	High
GPIO(3)	LCDD_VDD	High
GPIO(4)	LCDD_BL_EN	High
GPIO(5)	GPU VID0	00 0.8V
GPIO(6)	GPU VID1	10 0.85V
GPIO(7)	GPU VID2	NC
GPIO(8)	OVERT	LOW
GPIO(9)	ALERT	NC
GPIO(10)	MEM_VREF	NC
GPIO(11)	SLI_SYNC	NC
GPIO(12)	PWR_LEVEL	NC
GPIO(13)	MEM_VID	NC
GPIO(14)	PWR_CTRL1	NC
GPIO(15)	HPD-E	High
GPIO(16)	FAN_PWM	NC
GPIO(17)	Reserved	NC
GPIO(18)	Reserved	NC
GPIO(19)	HPD-D	NC

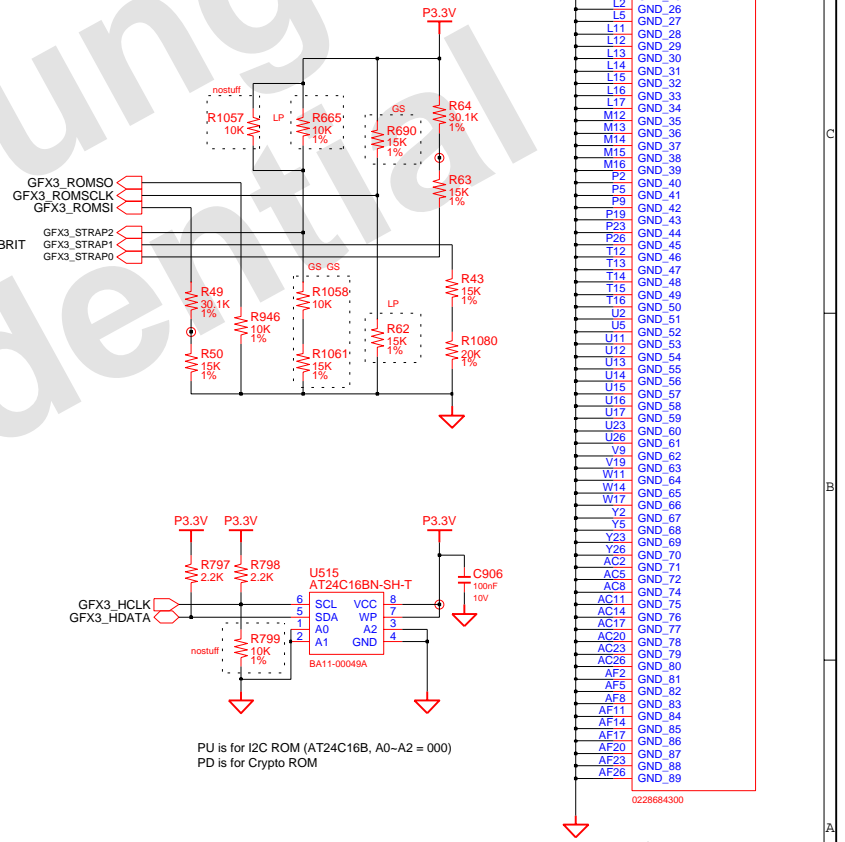
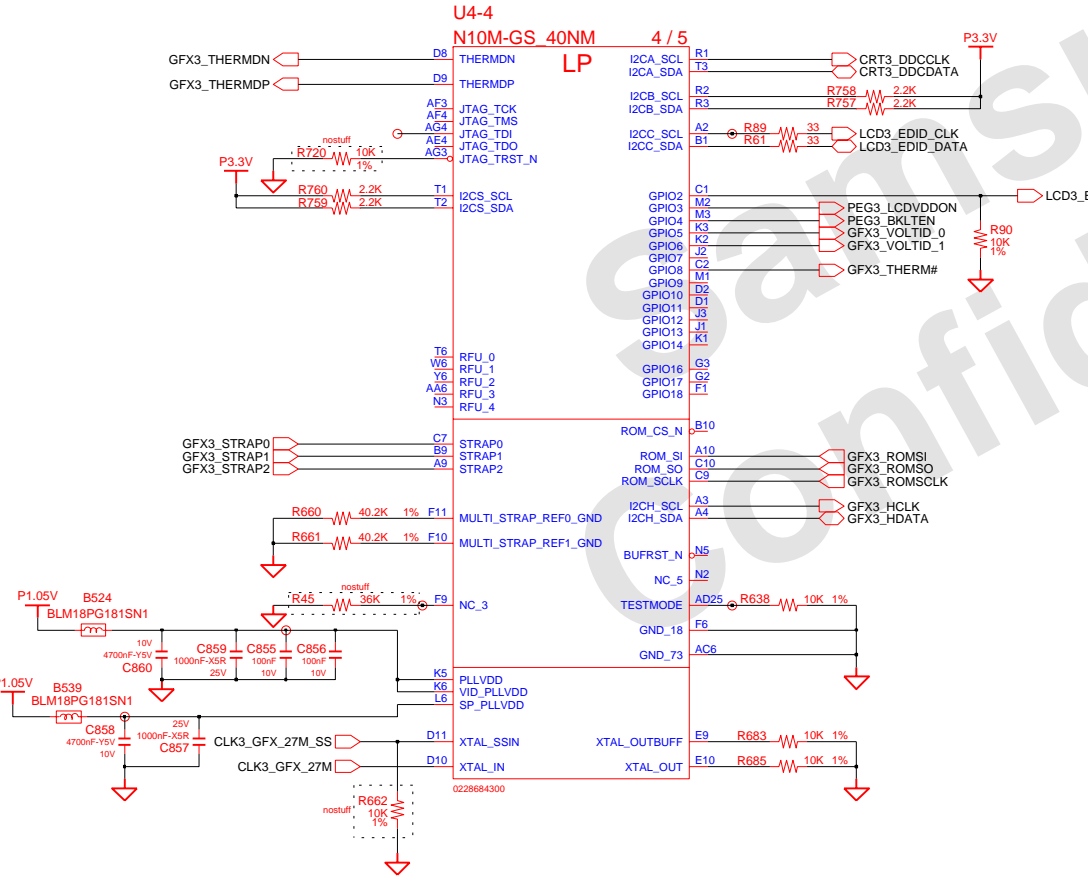
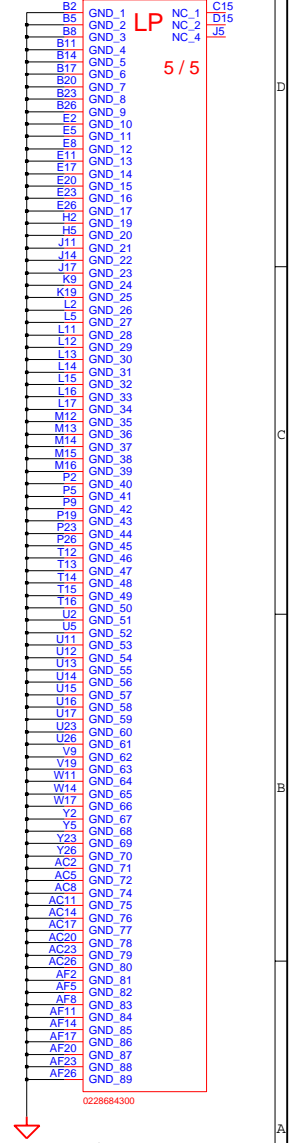
Strap option	Bit 3	Bit 2	Bit 1	Bit 0
ROM_SO	XCLK_417	FB_0_BAR_SIZE	SMB_ALT_ADDR	VGA_DEVICE
ROM_SCLK	DEVID[4]	VENID	CLK_CFG	PLL_TERM
ROM_SI	RAMCFG[3]	RAMCFG[2]	RAMCFG[1]	RAMCFG[0]
STRAP2	DEVID[3]	DEVID[2]	DEVID[1]	DEVID[0]
STRAP1	PADCFG[3]	PADCFG[2]	PADCFG[1]	PADCFG[0]
STRAP0	USER[3]	USER[2]	USER[1]	USER[0]
Resistor value	PU to VDD	PD to GND	XCLK417 = 0.27MHz	
5K ohm	1000	0000	RAM CFG (SEC)	
10 Kohm	1001	0001	0011 512Mbit 0111 1Gbit	
15K ohm	1010	0010	USER[3:0]=1111 for EDID	
20K ohm	1011	0011	PADCFG[3:0]=0110 for NB	
25K ohm	1100	0100	N10M-GS:0x0A74	
30K ohm	1101	0101	N10M-GE:0x0A68	
35K ohm	1110	0110	N10M-LP:0x0A69	
45K ohm	1111	0111	N10M-NS:0x0A6C	
			N10M-NE:0x0A6A	
			N10M-GLM:0x0A7C	

	Bit3	Bit2	Bit1	Bit0	
ROMSO	0	0	0	1	27M
SCLK	0	0	1	0	GFXTYPE
SI	0	1	1	1	1Gb
Strap2	1	0	0	1	N10M-LP DEVICE ID
Strap1	0	1	1	0	For NB
Strap0	1	1	1	1	EDID_EN

U4-5
N10M-GS_40NM

LP NC.1 D15
 NC.2 D5
 NC.4 J5

5 / 5



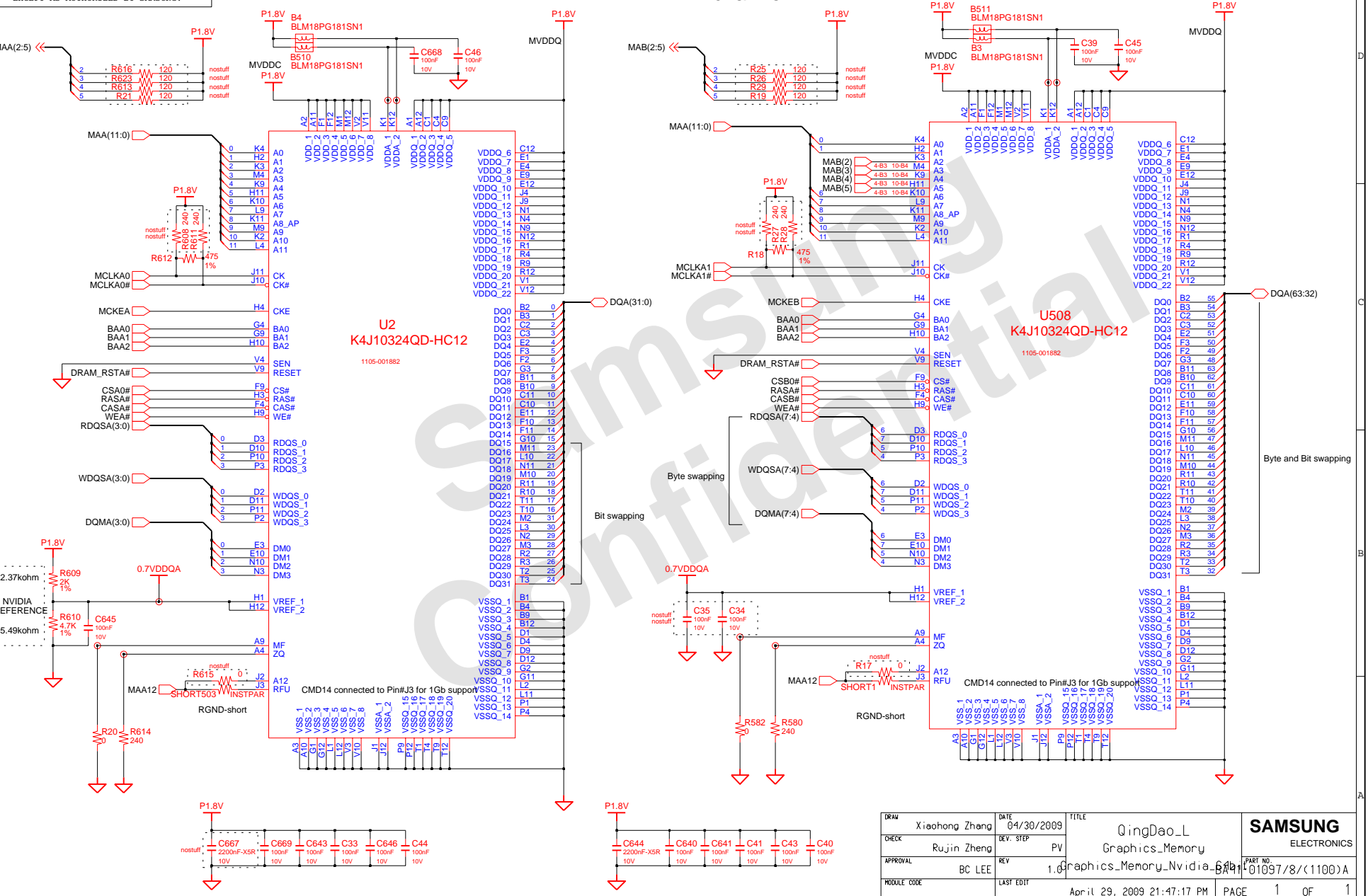
PU is for I2C ROM (AT24C16B, A0-A2 = 000)
 PD is for Crypto ROM

DRWN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L EXT_NB9X NVIDIA_NB9X_9M	PART NO.	BA11-01097/8/(1100)A
CHECK	Rujin Zheng	REV. STEP	PV				
APPROVAL	BC LEE	REV	1.0				
MODULE CODE		LAST EDIT		April 29, 2009 21:47:17 PM	PAGE	4	OF 4

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL PROPRIETARY INFORMATION THAT IS SAMSUNG ELECTRONICS CO.'S PROPERTY. NOT DISCLOSE TO OR DUPLICATE FOR OTHERS EXCEPT AS AUTHORIZED BY SAMSUNG.

nVidia can support 700MHz, but for N10M_GE, there only debug 800MHz about VBIOS

A-channel

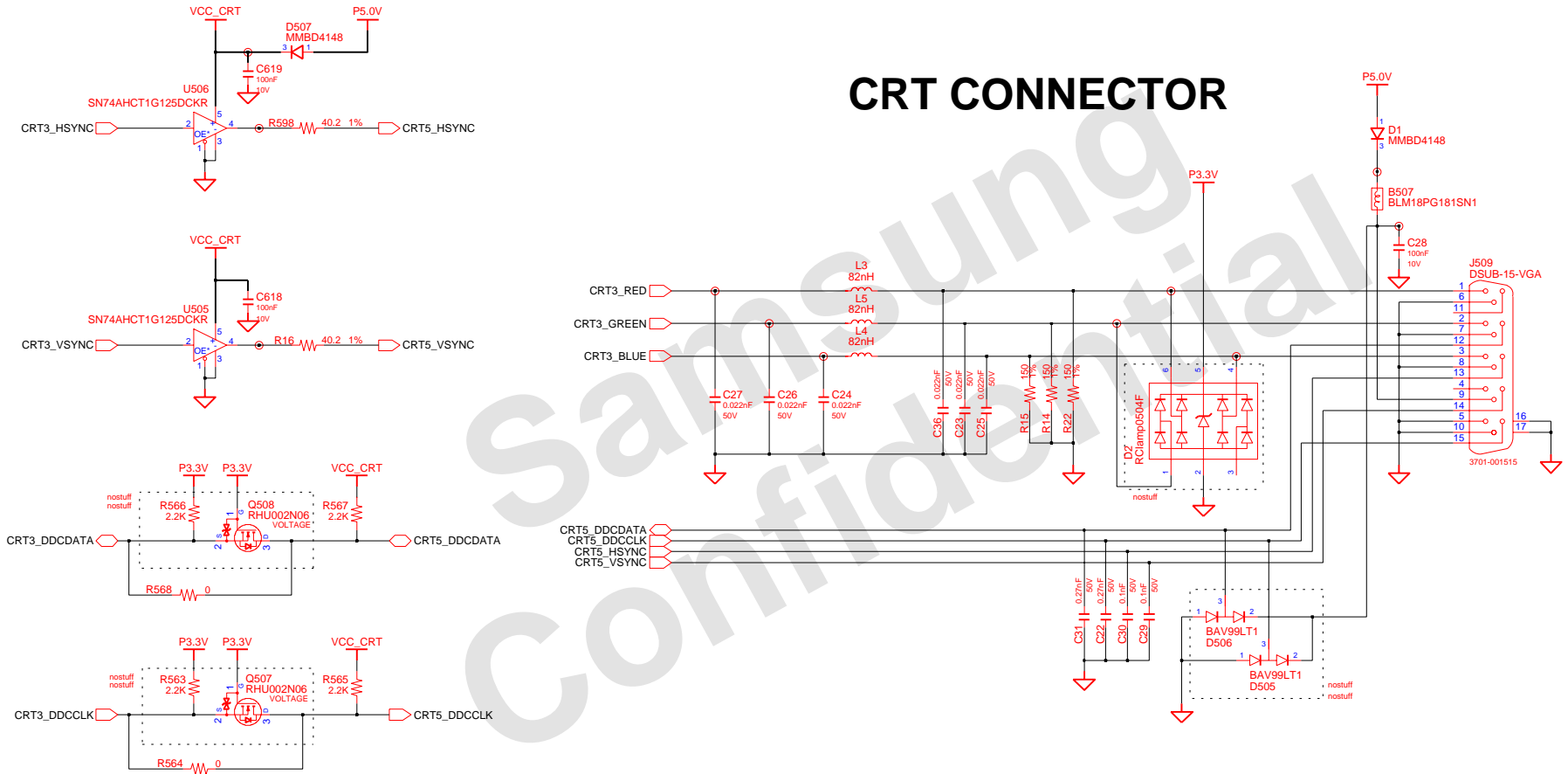


DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	Graphics_Memory		
APPROVAL	BC LEE	REV	1.0	Graphics_Memory_Nvidia_64bit		PART NO. E01097/8/(1100)A
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM		PAGE	1 OF 1

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

CRT

CRT CONNECTOR



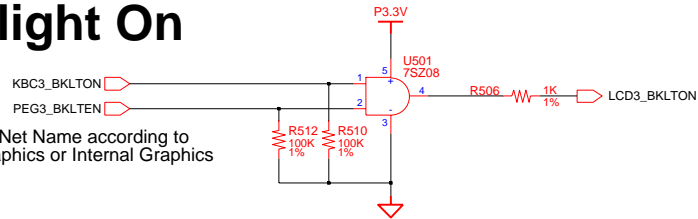
Check "CRT3_DDCCLK/DATA" Voltage Level
 2N06 Can be replaced with SM6K2

DESIGN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L GRAPHICS_IF CRT	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	BA41-01097/8/(1100)A		
APPROVAL	BC LEE	REV	1.0	April 29, 2009 21:47:17 PM	PAGE	undefined
MODULE CODE		LAST EDIT				

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

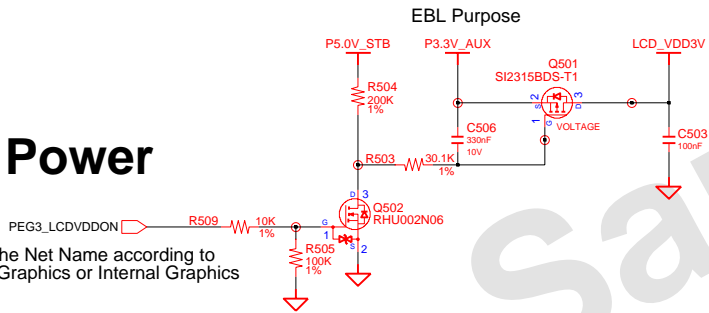
LVDS

Backlight On



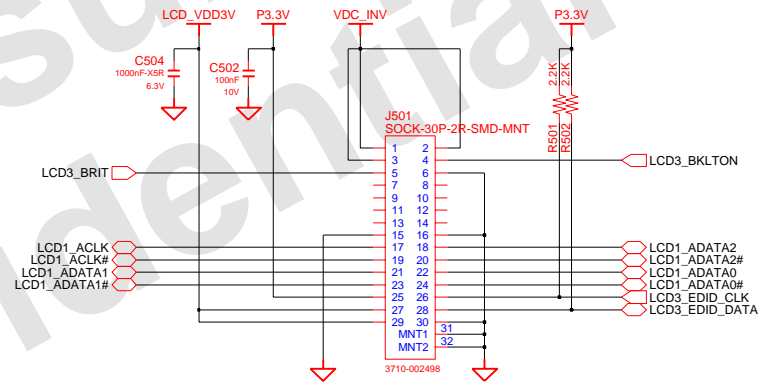
Change the Net Name according to
 External Graphics or Internal Graphics

LCD Power

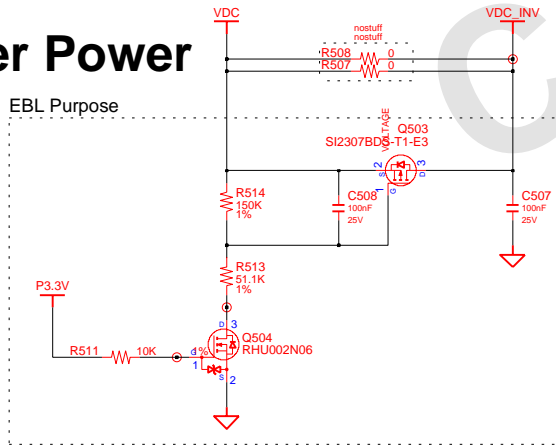


Change the Net Name according to
 External Graphics or Internal Graphics

1Ch. LCD Connector



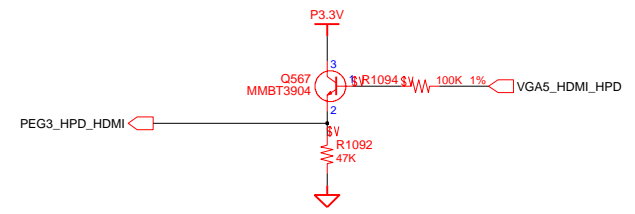
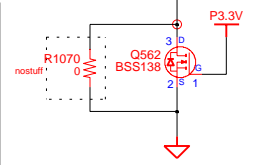
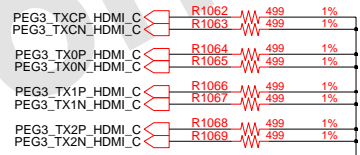
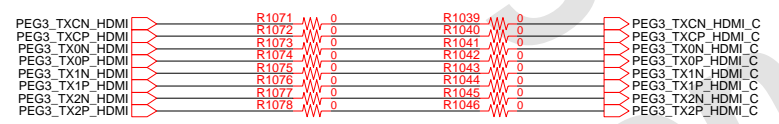
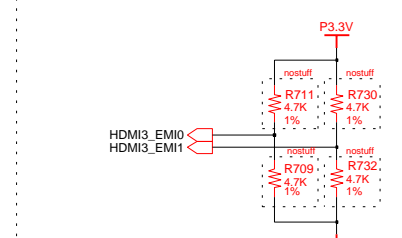
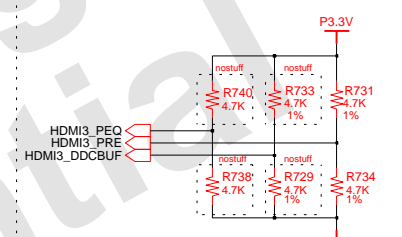
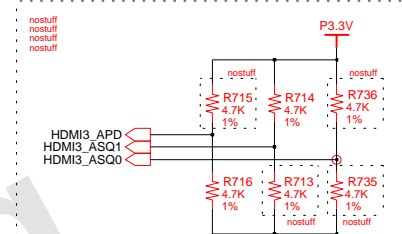
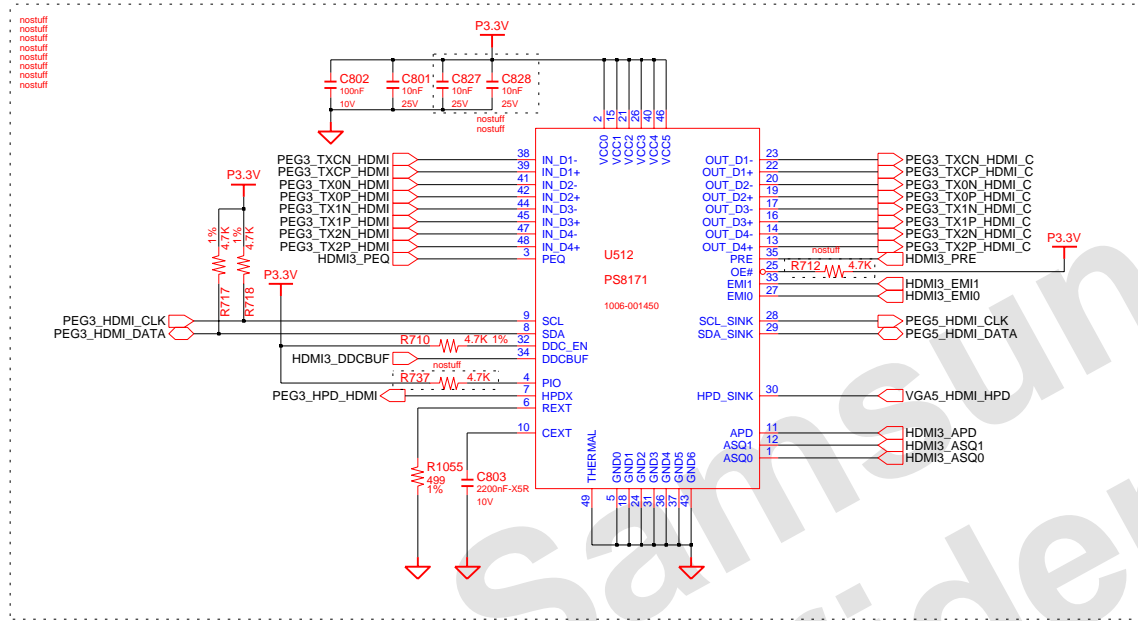
Inverter Power



DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	GRAPHICS_IF		
APPROVAL	BC LEE	REV	1.0	LCD	BA41-01097/8/(1100)A	PART NO.
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	2	of

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

HDMI Level Shifter(Pre-emp)



APD ASQ0,ASQ1 Same setting as PS8101. Debug in PV stage, then confirm value.

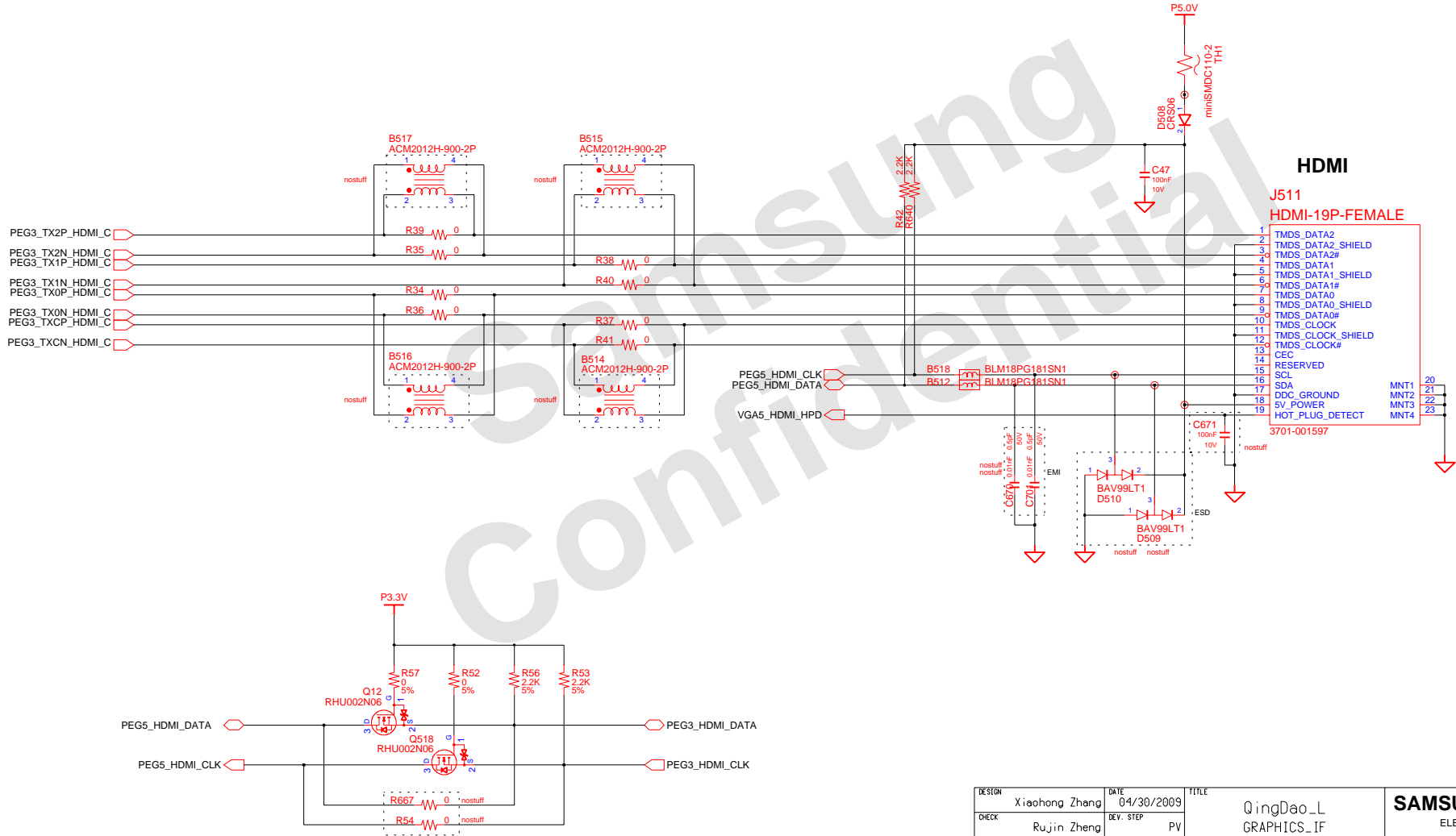
APD	Automatic power down management	internal PU: R=500Kohm
	APD=LOW: Automatic power down disable	
	APD=High: Automatic power down enable	
	APD=MID: Reserved	
EMIOEM1	EMI reduction and filter setting	EM1:internal PU: R=500Kohm EMIO:internal PD: R=500Kohm
	[EM1,EMIO]=HL: no EMI reduction	
	EMIO=High: Reduced rise/fall time	
	MID: Reduced rise/fall time 2nd	
	EM1=LOW: EMI filter setting 1	
	MID: Reserved	
ASQ0,ASQ1	Automatic squelch function	internal PD: R=500Kohm
	[ASQ1,ASQ0]=	
	HL: No automatic squelch	
	LL: Automatic squelch enable, Level=120mVpp, default timer	
	LH: Automatic squelch enable, Level=100mVpp, default timer	
	HH: Automatic squelch enable, Level=80mVpp, default timer	
	ML: Automatic squelch enable, Level=120mVpp, extended timer	
	MH: Automatic squelch enable, Level=100mVpp, extended timer	
	LM: Automatic squelch enable, Level=80mVpp, extended timer	
	HM: Reserved	
	MM: Reserved	

HPDX	Define by PIO	
	PIO=Low: HPD=HPD_SINK @ 3.3V COMS output	
	PIO=High: HPD=HPD_SINK!(inverted HPD) @ 0.9V	
PEQ	TMDS inputs equalization, internal PD=500Kohm	
	PEQ=Low: Mid level EQ (default)	
	PEQ=High: High level EQ	
	PEQ=MID: Low level EQ	
DDCBUF	DDC Active Buffer enable and setting, internal PD=500Kohm	
	DDCBUF=LOW: No DDC active buffer passive DDC level shifter	
	DDCBUF=High: Active DDC buffer enable, setting 1	
	DDCBUF=MID: Active DDC buffer enable, setting 2	
PRE	TMDS output driver pre-emphasis level setting	
	PRE=LOW: No pre-emphasis	
	PRE=High: Low level pre-emphasis is added	
	PRE=MID: High level pre-emphasis is added	

DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L GRAPHICS_IF	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV			
APPROVAL	BC LEE	REV	1.0		HDMI LEVEL SHIFTER_BA41	PART NO. 01097/8/(1100)A
MODULE CODE		LAST EDIT		April 29, 2009 21:47:17 PM		PAGE 4 of 4

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

HDMI

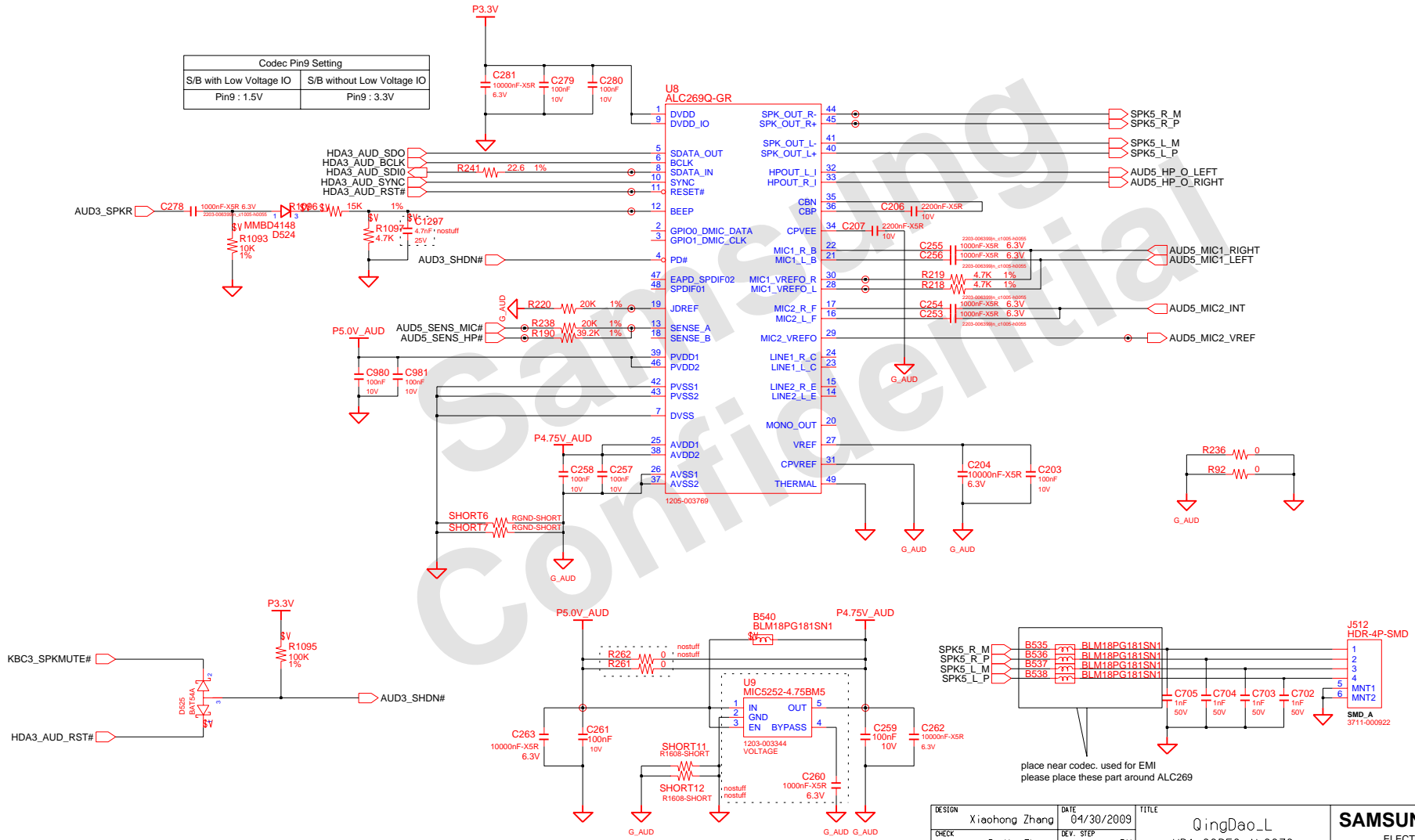


DESIGN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L GRAPHICS_IF	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	HDMI	BA41-01097/8/(1100)A	
APPROVAL	BC LEE	REV	1.0	April 29, 2009 21:47:17 PM	PAGE	3 of 3
MODULE CODE		LAST EDIT				

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

AUDIO

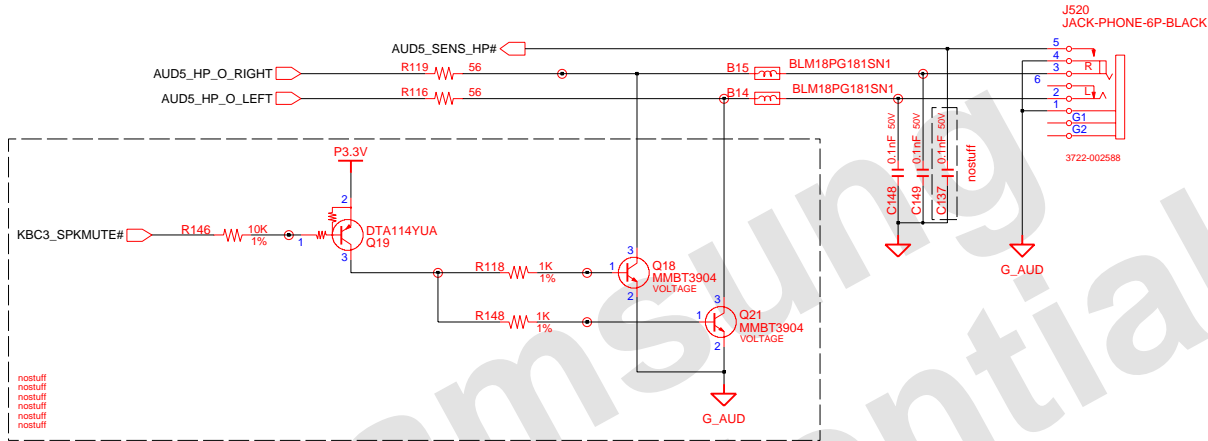
Codec Pin9 Setting	
S/B with Low Voltage IO	S/B without Low Voltage IO
Pin9 : 1.5V	Pin9 : 3.3V



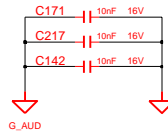
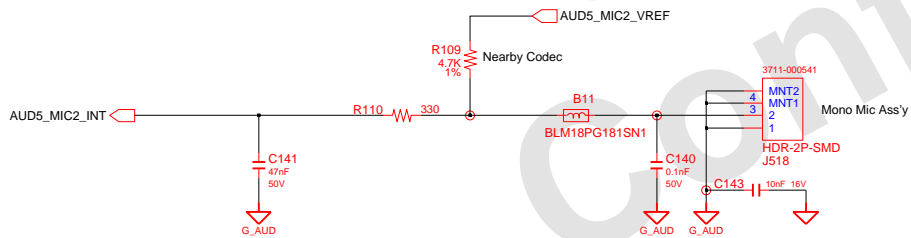
DESIGN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L HDA_CODEC_ALC272	SAMSUNG ELECTRONICS PART NO. 01097/8/(1100)A
CHECK	Rujin Zheng	DEV. STEP	PV	REV	1.0	
APPROVAL	BC LEE	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1	OF 5

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

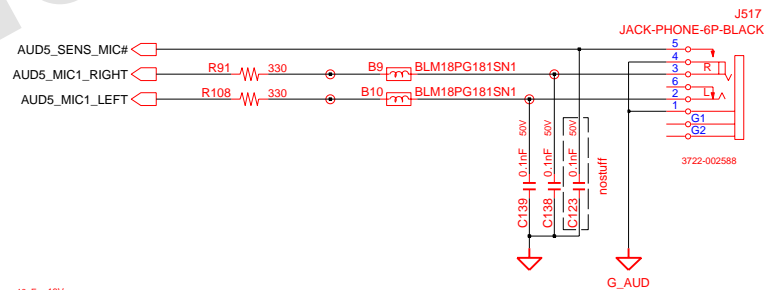
HEADPHONE



Analog MIC



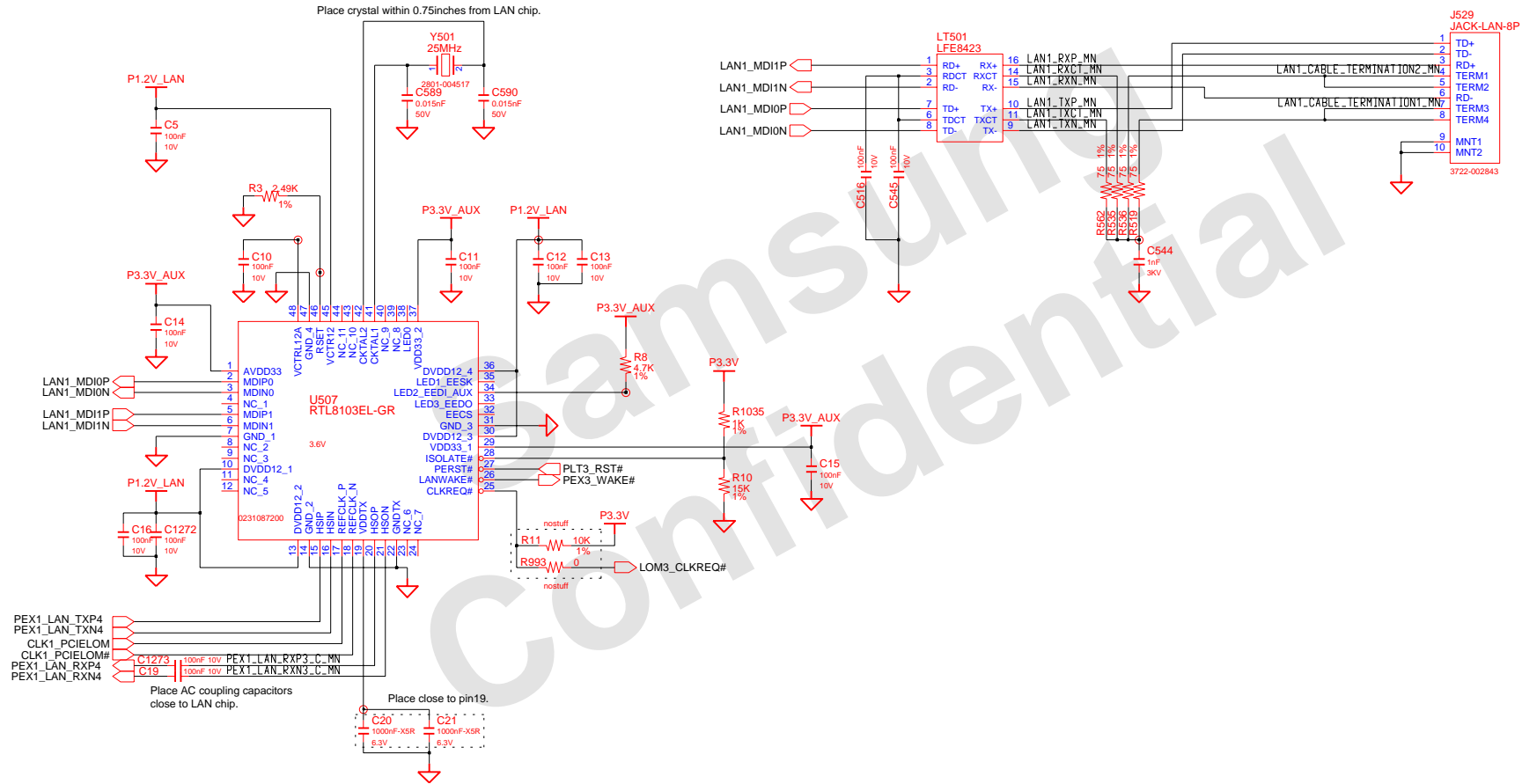
MIC JACK



DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	HDA_CODEC_ALC272		
APPROVAL	BC LEE	REV	1.0	SPK AMP TPA6017	BA41	PART NO. 01097/8/(1100)A
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	2	OF 5

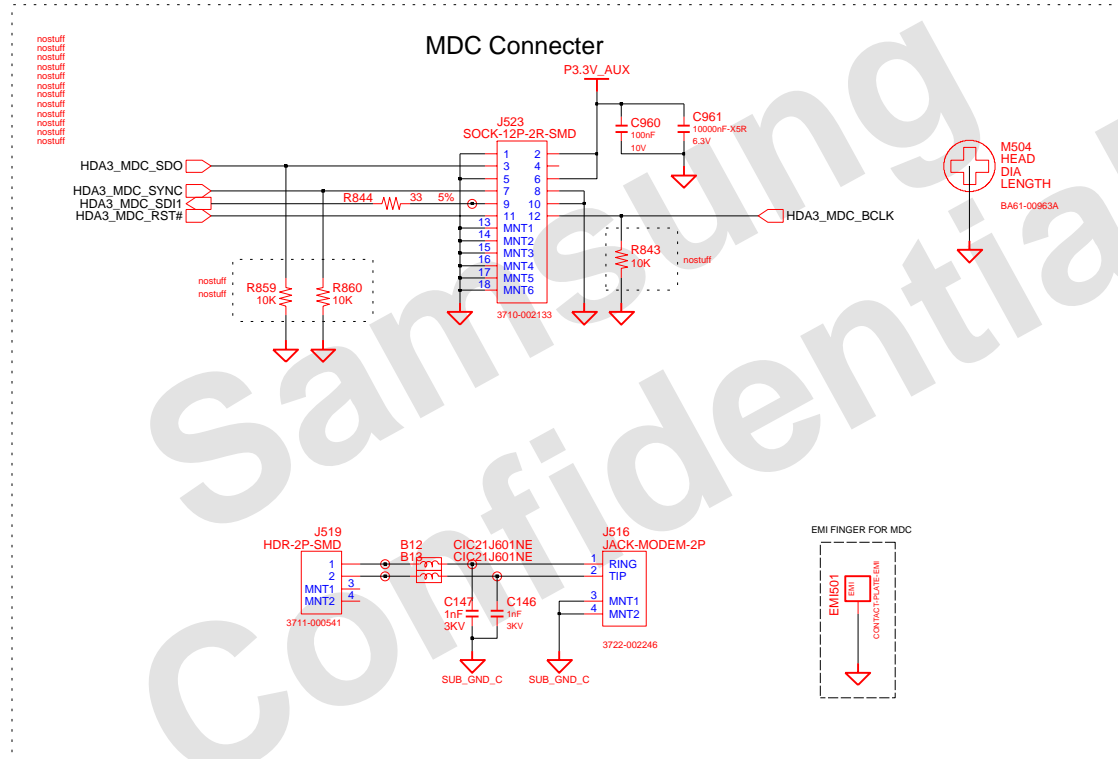
SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

LAN



DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	REV. STEP	PV	LAN_MARVELL_8055		
APPROVAL	BC LEE	REV	1.0	LAN		PART NO.
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE		1 of 1

MDC

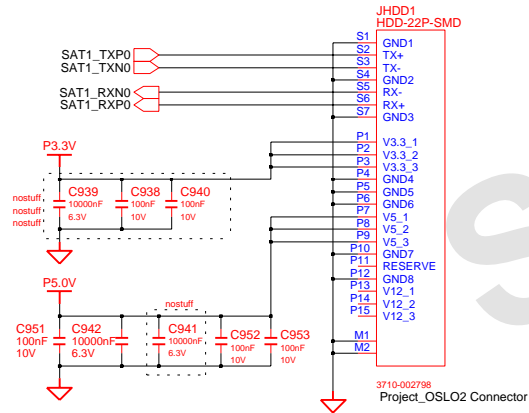


DRAW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV		HDA_Modem	
APPROVAL	BC LEE	REV	1.0		HDA_Modem	PART NO. BA41-01097/8/<1100>A
MODULE CODE		LAST EDIT		April 29, 2009 21:47:17 PM	PAGE	1 OF 1

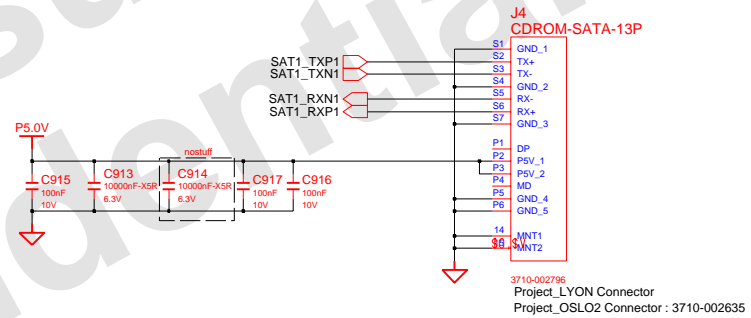
SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

SATA I/F CONN

SATA HDD CONN

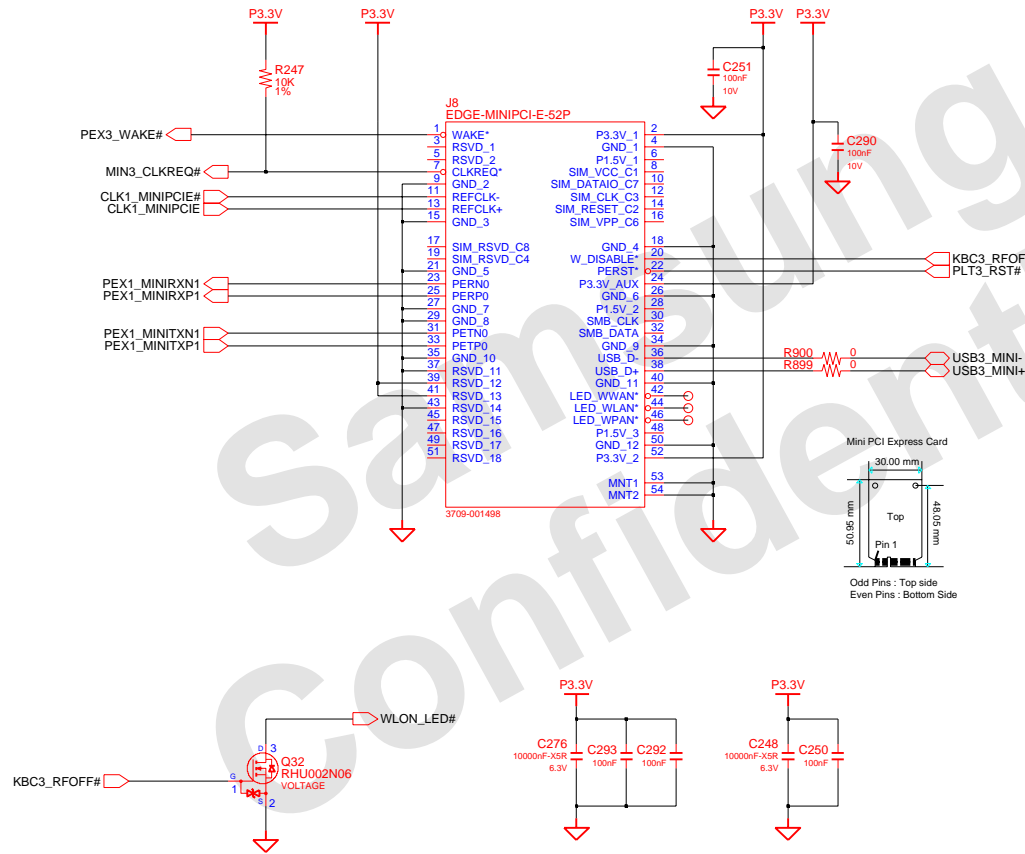


SATA ODD CONN



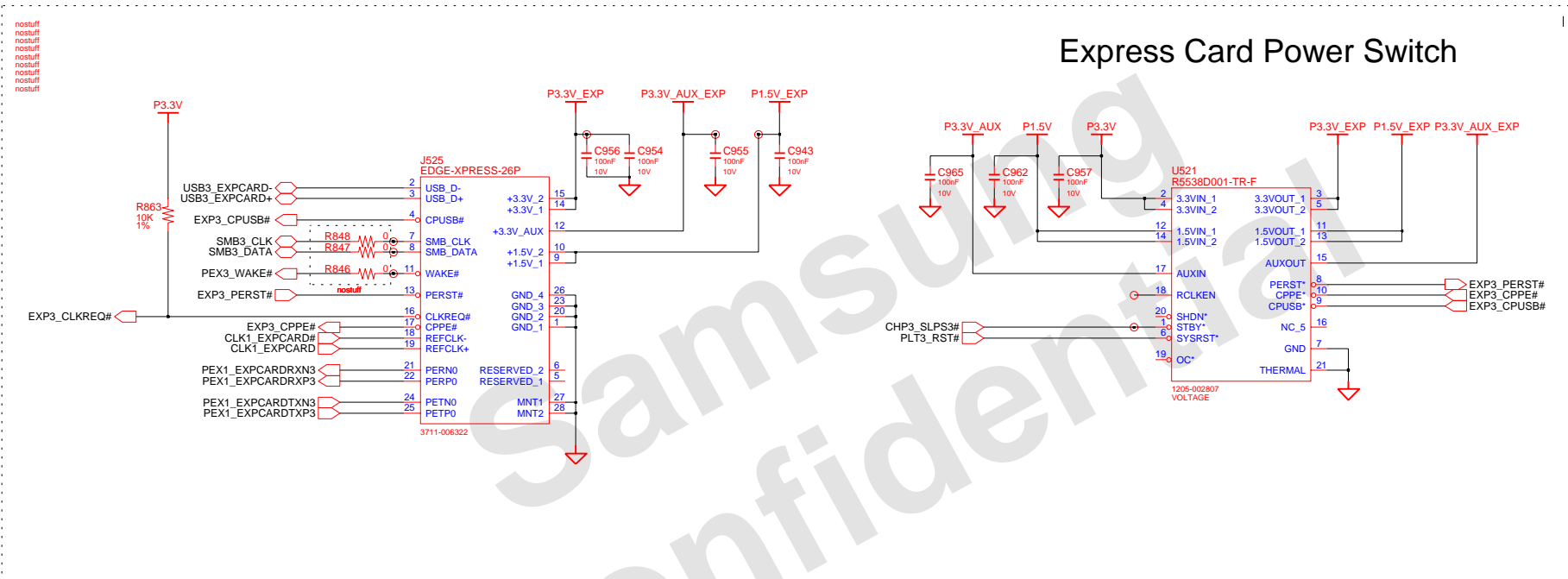
DESIGN	XiaoHong Zheng	DATE	12/3/2008	TITLE	QingDao_Ext SATA_DEVICES HDD ODD	SAMSUNG ELECTRONICS PART NO. BA41-xxxxxA
CHECK	RuJin Zheng	DEV. STEP	ADV1			
APPROVAL	BC LEE	REV	1.0			
MODULE CODE	undefined	LAST EDIT	December , 3, 2008 12:06:51 PM	PAGE	1 OF	

WLAN 7mm

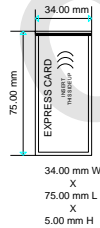


DESIGN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L MINI_PCIE_CONN	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV			
APPROVAL	BC LEE	REV	1.0		WLAN	PART NO. 01097/8/(1100)A
MODULE CODE	undef ined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1	OF

Express Card

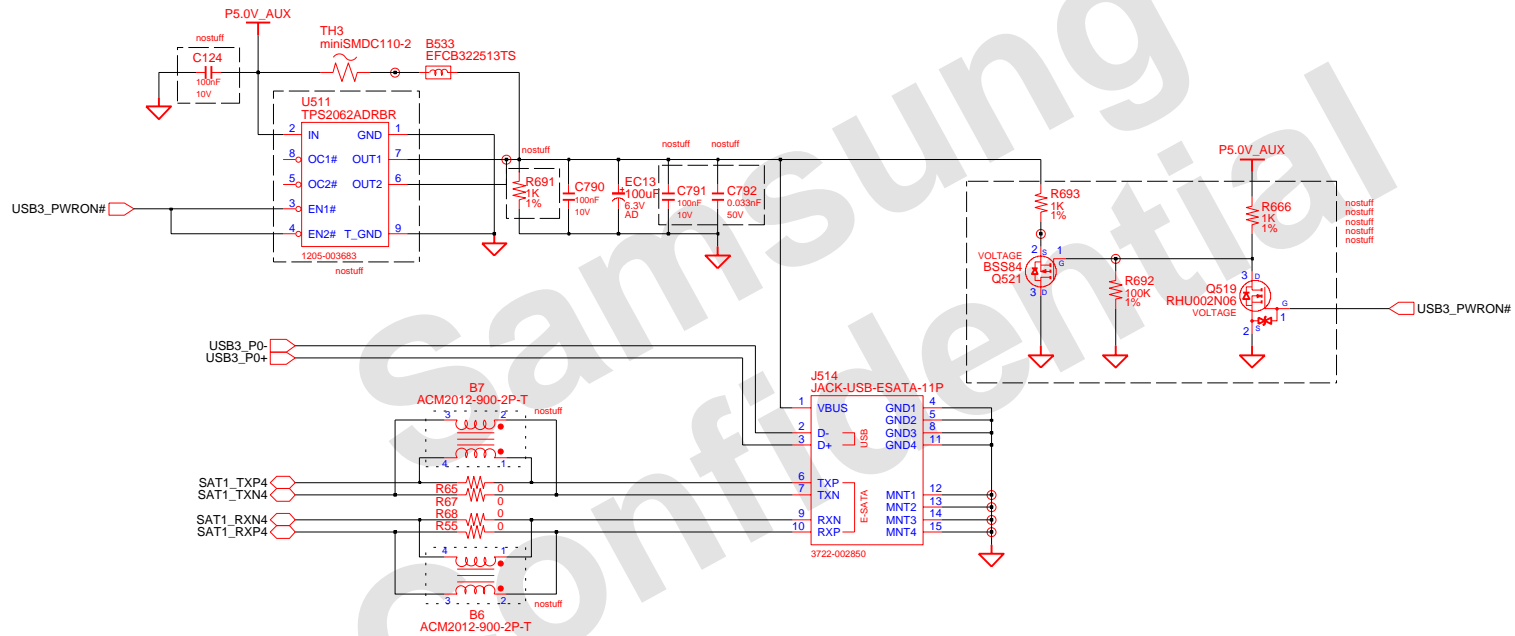


Type 1 module



DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L EXPRESS CARD	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV			
APPROVAL	BC LEE	REV	1.0			PART NO. BA41-01097/8/(1100)A
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1	OF

eSATA

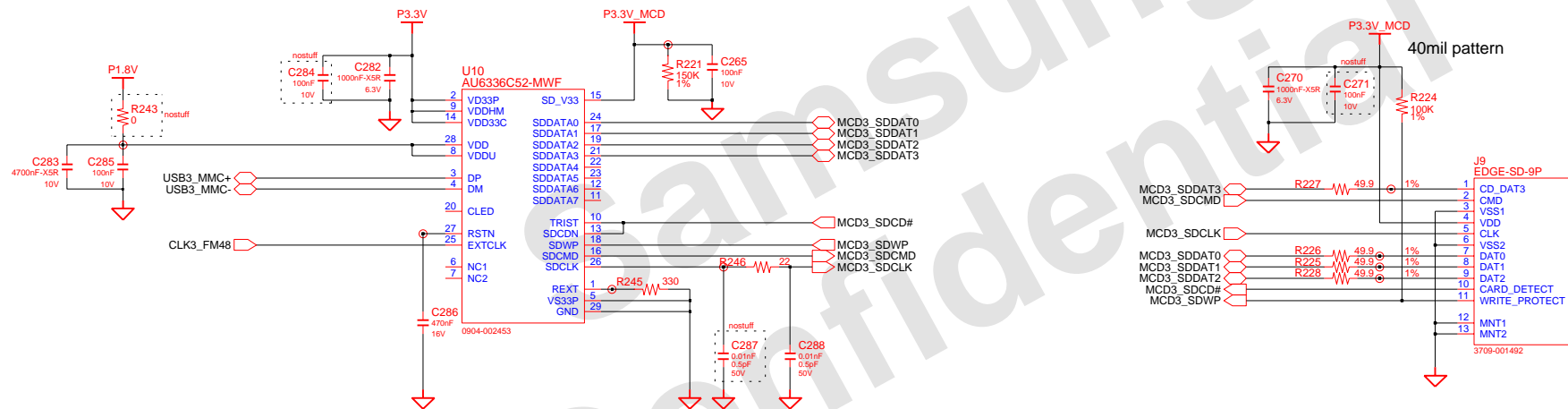


DESIGN	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	MAIN		
APPROVAL	BC LEE	REV	1.0	eSATA	BA41-01097/8/(1100)A	PART NO.
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM		PAGE	10 OF 15

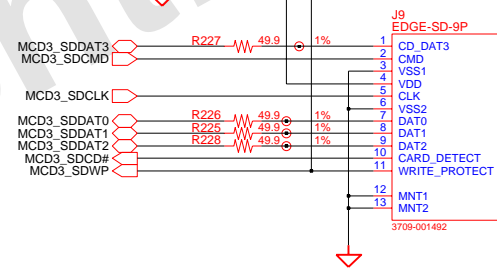
SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

3 IN 1

P3.3V_MCD distance between R5U880 and socket should be less than 2 inches



40mil pattern



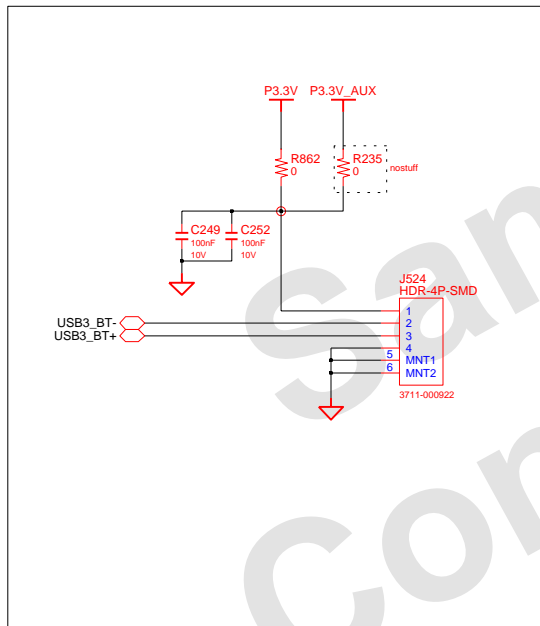
40 mil trace for medica card socket ground

MSEL5	SD Write Protec Selection
Connected to VCC	High Enable
Connected to GND	Low Enable
MSEL7	PLL BASE CLOCK SELECTION
Connected to VCC	12MHz
Connected to GND	48MHz

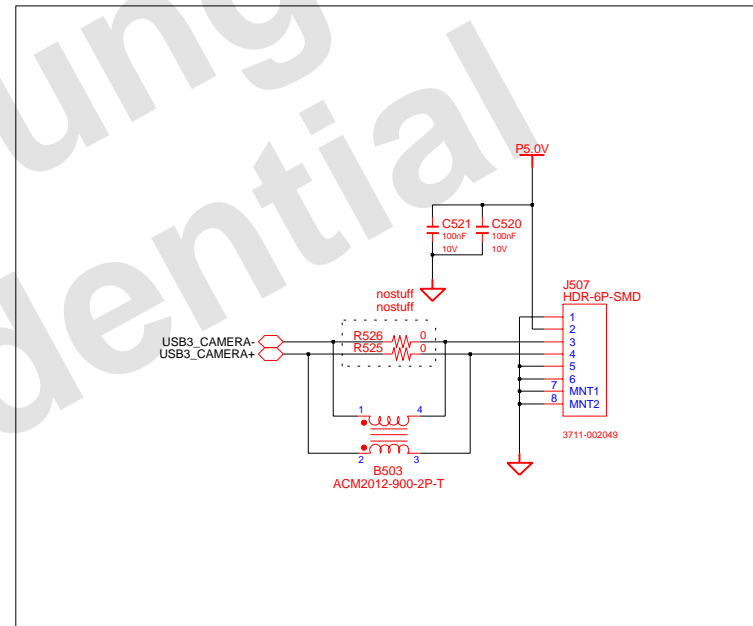
DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L AU6336	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV			
APPROVAL	BC LEE	REV	1.0			PART NO. BA41-01097/8/(1100)A
MODULE CODE	undef ined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1	OF

USB I/F Devices

Bluetooth Interface

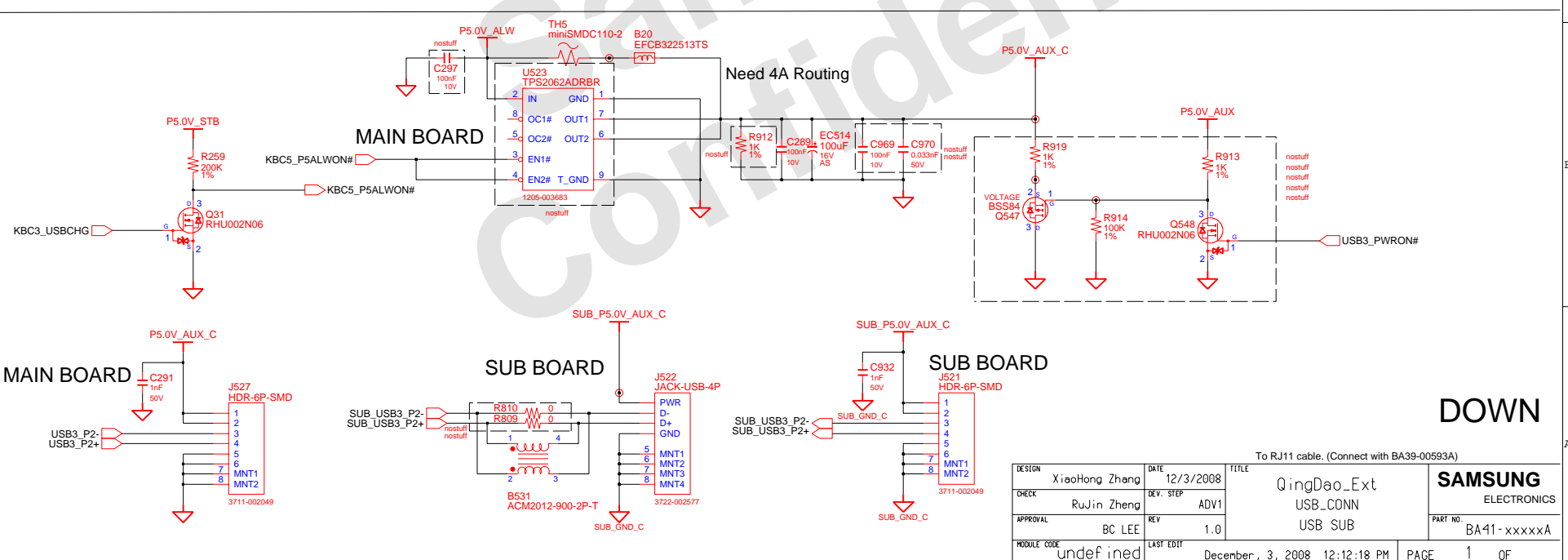
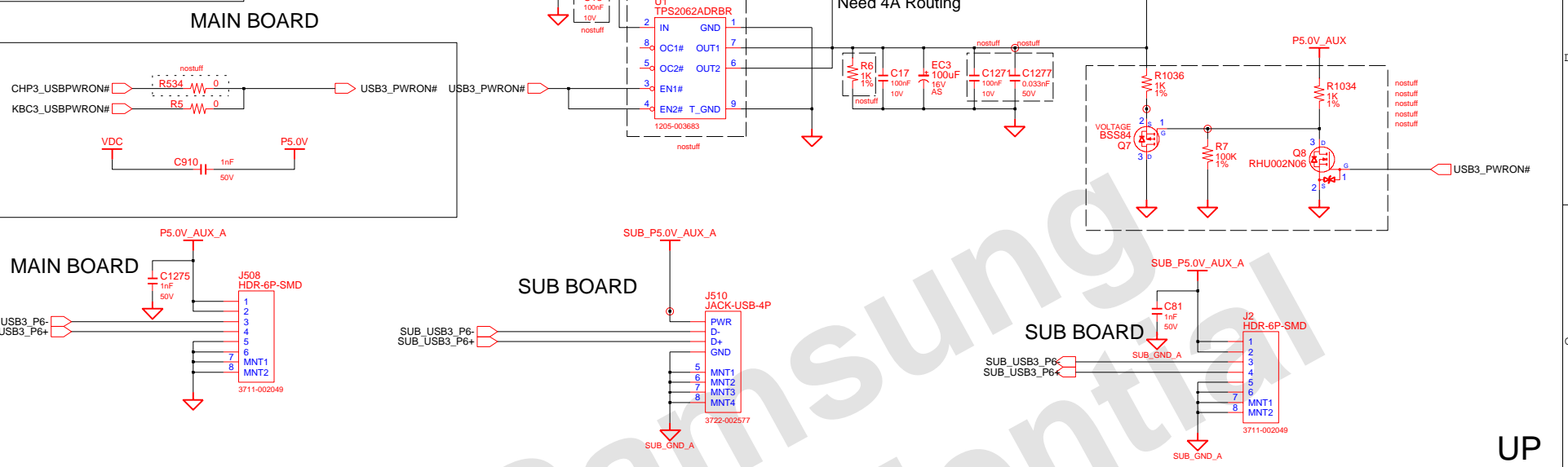


CAMERA



DESIGN	XiaoHong Zhang	DATE	12/3/2008	TITLE	QingDao_Ext USB_DEVICES BT CAMERA	SAMSUNG ELECTRONICS	
CHECK	RuJin Zheng	DEV. STEP	ADV1	PART NO.			BA41-xxxxxA
APPROVAL	BC LEE	REV	1.0				
MODULE CODE		LAST EDIT	December, 3, 2008 12:12:55 PM	PAGE			undefined

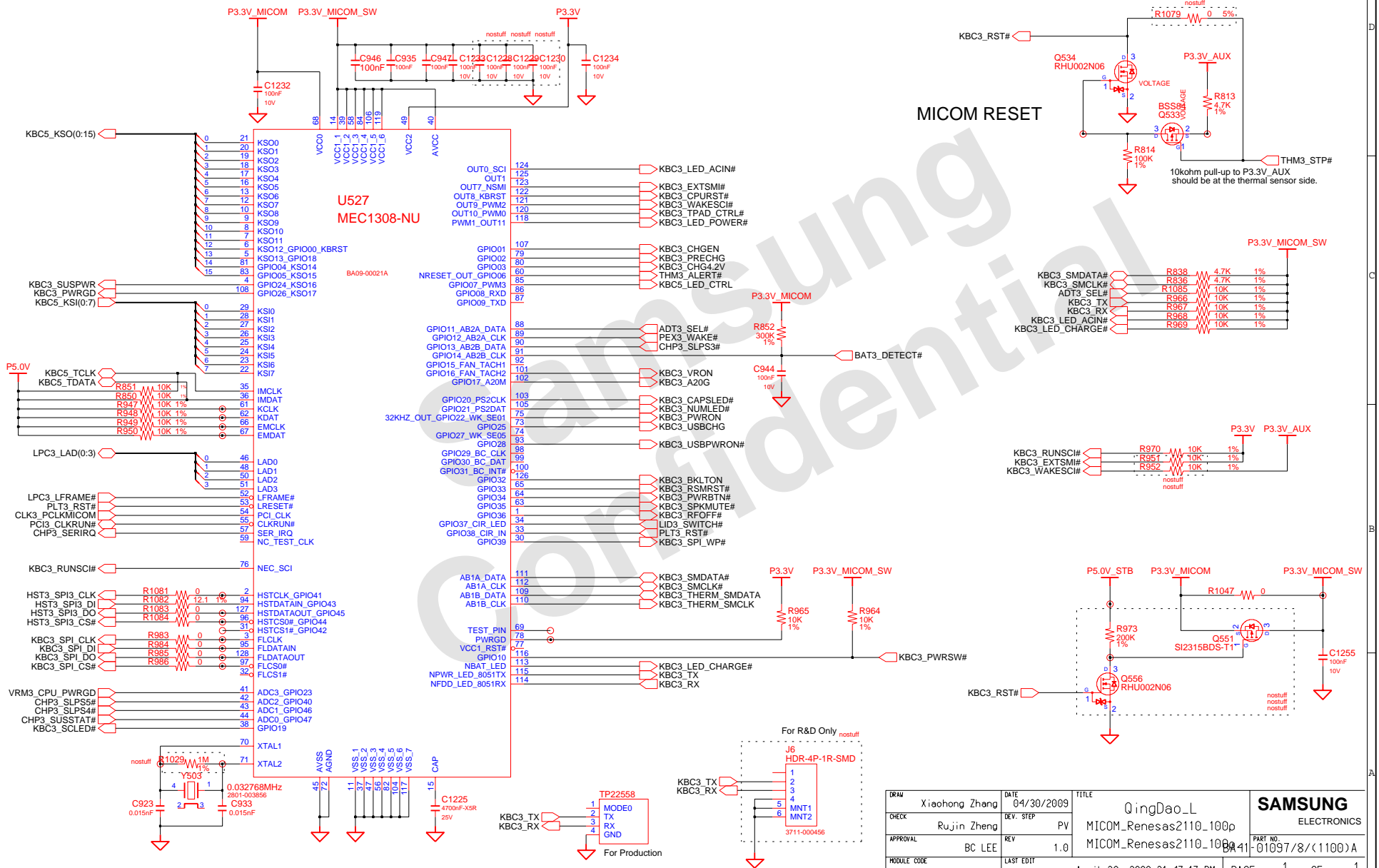
SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.



DESIGN	XiaoHong Zhang	DATE	12/3/2008	TITLE	To RJ11 cable. (Connect with BA39-00593A)	
CHECK	RuJin Zheng	DEV. STEP	ADV1	QingDao_Ext		SAMSUNG
APPROVAL	BC LEE	REV	1.0	USB_CONN		ELECTRONICS
MODULE CODE	undef ined	LAST EDIT	December, 3, 2008 12:12:18 PM	USB SUB		PART NO. BA41-xxxxxA
				PAGE	1	OF 1

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

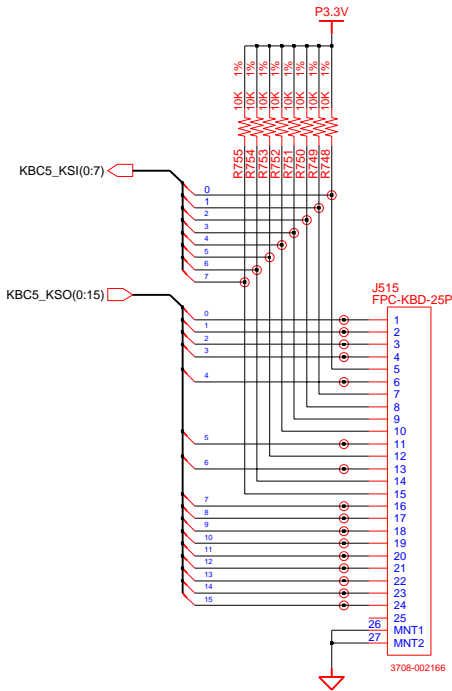
MICOM



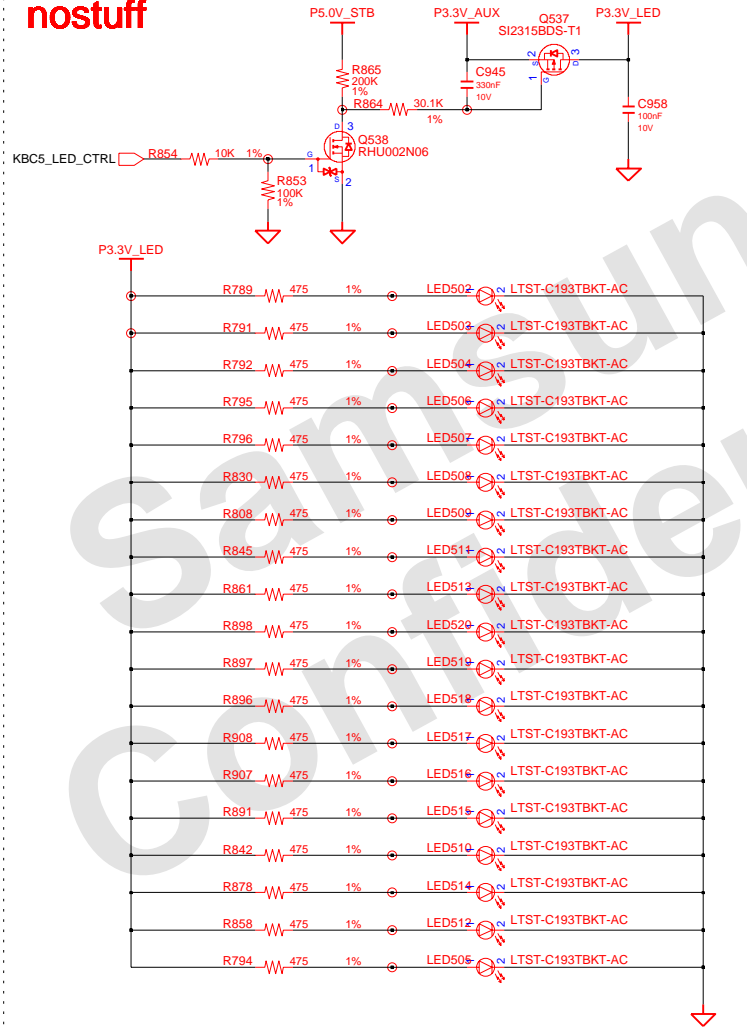
DRW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	MICOM_Renesas2110_100p		
APPROVAL	BC LEE	REV	1.0	MICOM_Renesas2110_100p		PART NO.
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM			01097/8/(1100)A
						PAGE 1 OF 1

Micom Glue Logic

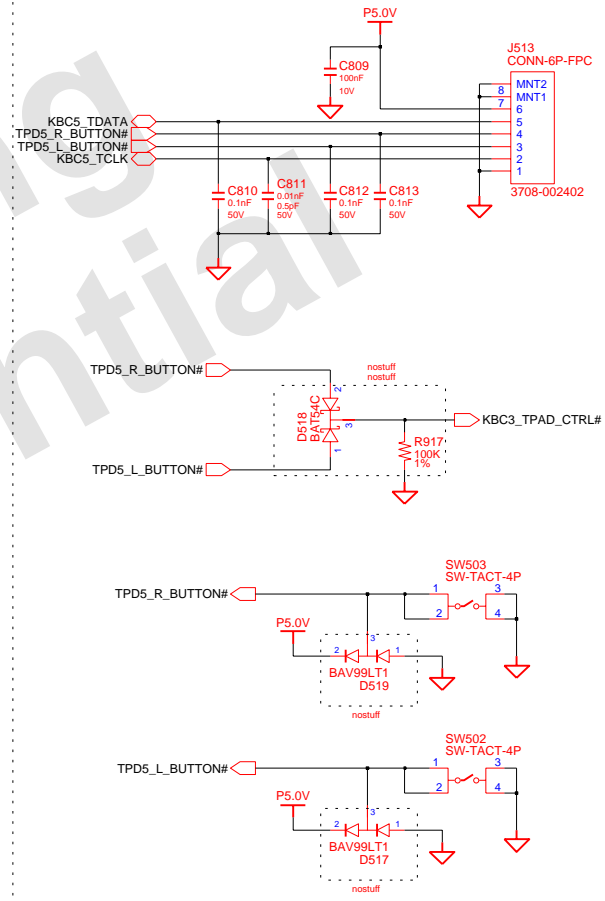
KEYBOARD



nostuff



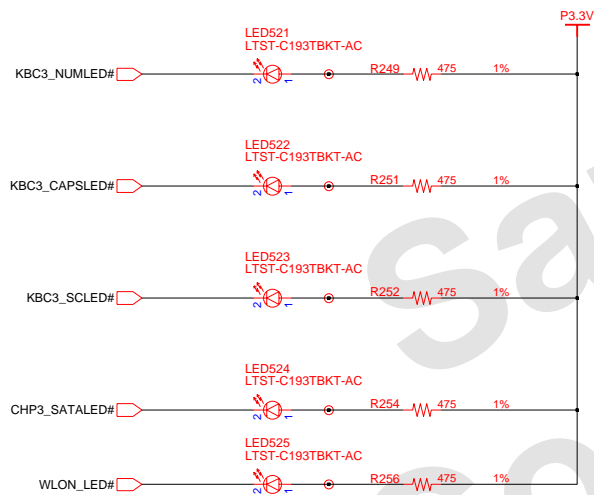
TOUCHPAD



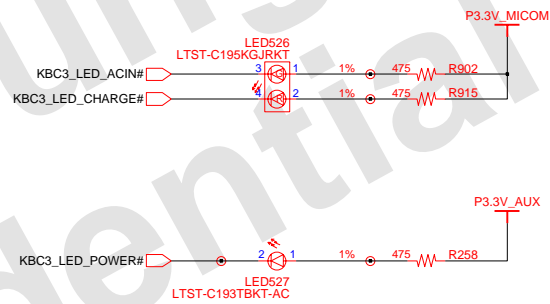
DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	MICOM_GLUE_LOGIC		
APPROVAL	BC LEE	REV	1.0	KBD TP	BA41	PART NO. 01097/8/(1100)A
MODULE CODE		LAST EDIT		April 29, 2009 21:47:17 PM	PAGE	undefined

LED SWITCH LOGIC

Function Key LEDES



ADAPTERIN/CHARGING LED

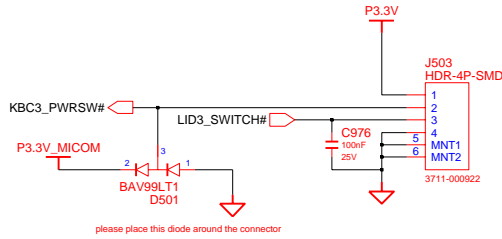


DRW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS	
CHECK	Rujin Zheng	DEV. STEP	PV	LED_Switch			
APPROVAL	BC LEE	REV	1.0	LED_Switch	BA41-01097/8/(1100)A	PART NO.	
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1	OF	1

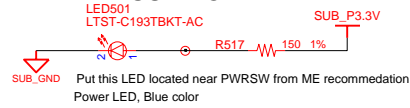
SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

SUB Board

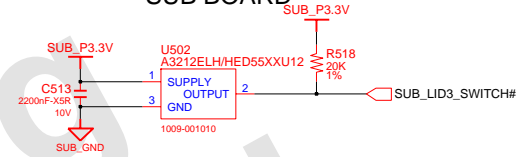
MAIN BOARD



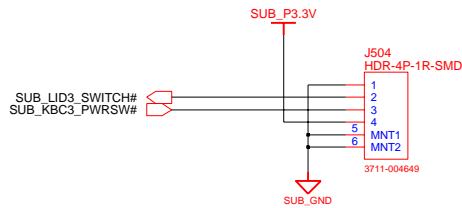
Power LED SUB BOARD



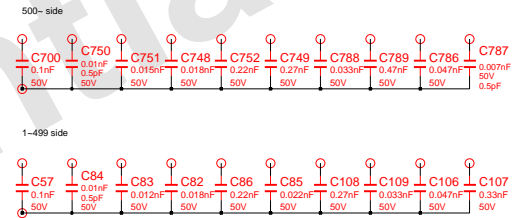
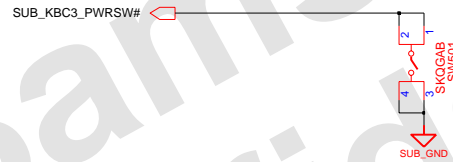
LID_SWITCH SUB BOARD



SUB BOARD



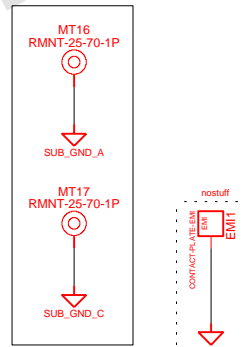
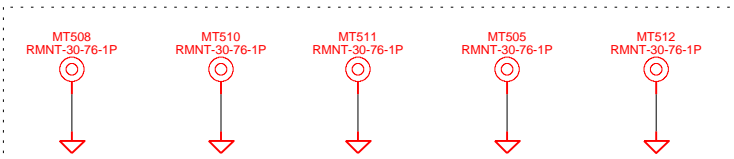
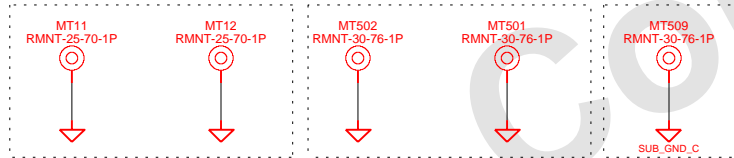
Power Switch SUB BOARD



PCB & BOTTOM

KBD & BOTTOM

USB_SUB & BOTTOM



PCB REVISION CONTROL (ICT)

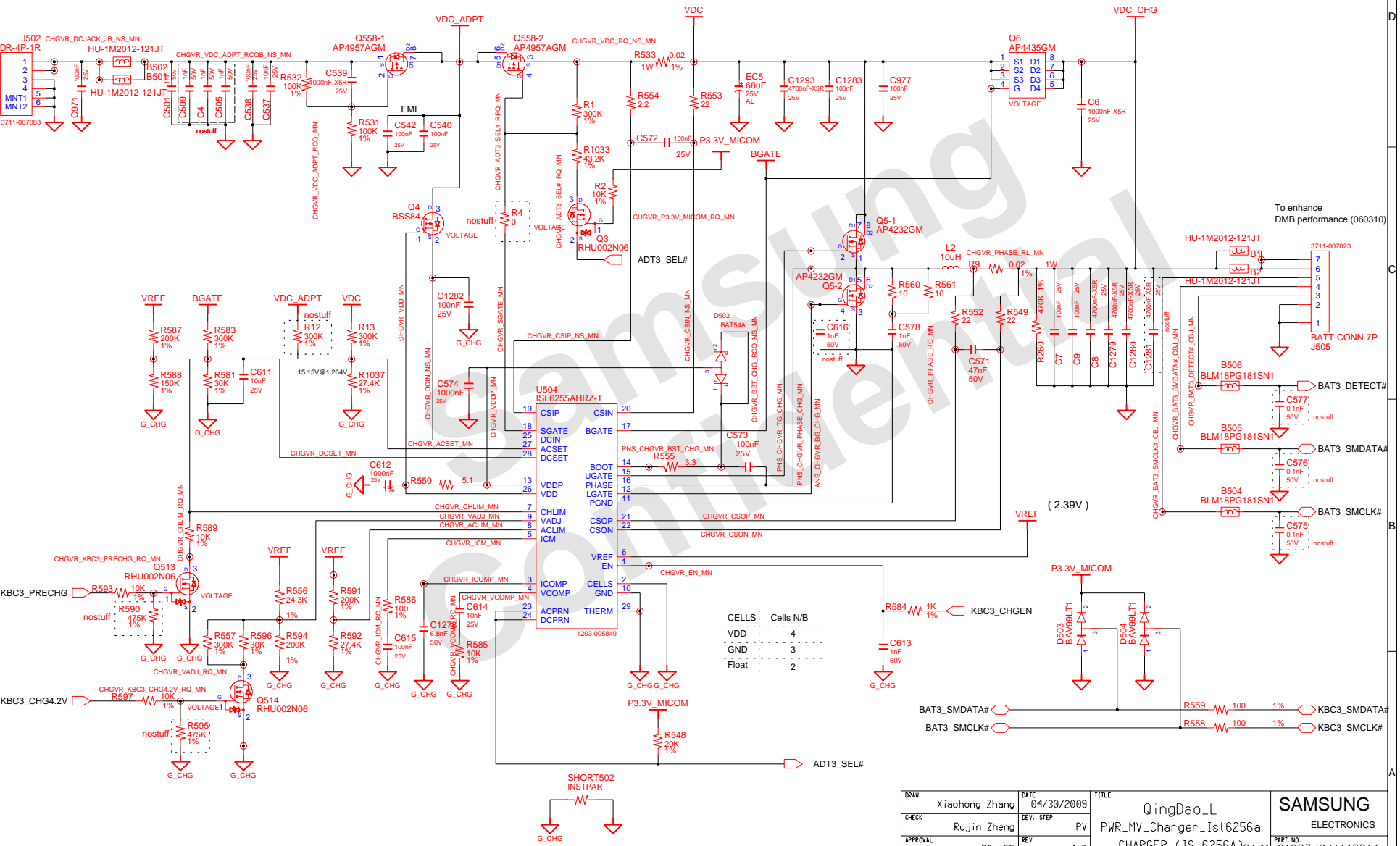
NO	CONNECTION	DATE(Y/M/D)	REVISION	STEP
1	N.C.			
2	1-2			
3	2-3			
4	3-1			
5	1-2-3			
6	N.C.			
7	1-2			
8	2-3			
9	3-1			
10	1-2-3			

REV1
 1 O
 2 O O3

DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	MAIN		
APPROVAL	BC LEE	REV	1.0	PWR SW SUB	BA41	PART NO. 01097/8/(1100)A
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	11	OF 15

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

CHARGER & POWER MANAGEMENT



To enhance
 DMB performance (060310)

3711-007023

BATT-CONN-7P
 J505

BAT3_DETECT#

BAT3_SMDATA#

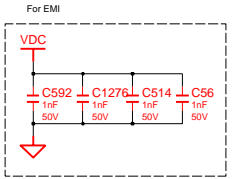
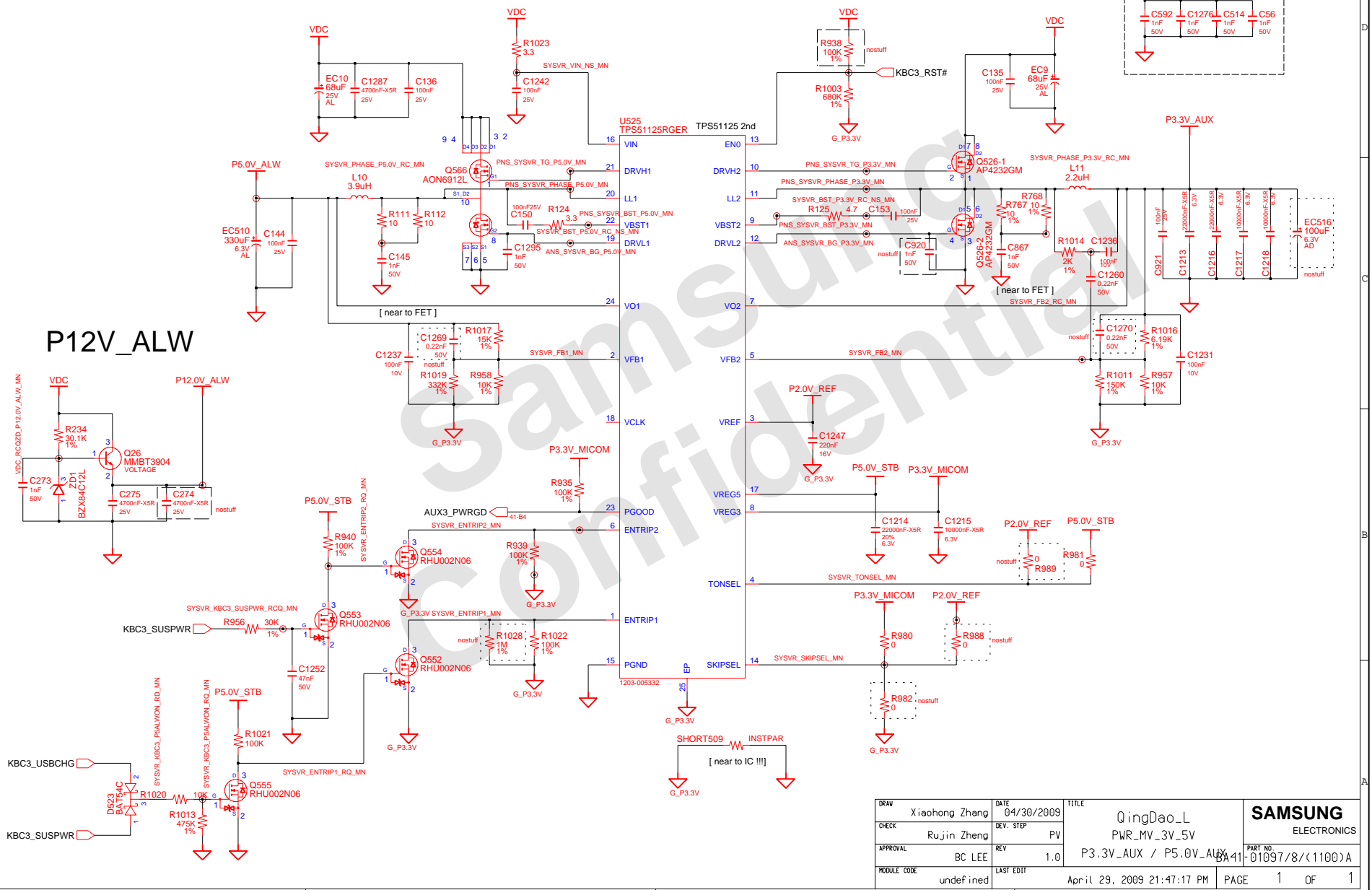
BAT3_SMCLK#

BAT3_SMDATA#

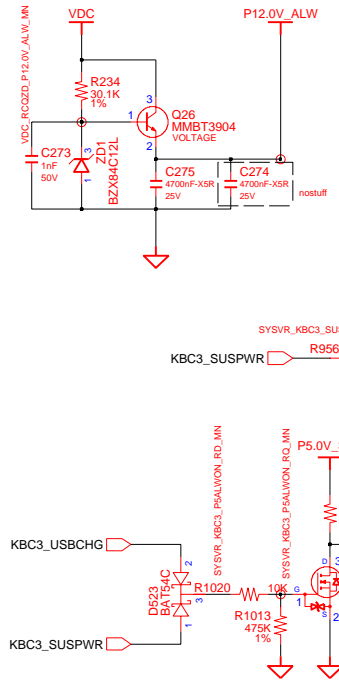
BAT3_SMCLK#

DRAW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	REV. STEP	PV	PWR_MV_Charger_Is16256a		
APPROVAL	BC LEE	REV	1.0	CHARGER (ISL6256A)BA41		PART NO. 01097/8/(1100)A
MODULE CODE	undef ined	LAST EDIT	Apr 12, 2009 21:47:17 PM	PAGE	1	

P3.3V_AUX & P5.0V_AUX

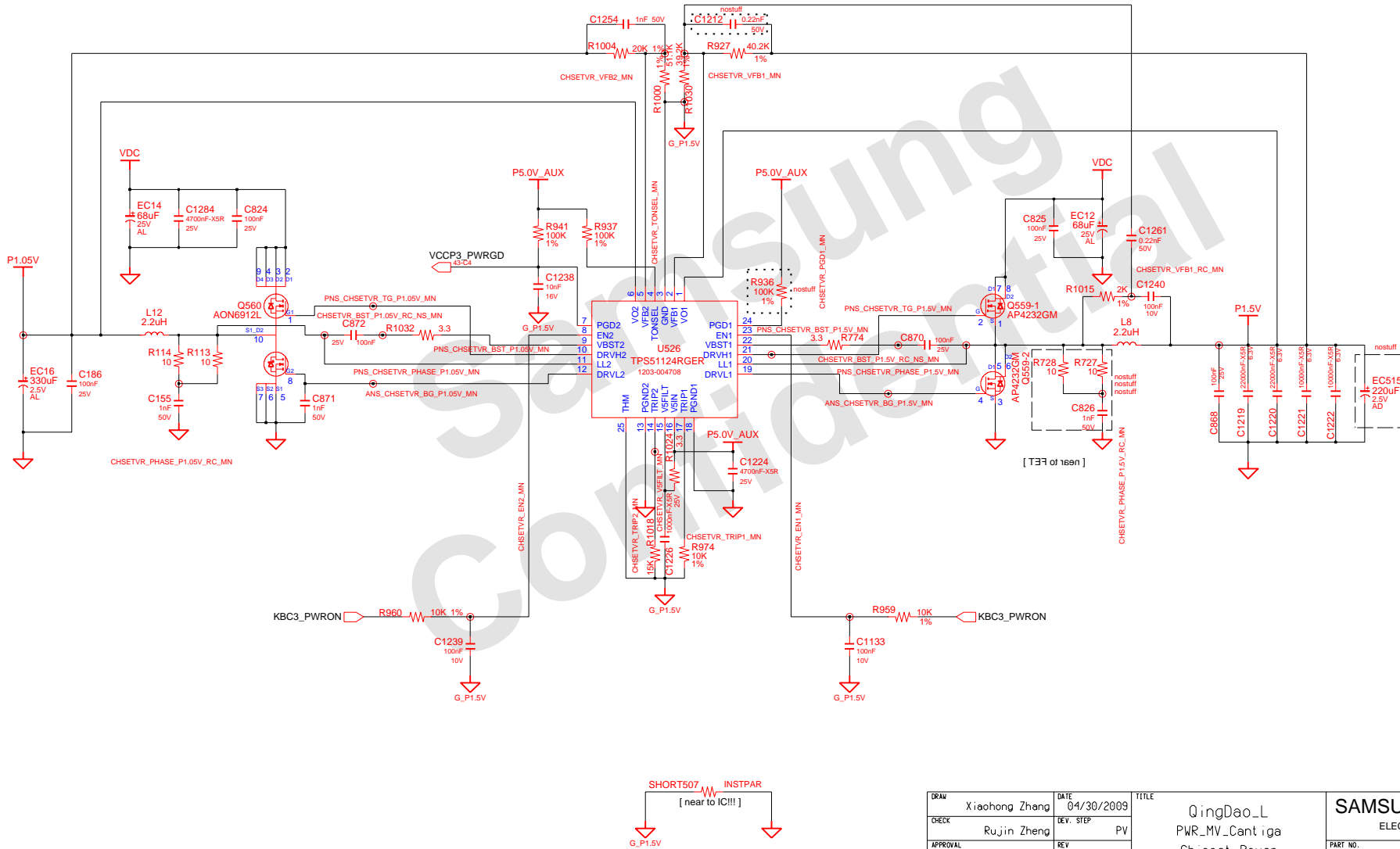


P12V_ALW



DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L
CHECK	Rujin Zheng	DEV. STEP			PWR_MV_3V_5V
APPROVAL	BC LEE	REV	1.0		P3.3V_AUX / P5.0V_AUX
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM		BA41-01097/8/(1100)A
SAMSUNG ELECTRONICS					
PART NO. 01097/8/(1100)A					
PAGE 1 OF 1					

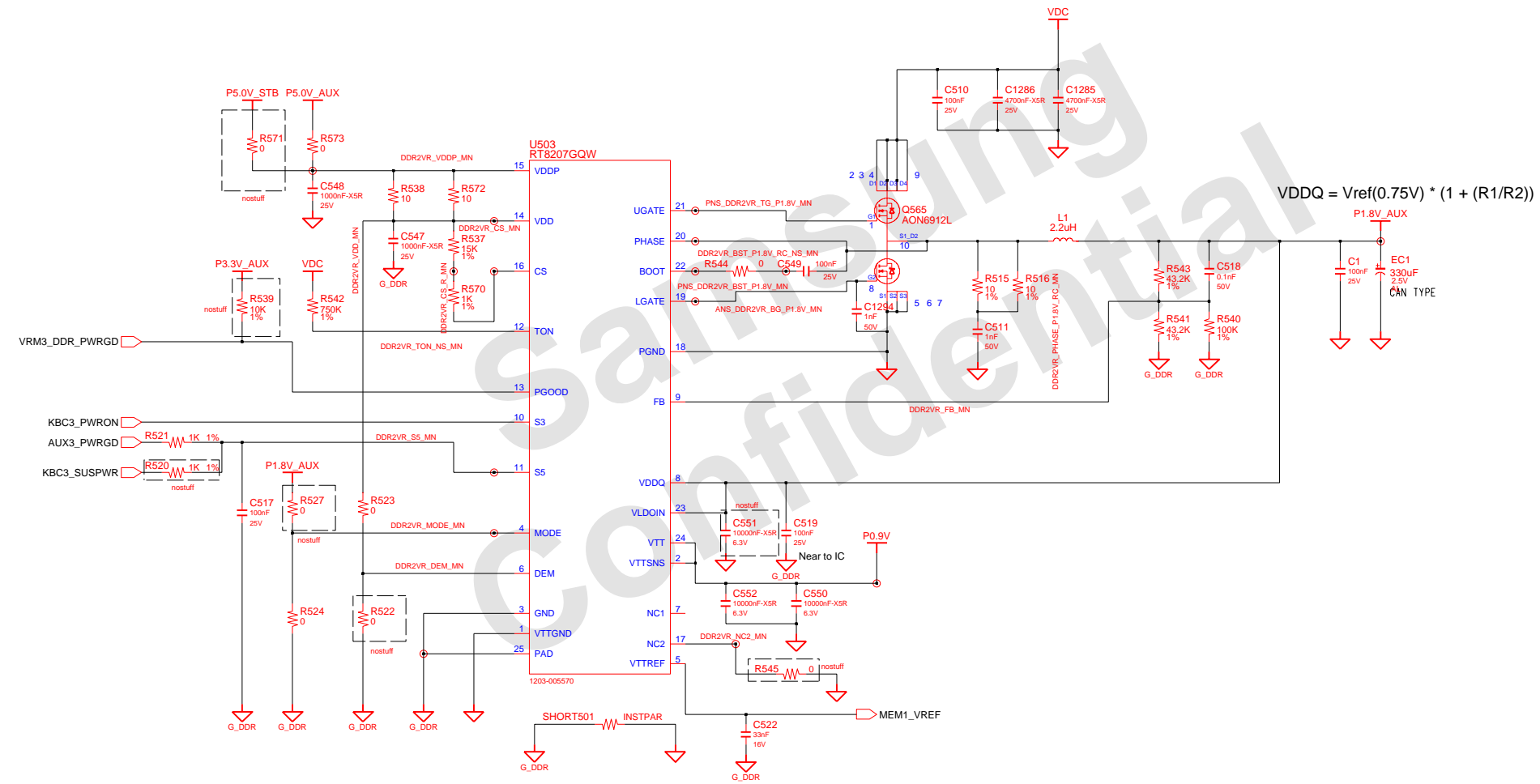
1.05V & P1.5V



DRAW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L PWR_MV_Cantiga Chipset Power	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	REV. STEP	PV			
APPROVAL	BC LEE	REV	1.0			PART NO. 01097/8/(1100)A
MODULE CODE	undefined	LAST EDIT		April 29, 2009 21:47:17 PM	PAGE	

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

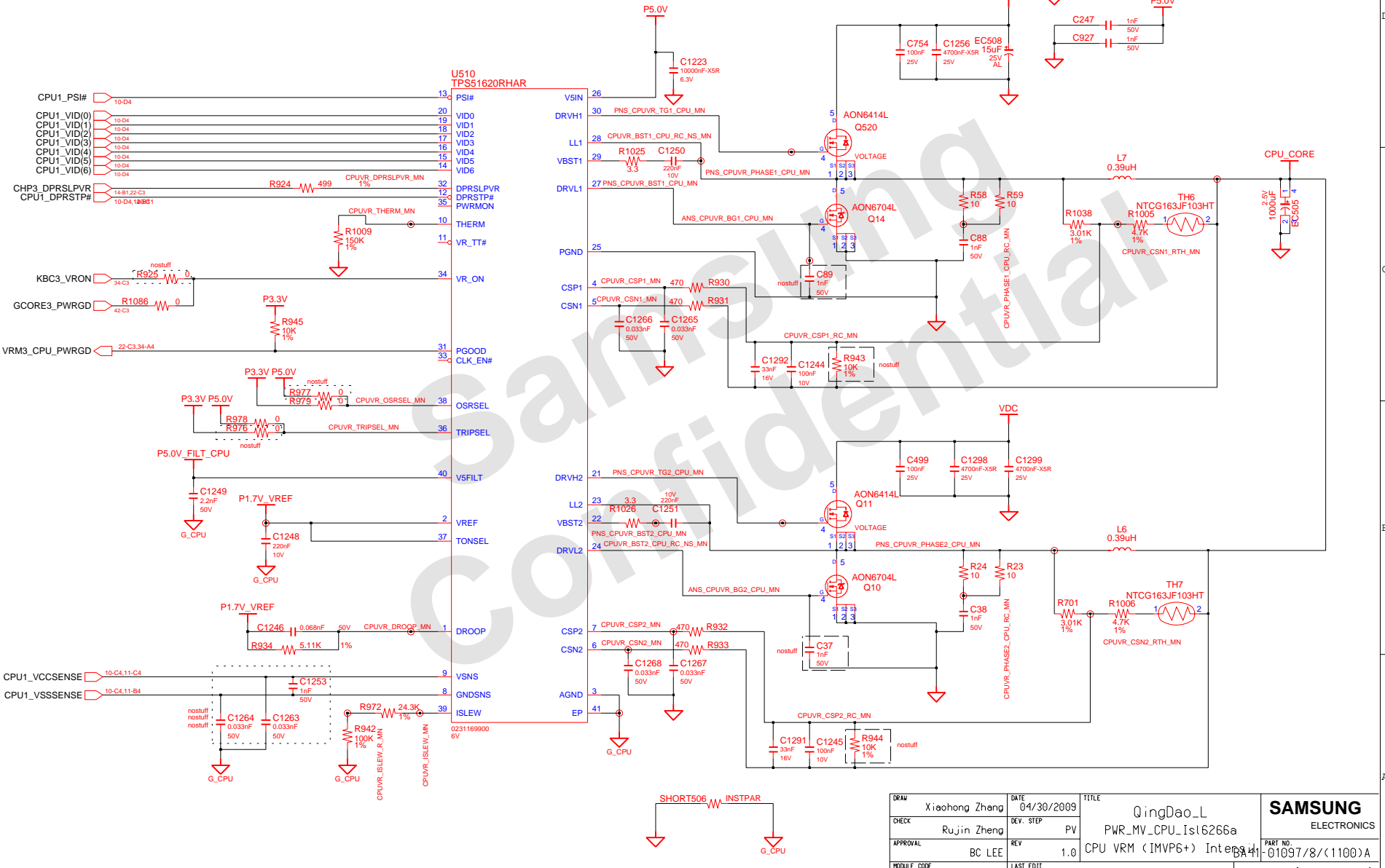
DDR2 Power



DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	PWR_MV_Memory		
APPROVAL	BC LEE	REV	1.0	DDR3 POWER (P1.5V_AUX)A1	PART NO.	01097/8/(1100)A
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1	OF 1

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

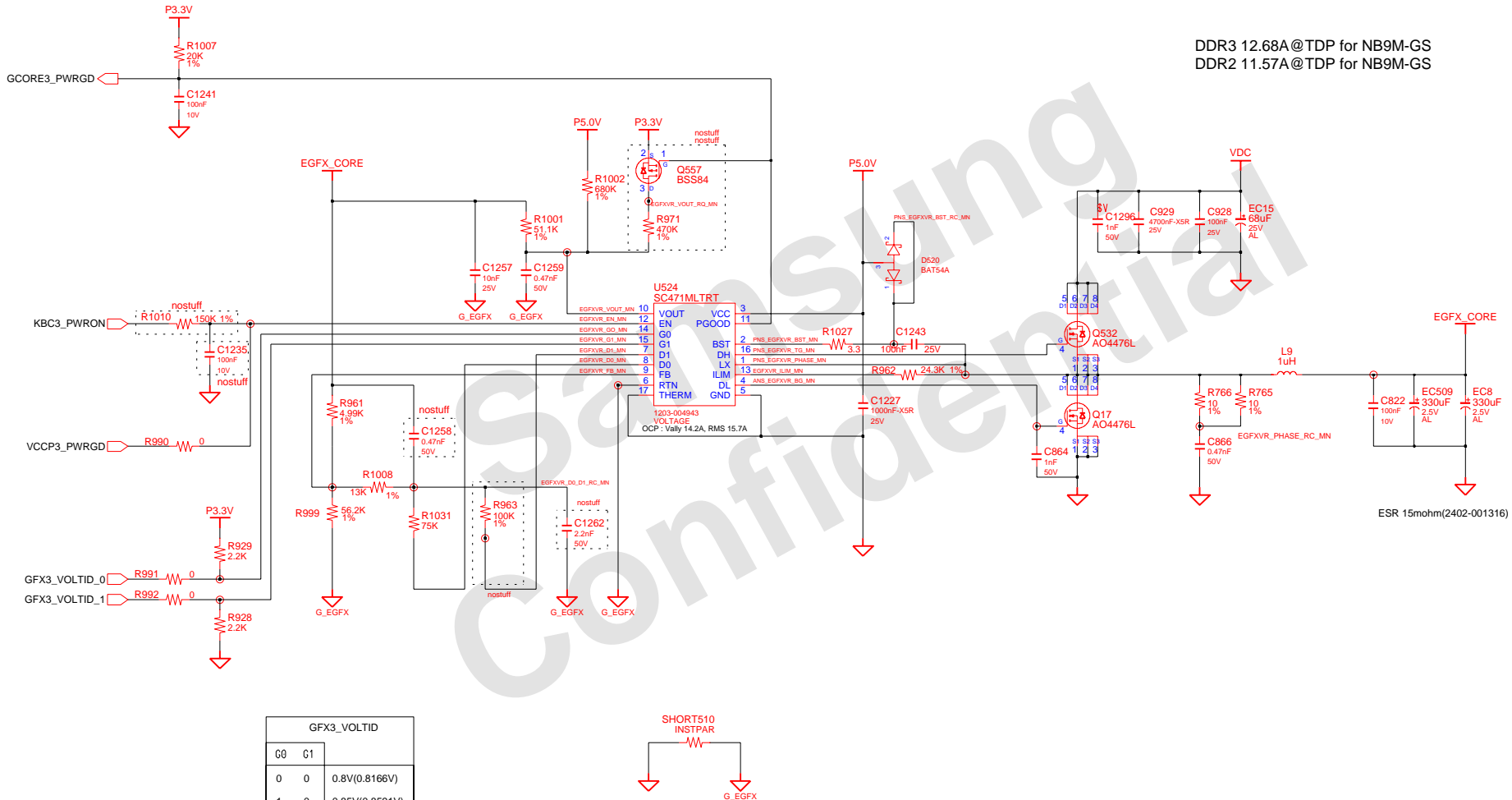
CPU VRM [INTERSIL]



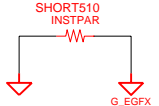
DRW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG
CHECK	Rujin Zheng	DEV. STEP	PV	PWR_MV_CPU_Ist6266a		ELECTRONICS
APPROVAL	BC LEE	REV	1.0	CPU VRM (IMVP6+) Intersil		PART NO. BA41-01097/8/(1100)A
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1 OF	1

Graphic Core Power

DDR3 12.68A@TDP for NB9M-GS
 DDR2 11.57A@TDP for NB9M-GS



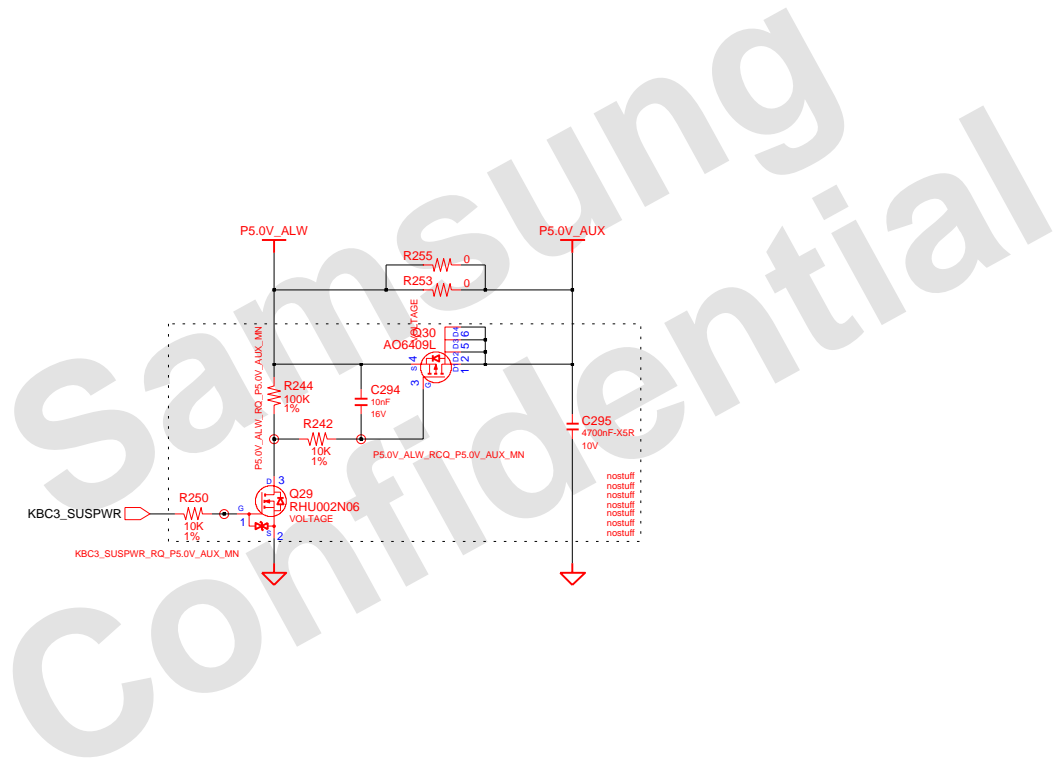
GFX3_VOLTID			
Q0	G1		
0	0	0.8V(0.8166V)	
1	0	0.85V(0.8591V)	
0	1	RESERVE	
1	1	RESERVE	



DRW	Xiaohong Zhang	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	PWR_Gfx_MV_Ext		
APPROVAL	BC LEE	REV	1.0	Ext Gfx Memory(SC486)		PART NO.
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1 OF 1	BA41-01097/8/(1100)A

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

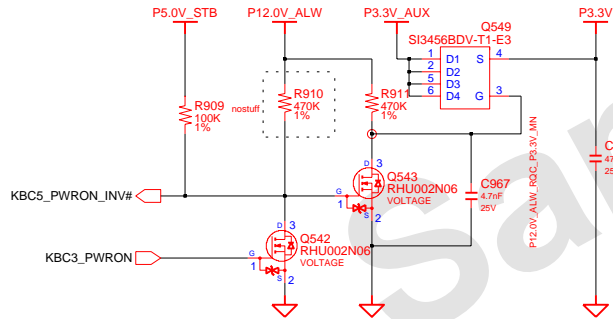
Switched Power



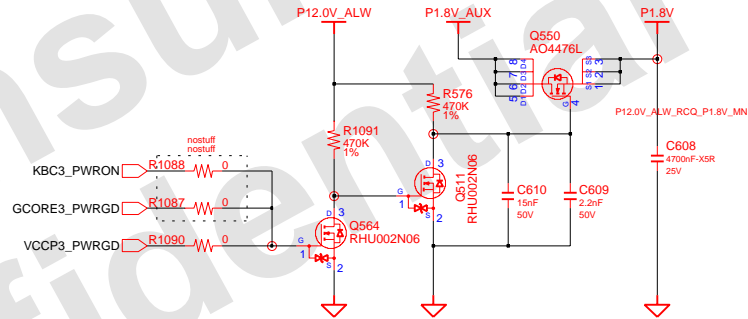
DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS	
CHECK	Rujin Zheng	DEV. STEP	PV	PWR_MV_Switched			
APPROVAL	BC LEE	REV	1.0	SWITCHED POWER	BA41-01097/8/(1100)A	PART NO.	
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1	OF	2

Switched Power

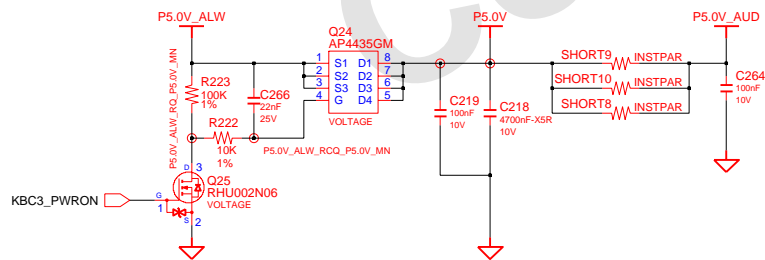
Switched Power On (P3.3V)



Switched Power On (P1.8V)

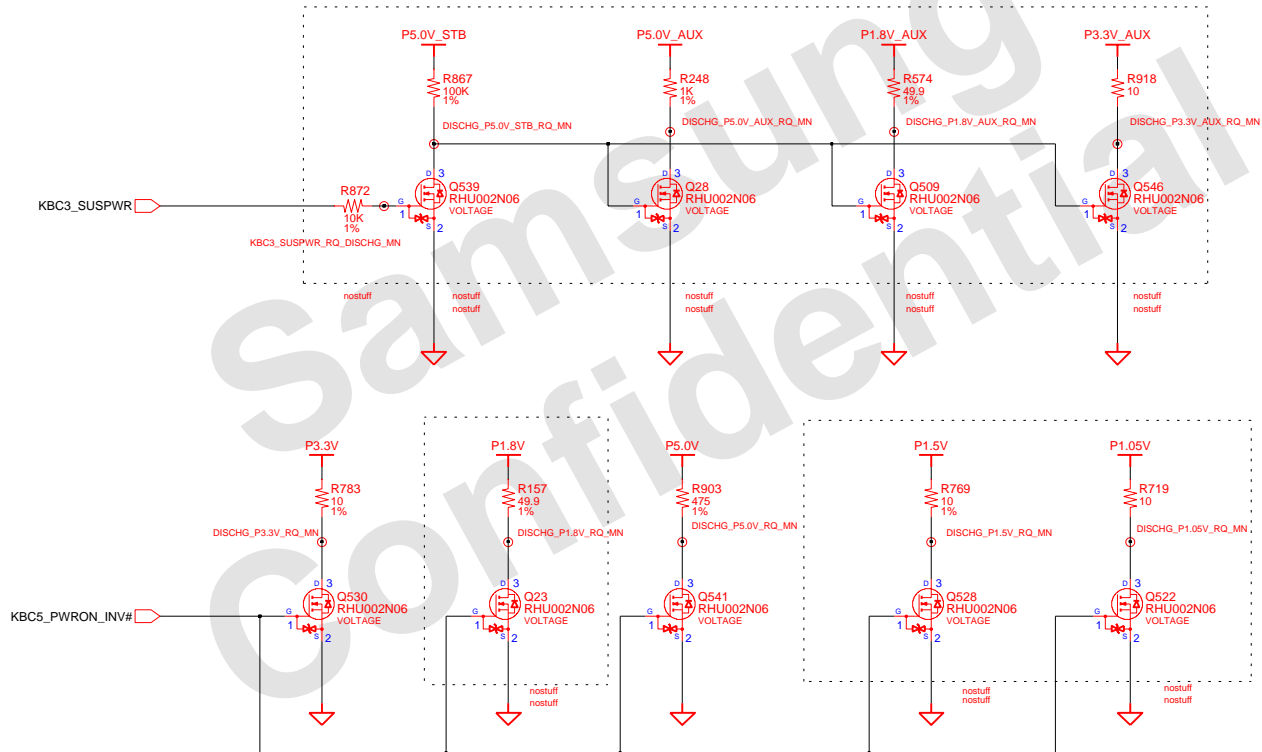


Switched Power On (P5.0V)



DESIGN	XIAOHONG, ZHANG	DATE	12/3/2008	TITLE	QingDao_Ext PWR_MV_SWITCHED Switched Power	SAMSUNG ELECTRONICS PART NO. BA41-xxxxxA
CHECK	RUJIN, ZHENG	DEV. STEP	ADV1			
APPROVAL	BC, LEE	REV	1.0			
MODULE CODE		LAST EDIT	December, 3, 2008 3:39:16 PM	PAGE	2 OF	

POWER DISCHARGER



DRAW	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	PWR_MV_DisCharger		
APPROVAL	BC LEE	REV	1.0	DISCHARGING LOGIC BA41		PART NO. 01097/8/(1100)A
MODULE CODE	undefined	LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	1	OF 1

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

- CPU1_NMI
- CPU1_TCK
- CPU1_TDI
- CPU1_TMS
- FANS_VDD
- SMB3_CLK
- ADT3_SEL#
- CLK3_FMS#
- CPU1_ADS#
- CPU1_BNR#
- CPU1_HIT#
- CPU1_INTR
- CPU1_PSI#
- CPU1_SMI#
- GFX3_HCLK
- KBC3_A20G
- KBC3_VRON
- KBC5_TCLK
- LCD3_BRIT
- MCD3_SDWP#
- MEM1_VREF
- PLT3_RST#
- SMB3_DATA
- THM3_STP#
- WLN_LED#
- CLK3_PWRGD
- CLK3_ICH14
- CLK3_PWRGD
- CLK3_USB48
- CPU1_A20M#
- CPU1_BPR#
- CPU1_BREQ#
- CPU1_DBSY#
- CPU1_DPWR#
- CPU1_DRDY#
- CPU1_FERR#
- CPU1_INIT#
- CPU1_LOCK#
- CPU1_TRDY#
- CPU1_TRST#
- CRT3_HSYNC
- CRT3_VSYNC
- CRT5_HSYNC
- CRT5_VSYNC
- DRAM_RST#
- EXP3_OPPE#
- GFX3_HDATA
- GFX3_ROMS#
- GFX3_ROMSO
- KBC3_CHGEN
- KBC3_PWRGD
- KBC3_PWRON
- KBC5_TDATA
- MCD3_SDOP#
- MCD3_SDCLK
- MCD3_SDCMD
- MCH1_HVREF
- PC13_INTA#
- PC13_INTB#
- PC13_INTC#
- PC13_INTD#
- PC13_IRDY#
- PC13_PERR#
- PC13_SERR#
- PC13_STOP#
- PC13_TRDY#
- PE3_WAKE#
- BAT3_SMCLK#
- CHP3_GPIO18
- CHP3_GPIO20
- CHP3_SERIRQ
- CHP3_SLPS#
- CHP3_SLPS#
- CLK3_DBG LPC
- CPU1_DPSLP#
- CPU1_IGNNE#
- CPU1_VID(0)
- CPU1_VID(1)
- CPU1_VID(2)
- CPU1_VID(3)
- CPU1_VID(4)
- CPU1_VID(5)
- CPU1_VID(6)
- CRT3_DDCCLK
- CRT5_DDCCLK
- EXP3_CLKUSB#
- EXP3_PERS#
- GFX3_STRAP2
- KBC3_BKLTON
- KBC3_PRECHG
- KBC3_PWRSW#
- KBC3_RFOF#
- KBC3_SCLE#
- KBC3_SMCLK#
- KBC3_SUSPWR
- LCD3_BKLTON
- LPC3_LAD(0)
- LPC3_LAD(1)
- LPC3_LAD(2)
- LPC3_LAD(3)
- MCD3_SDDAT0
- MCD3_SDDAT1
- MCD3_SDDAT2
- MCD3_SDDAT3
- PC13_FRAME#
- PC13_PLOCK#
- PEG3_BKLTEN
- SMB3_ALERT#
- THM3_ALERT#
- USB3_PWRON#
- VCCP3_PWRGD
- BAT3_DETECT#
- BAT3_SMDATA#
- CHP3_BIOSW#
- CHP3_CPUSTP#
- CHP3_PCISTP#
- CLK3_GFX_27M
- CLK3_PCLKMCOM
- CPU1_DPRSTP#
- CPU1_DSTBN#
- CPU2_THERMDA
- CPU2_THERMDC
- CRT3_DDCDATA
- CRT5_DDCDATA
- EXP3_CLKREQ#
- FAN3_FBACK#
- SCORE3_PWRGD
- GFX3_ROMSCLK
- GFX3_THERMDN
- GFX3_THERMDP
- HDA3_MDC_SDO
- KBC3_CHG1.2V
- KBC3_CPURST#
- KBC3_EXTSMI#
- KBC3_NUMLED#
- KBC3_PWRON_INV#
- KBC3_LED_ACIN#
- KBC3_USBPWRON#
- LCD3_EDID_DATA
- PEG3_HDMI_DATA
- PEG5_HDMI_DATA
- TPD5_L_BUTTON#
- TPD5_R_BUTTON#
- VRM3_CPU_PWRGD
- VRM3_DDR_PWRGD
- CHP3_ME_RTCRST#
- CLK3_GFX_27M_SS
- KBC3_SATACLKREQ#
- KBC3_LED_CHARGE#
- KBC3_THERM_SMCLK
- SUB_LID3_SWITCH#
- KBC3_THERM_SMDATA
- KBC3_PWRBTN#
- KBC3_RSMRST#
- KBC3_RUNSC#
- KBC3_SMDATA#
- KBC3_SPMUTE#
- LID3_SWITCH#
- LOM3_CLKREQ#
- LPC3_LFRAME#
- MCH1_HASWING
- MCH3_CLKREQ#
- MCH3_EXTSO#
- MCH3_EXTS1#
- MN3_CLKREQ#
- PC13_CLKRUN#
- PC13_DEVSEL#
- CHP3_CL_CLK_0
- CHP3_DPRSLPVR
- CHP3_PM_SYNC#
- CHP3_SATALED#
- CHP3_SUSSTAT#
- CPU1_PWRGD CPU
- CPU1_VCCSENSE
- CPU1_VSSSENSE
- GFX3_VOLTID_0
- GFX3_VOLTID_1
- LPC3_LAD(0)
- LPC3_LAD(1)
- LPC3_LAD(2)
- LPC3_LAD(3)
- MCD3_SDDAT0
- MCD3_SDDAT1
- MCD3_SDDAT2
- MCD3_SDDAT3
- HDA3_MDC_BCLK
- HDA3_MDC_RST#
- HDA3_MDC_SDI#
- HDA3_MDC_SYNC
- KBC3_CAPSLED#
- KBC5_LED_CTRL
- KBC5_WAKESCH#
- KBC5_PALWON#
- LCD3_EDID_CLK
- MCH3_IHSYNC#
- PEG3_HDMI_CLK
- PEG3_HPD_HDMI
- PEG3_LCDVDDON
- PEG5_HDMI_CLK
- CHP3_BIOS_CR#
- CHP3_CL_DATA_0
- CHP3_CL_RST_0#
- CHP3_INTRUDER#
- CHP3_USBPWRON#
- CLK3_PCLKMCOM
- CPU1_THRMTRIP#
- CPU3_THRMTRIP#
- ITP3_DBRESET#
- KBC3_LED_ACIN#
- KBC3_USBPWRON#
- LCD3_EDID_DATA
- PEG3_HDMI_DATA
- PEG5_HDMI_DATA
- TPD5_L_BUTTON#
- TPD5_R_BUTTON#
- VRM3_CPU_PWRGD
- VRM3_DDR_PWRGD
- CHP3_ME_RTCRST#
- CLK3_GFX_27M_SS
- KBC3_PWRON_INV#
- KBC3_SATACLKREQ#
- KBC3_LED_CHARGE#
- KBC3_THERM_SMCLK
- SUB_LID3_SWITCH#
- KBC3_THERM_SMDATA
- P3.3V_MICOM
- SUB_GND
- SUB_GND_A
- SUB_GND_C
- SUB_P3.3V
- P5.0V_AUX



DESIGN	Xiaohong Zheng	DATE	04/30/2009	TITLE	QingDao_L	SAMSUNG ELECTRONICS
CHECK	Rujin Zheng	DEV. STEP	PV	MAIN		
APPROVAL	BC LEE	REV	1.0	TP	BA41	PART NO. 01097/8/(1100)A
MODULE CODE		LAST EDIT	April 29, 2009 21:47:17 PM	PAGE	12	OF 15

SAMSUNG PROPRIETARY
 THIS DOCUMENT CONTAINS CONFIDENTIAL
 PROPRIETARY INFORMATION THAT IS
 SAMSUNG ELECTRONICS CO.'S PROPERTY.
 NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
 EXCEPT AS AUTHORIZED BY SAMSUNG.

- HDMI3_APD
- HDMI3_PEO
- HDMI3_PRE
- AUD5_MIC2_INT
- HDA3_AUD_SDO
- CPU1_BSEL0
- CPU1_BSEL1
- CPU1_BSEL2
- CPU1_HITM#

- HDMI3_AS01
- HDMI3_EMIO
- HDMI3_EMI1

- GFX3_THERM#
- KBC3_SPI_DI
- KBC3_SPI_DO
- KBC3_USBCHG
- CPU1_STPCLK#
- HDMI3_DDCBUF
- HST3_SPI3_DI
- HST3_SPI3_DO
- KBC3_SPI_CLK
- KBC3_SPI_CS#
- KBC3_SPI_WP#

Samsung
 Confidential

D
 C
 B
 A

SAMSUNG PROPRIETARY

THIS DOCUMENT CONTAINS CONFIDENTIAL
PROPRIETARY INFORMATION THAT IS
SAMSUNG ELECTRONICS CO.'S PROPERTY.
NOT DISCLOSE TO OR DUPLICATE FOR OTHERS
EXCEPT AS AUTHORIZED BY SAMSUNG.

- HDA3_AUD_BCLK
- HDA3_AUD_SDIO
- HDA3_AUD_SYNC
- HST3_SPI0_CLK
- HST3_SPI0_CS#
- VGA5_HDMI_HPD
- AUD5_HP_O_LEFT
- AUD5_MIC1_LEFT
- AUD5_HP_O_RIGHT
- AUD5_MIC1_RIGHT
- KBC3_TPAD_CTRL#

Samsung
Confidential